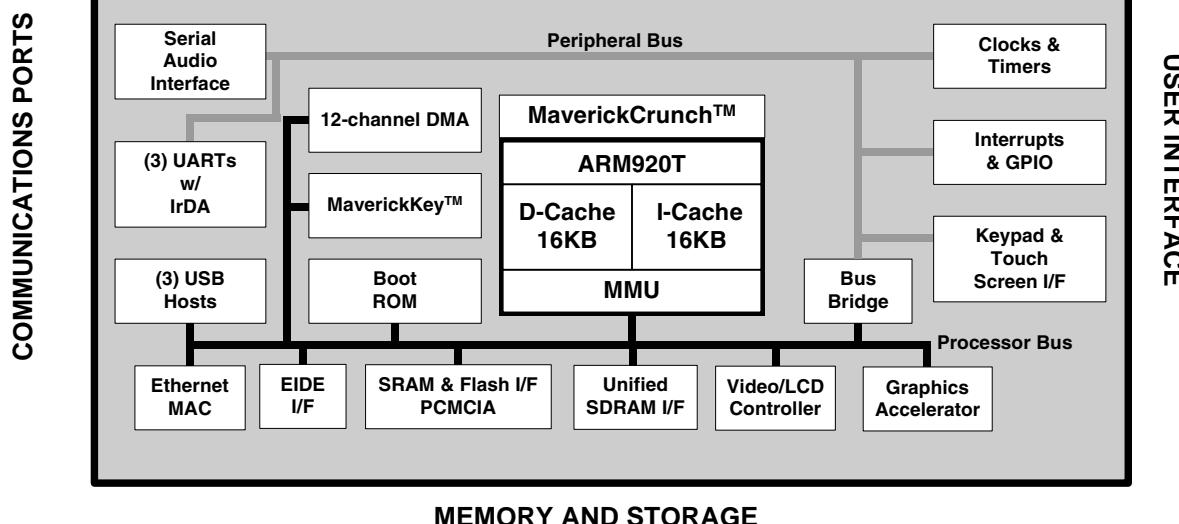


## FEATURES

- 200-MHz ARM920T Processor
  - 16-kbyte Instruction Cache
  - 16-kbyte Data Cache
  - Linux®, Microsoft® Windows® CE-enabled MMU
  - 100-MHz System Bus
- MaverickCrunch™ Math Engine
  - Floating Point, Integer, and Signal Processing Instructions
  - Optimized for digital music compression and decompression algorithms.
  - Hardware interlocks allow in-line coding.
- MaverickKey™ IDs
  - 32-bit Unique ID can be used for DRM-compliant 128-bit random ID.
- Integrated Peripheral Interfaces
  - 32-bit SDRAM Interface (up to 4 Banks)
  - 32-/16-bit SRAM / FLASH / ROM
  - Serial EEPROM Interface
  - EIDE (up to 2 devices)
  - 1/10/100-Mbps Ethernet MAC
  - Three UARTs
  - Three-port USB 2.0 Full-speed Host (OHCI) (12 Mbits per second)
  - LCD and Raster Interface with Graphics Accelerator

## Enhanced Universal Platform System-on-Chip Processor

- IrDA Interface
- PCMCIA Interface
- Touchscreen Interface with ADC
- 8 x 8 Keypad Scanner
- One Serial Peripheral Interface (SPI™) Port
- 6-channel or 2-channel Serial Audio Interface (I<sup>2</sup>S)
- 2-channel, Low-cost Serial Audio Interface (AC'97)
- 2 High-resolution PWMs (16 bits each)
- Internal Peripherals
  - 12 Direct Memory Access (DMA) Channels
  - Real-time Clock with Software Trim
  - Dual PLL controls all clock domains.
  - Watchdog Timer
  - Two General-purpose 16-bit Timers
  - One General-purpose 32-bit Timer
  - One 40-bit Debug Timer
  - Interrupt Controller
  - Boot ROM
- Package
  - 352-pin PBGA



## OVERVIEW

The EP9315 is an ARM920T-based system-on-a-chip design with a large peripheral set targeted to a variety of applications:

- Thin Client Computers for Business and Home
  - Internet Radio
  - Internet Access Devices
  - Industrial Computers
  - Specialized Terminals
  - Point-of-sale Terminals
  - Test and Measurement Equipment

The ARM920T microprocessor core with separate 16-kbyte, 64-way set-associative instruction and data caches is augmented by the MaverickCrunch™ co-processor, enabling high-speed floating point calculations.

MaverickKey™ unique hardware programmed IDs are a solution to the growing concern over secure web content and commerce. With Internet security playing an important role in the delivery of digital media such as

books or music, traditional software methods are quickly becoming unreliable. The MaverickKey unique IDs provide OEMs with a method of utilizing specific hardware IDs such as those assigned for SDMI (Secure Digital Music Initiative) or any other authentication mechanism.

A high-performance 1/10/100-Mbps Ethernet media access controller (EMAC) is included along with external interfaces to SPI, I<sup>2</sup>S audio, Raster/LCD, IDE storage peripherals, keypad, and touchscreen. A three-port USB 2.0 Full Speed Host (OHCI) (12 Mbits per second) and three UARTs are included as well.

The EP9315 is a high-performance, low-power, RISC-based, single-chip computer built around an ARM920T microprocessor core with a maximum operating clock rate of 200 MHz (184 MHz for industrial conditions). The ARM core operates from a 1.8 V supply, while the I/O operates at 3.3 V with power usage between 100 mW and 750 mW (dependent on speed).

## Table A. Change History

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## Processor Core - ARM920T

The ARM920T is a Harvard architecture processor with separate 16-kbyte instruction and data caches with an 8-word line length but a unified memory. The processor utilizes a five-stage pipeline consisting of fetch, decode, execute, memory, and write stages. Key features include:

- ARM (32-bit) and Thumb (16-bit compressed) Instruction Sets
- 32-bit Advanced Micro-Controller Bus Architecture (AMBA)
- 16-kbyte Instruction Cache with Lockdown
- 16-kbyte Data Cache (programmable write-through or write-back) with Lockdown
- MMU for Linux®, Microsoft® Windows® CE and Other Operating Systems
- Translation Look Aside Buffers with 64 Data and 64 Instruction Entries
- Programmable Page Sizes of 1 Mbyte, 64 kbyte, 4 kbyte, and 1 kbyte
- Independent Lockdown of TLB Entries

## MaverickCrunch™ Math Engine

The MaverickCrunch Engine is a mixed-mode coprocessor designed primarily to accelerate the math processing required to rapidly encode digital audio formats. It accelerates single and double precision integer and floating point operations plus an integer multiply-accumulate (MAC) instruction that is considerably faster than the ARM920T's native MAC instruction. The ARM920T coprocessor interface is utilized thereby sharing its memory interface and instruction stream. Hardware forwarding and interlock allows the ARM to handle looping and addressing while MaverickCrunch handles computation. Features include:

- IEEE-754 single and double precision floating point
- 32 / 64-bit integer
- Add / multiply / compare
- Integer MAC 32-bit input with 72-bit accumulate
- Integer Shifts
- Floating point to/from integer conversion
- Sixteen 64-bit register files
- Four 72-bit accumulators

## MaverickKey™ Unique ID

MaverickKey unique hardware programmed IDs are a solution to the growing concern over secure web content and commerce. With Internet security playing an important role in the delivery of digital media such as books or music, traditional software methods are quickly becoming unreliable. The MaverickKey unique IDs

provide OEMs with a method of utilizing specific hardware IDs such as those assigned for SDMI (Secure Digital Music Initiative) or any other authentication mechanism.

Both a specific 32-bit ID as well as a 128-bit random ID is programmed into the EP9315 through the use of laser probing technology. These IDs can then be used to match secure copyrighted content with the ID of the target device the EP9315 is powering, and then deliver the copyrighted information over a secure connection. In addition, secure transactions can benefit by also matching device IDs to server IDs. MaverickKey IDs provide a level of hardware security required for today's Internet appliances.

## General Purpose Memory Interface (SDRAM, SRAM, ROM, FLASH)

The EP9315 features a unified memory address model where all memory devices are accessed over a common address/data bus. A separate internal port is dedicated to the read-only Raster/LCD refresh engine, while the rest of the memory accesses are performed via the Processor bus. The SRAM memory controller supports 8, 16 and 32-bit devices and accommodates an internal boot ROM concurrently with 32-bit SDRAM memory.

- 1-4 banks of 32-bit 66 or 100 MHz SDRAM
- One internal port dedicated to the Raster/LCD Refresh Engine (Read Only)
- Address and data bus shared between SDRAM, SRAM, ROM, and FLASH memory
- NOR FLASH memory supported

**Table B. General Purpose Memory Interface Pin Assignments**

| Pin Mnemonic          | Pin Description                   |
|-----------------------|-----------------------------------|
| SDCLK                 | SDRAM Clock                       |
| SDCLKEN               | SDRAM Clock Enable                |
| SDCSn[3:0]            | SDRAM Chip Selects 3-0            |
| RASn                  | SDRAM RAS                         |
| CASn                  | SDRAM CAS                         |
| SDWEn                 | SDRAM Write Enable                |
| CSn[7:6] and CSn[3:0] | Chip Selects 7, 6, 3, 2, 1, 0     |
| AD[25:0]              | Address Bus 25-0                  |
| DA[31:0]              | Data Bus 31-0                     |
| DQMn[3:0]             | SDRAM Output Enables / Data Masks |
| WRn                   | SRAM Write Strobe                 |
| RDn                   | SRAM Read / OE Strobe             |
| WAITn                 | SRAM Wait Input                   |

## IDE Interface

The IDE Interface provides an industry-standard connection to two AT Advanced Packet Interface (ATAPI) compliant devices. The IDE port will attach to a master and a slave device. The internal DMA controller performs all data transfers using the Ultra DMA modes. The interface supports the following operating modes:

- PIO Mode 0 thru 4
- Ultra DMA Modes 0 thru 3

**Table C. IDE Interface Pin Assignments**

| Pin Mnemonic | Pin Description         |
|--------------|-------------------------|
| DD[15-0]     | IDE Data bus            |
| IDEDA[2-0]   | IDE Device address      |
| IDECSn[0,1]  | IDE Chip Select 0 and 1 |
| DIORn        | IDE Read Strobe         |
| DIOWn        | IDE Write Strobe        |
| DMACKn       | IDE DMA acknowledge     |

## Ethernet Media Access Controller (MAC)

The MAC subsystem is compliant with the ISO/IEC 802.3 topology for a single shared medium with several stations. Multiple MII-compliant PHYs are supported. Features include:

- Supports 1/10/100 Mbps transfer rates for home / small-business / large-business applications
- Interfaces to an off-chip PHY through industry standard Media Independent Interface (MII)

**Table D. Ethernet Media Access Controller Pin Assignments**

| Pin Mnemonic | Pin Description       |
|--------------|-----------------------|
| MDC          | Management Data Clock |
| MDIO         | Management Data I/O   |
| RXCLK        | Receive Clock         |
| MIIRXD[3:0]  | Receive Data          |
| RXDVAL       | Receive Data Valid    |
| RXERR        | Receive Data Error    |
| TXCLK        | Transmit Clock        |
| MIITXD[3:0]  | Transmit Data         |
| TXEN         | Transmit Enable       |
| TXERR        | Transmit Error        |
| CRS          | Carrier Sense         |
| CLD          | Collision Detect      |

## Serial Interfaces (SPI, I<sup>2</sup>S and AC '97)

The SPI port can be configured as a master or a slave, supporting the National Semiconductor®, Motorola® and Texas Instruments® signaling protocols.

The AC'97 port supports multiple codecs for multichannel audio output with a single stereo input. Three I<sup>2</sup>S ports can be configured to support six channel 24-bit audio.

These ports are multiplexed so that I<sup>2</sup>S port 0 will take over either the AC'97 pins or the SPI pins. The second and third I<sup>2</sup>S ports' serial input and serial output pins are multiplexed with EGPIO[4,5,6,13]. The clocks supplied in the first I<sup>2</sup>S port are also used for the second and third I<sup>2</sup>S ports.

- Normal Mode: One SPI Port and one AC'97 Port
- I<sup>2</sup>S on SSP Mode: One AC'97 Port and up to three I<sup>2</sup>S Ports
- I<sup>2</sup>S on AC'97 Mode: One SPI Port and up to three I<sup>2</sup>S Ports

**Table E. Audio Interfaces Pin Assignment**

| Pin Name | Normal Mode         | I <sup>2</sup> S on SSP Mode       | I <sup>2</sup> S on AC'97 Mode |
|----------|---------------------|------------------------------------|--------------------------------|
|          | Pin Description     | Pin Description                    | Pin Description                |
| SCLK1    | SPI Bit Clock       | I <sup>2</sup> S Serial Clock      | SPI Bit Clock                  |
| SFRM1    | SPI Frame Clock     | I <sup>2</sup> S Frame Clock       | SPI Frame Clock                |
| SSPRX1   | SPI Serial Input    | I <sup>2</sup> S Serial Input      | SPI Serial Input               |
| SSPTX1   | SPI Serial Output   | I <sup>2</sup> S Serial Output     | SPI Serial Output              |
|          |                     | (No I <sup>2</sup> S Master Clock) |                                |
| ARSTn    | AC'97 Reset         | AC'97 Reset                        | I <sup>2</sup> S Master Clock  |
| ABITCLK  | AC'97 Bit Clock     | AC'97 Bit Clock                    | I <sup>2</sup> S Serial Clock  |
| ASYNC    | AC'97 Frame Clock   | AC'97 Frame Clock                  | I <sup>2</sup> S Frame Clock   |
| ASDI     | AC'97 Serial Input  | AC'97 Serial Input                 | I <sup>2</sup> S Serial Input  |
| ASDO     | AC'97 Serial Output | AC'97 Serial Output                | I <sup>2</sup> S Serial Output |

## Raster / LCD Interface

The Raster / LCD interface provides data and interface signals for a variety of display types. It features fully programmable video interface timing for non-interlaced flat panel or dual scan displays. Resolutions up to 1024 x 768 are supported from a unified SDRAM based frame buffer. A 16-bit PWM provides control for LCD panel contrast. LCD specific features include:

- Timing and interface signals for digital LCD and TFT displays
- Full programmability for either non-interlaced or dual-scan color and grayscale flat panel displays
- Dedicated data path to SDRAM controller for improved system performance
- Pixel depths of 4, 8, 16, or 24 bits per pixel or 256 levels of grayscale
- Hardware Cursor up to 64 x 64 pixels
- 256 x 18 Color Lookup Table
- Hardware Blinking
- 8-bit interface to low end panel

**Table F. LCD Interface Pin Assignments**

| Pin Mnemonic | Pin Description                                     |
|--------------|---|
| SPCLK        | Pixel Clock   |
| P[17:0]      | Pixel Data Bus [17:0]                               |
| HSYNC / LP   | Horizontal Synchronization / Line Pulse             |
| VCSYNC / FP  | Vertical or Composite Synchronization / Frame Pulse |
| BLANK        | Composite Blank                                     |
| BRIGHT       | Pulse Width Modulated Brightness                    |

## Graphics Accelerator

The EP9315 contains a hardware graphics acceleration engine that improves graphic performance by handling block copy, block fill and hardware line draw operations. The Graphics Accelerator is used in the system to off-load graphics operations from the processor.

Pixel depths supported by the Graphics Accelerator are 4, 8, 16 or 24 bits per pixel. The 24 bits per pixel mode can be operated as packed (4 pixels every 3 words) or unpacked (1 pixel per word with the high byte unused.)

The block copy operations of the Graphics Accelerator are similar to a DMA (Direct Memory Access) transfer that understands pixel organization, block width, transparency, and transformation from 1bpp to higher 4, 8, 16 or 24bpp.

The line draw operations also allow for solid lines or dashed lines. The colors for line drawing can be either foreground color and background color or foreground color with the background being transparent.

## Touch Screen Interface with 12-bit Analog-to-digital Converter (ADC)

The touch screen interface performs all sampling, averaging, ADC range checking, and control for a wide variety of analog resistive touch screens. This controller

only interrupts the processor when a meaningful change occurs. The touch screen hardware may be disabled and the switch matrix and ADC controlled directly if desired. Features include:

- Support for 4-, 5-, 7-, or 8-wire analog resistive touch screens.
- Flexibility - unused lines may be used for temperature sensing or other functions.
- Touch screen interrupt function.

**Table G. Touch Screen Interface with 12-bit Analog-to-Digital Converter Pin Assignments**

| Pin Mnemonic | Pin Description                          |
|--------------|--|
| Xp, Xm       | Touch screen ADC X Axis                  |
| Yp, Ym       | Touch screen ADC Y Axis                  |
| SXp, SXm     | Touch screen ADC X Axis Voltage Feedback |
| SYp, SYm     | Touch screen ADC Y Axis Voltage Feedback |

## 64-Key Keypad Interface

The keypad circuitry scans an 8 x 8 array of 64 normally open, single-pole switches. Any one or two keys depressed will be de-bounced and decoded. An interrupt is generated whenever a stable set of depressed keys is detected. If the keypad is not utilized, the 16 column/row pins may be used as general purpose I/O. The Keypad interface:

- Provides scanning, debounce, and decoding for a 64-key switch array.
- Scans an 8-row by 8-column matrix.
- May decode 2 keys at once.
- Generates an interrupt when a new stable key is determined.
- Also generates a 3-key reset interrupt.

**Table H. 64-Key Keypad Interface Pin Assignments**

| Pin Mnemonic | Pin Description          | Alternative Usage   |
|--------------|--------------------------|---------------------|
| COL[7:0]     | Key Matrix Column Inputs | General Purpose I/O |
| ROW[7:0]     | Key Matrix Row Inputs    | General Purpose I/O |

## Universal Asynchronous Receiver/Transmitters (UARTs)

Three 16550-compatible UARTs are supplied. Two provide asynchronous HDLC (High-level Data Link Control) protocol support for full-duplex transmit and receive. The HDLC receiver handles framing, address matching, CRC checking, control-octet transparency, and optionally passes the CRC to the host at the end of the packet. The HDLC transmitter handles framing, CRC generation, and control-octet transparency. The host must assemble the frame in memory before transmission. The HDLC receiver and transmitter use the UART FIFOs to buffer the data streams. A third IrDA®-compatible UART is also supplied.

- UART1 supports modem bit rates up to 115.2 Kbps, supports HDLC and includes a 16-byte FIFO for receive and a 16-byte FIFO for transmit. Interrupts are generated on Rx, Tx, and modem status change.
- UART2 contains an IrDA encoder operating at either the slow (up to 115 Kbps), medium (0.576 or 1.152 Mbps), or fast (4 Mbps) IR data rates. It also has a 16-byte FIFO for receive and a 16-byte FIFO for transmit.
- UART3 supports HDLC and includes a 16-byte FIFO for receive and a 16-byte FIFO for transmit. Interrupts are generated on Rx and Tx.

**Table I. Universal Asynchronous Receiver/Transmitters Pin Assignments**

| Pin Mnemonic                        | Pin Name - Description                     |
|-------------------------------------|--|
| TXD0                                | UART1 Transmit                             |
| RXD0                                | UART1 Receive                              |
| CTS <sub>n</sub>                    | UART1 Clear To Send / Transmit Enable      |
| DSR <sub>n</sub> / DCD <sub>n</sub> | UART1 Data Set Ready / Data Carrier Detect |
| DTR <sub>n</sub>                    | UART1 Data Terminal Ready                  |
| RTS <sub>n</sub>                    | UART1 Ready To Send                        |
| EGPIO[0] / RI                       | UART1 Ring Indicator                       |
| TXD1 / SIROUT                       | UART2 Transmit / IrDA Output               |
| RXD1 / SIRIN                        | UART2 Receive / IrDA Input                 |
| TXD2                                | UART3 Transmit                             |
| RXD2                                | UART3 Receive                              |
| EGPIO[3] / TEN <sub>n</sub>         | HDLC3 Transmit Enable                      |

## Triple Port USB Host

The USB Open Host Controller Interface (Open HCI) provides full speed serial communications ports at a baud rate of 12 Mbits/sec. Up to 127 USB devices (printer, mouse, camera, keyboard, etc.) and USB hubs can be connected to the USB host in the USB “tiered-start” topology.

This includes the following features:

- Compliance with the USB 2.0 specification
- Compliance with the Open HCI Rev 1.0 specification
- Supports both low speed (1.5 Mbps) and full speed (12 Mbps) USB device connections
- Root HUB integrated with 3 downstream USB ports
- Transceiver buffers integrated, over-current protection on ports
- Supports power management
- Operates as a master on the bus

The Open HCI host controller initializes the master DMA transfer with the AHB bus:

- Fetches endpoint descriptors and transfer descriptors
- Accesses endpoint data from system memory
- Accesses the HC communication area
- Writes status and retire transfer descriptor

**Table J. Triple Port USB Host Pin Assignments**

| Pin Mnemonic | Pin Name - Description |
|--------------|------------------------|
| USBp[2:0]    | USB Positive signals   |
| USBm[2:0]    | USB Negative Signals   |

## Two-wire Interface

The two-wire interface provides communication and control for synchronous-serial-driven devices.

**Table K. Two-Wire Port with EEPROM Support Pin Assignments**

| Pin Mnemonic | Pin Name - Description   | Alternative Usage   |
|--------------|--------------------------|---------------------|
| EECLK        | Two-Wire Interface Clock | General Purpose I/O |
| EEDATA       | Two-Wire Interface Data  | General Purpose I/O |

## Real-Time Clock with Software Trim

The software trim feature on the real time clock (RTC) provides software controlled digital compensation of the 32.768 kHz input clock. This compensation is accurate to  $\pm 1.24$  sec/month.

*Note:* A real time clock must be connected to RTCXTALI or the EP9315 device will not boot.

Table L. Real-Time Clock with Pin Assignments

| Pin Mnemonic | Pin Name - Description            |
|--------------|-----------------------------------|
| RTCXTALI     | Real-Time Clock Oscillator Input  |
| RTCXTALO     | Real-Time Clock Oscillator Output |

## PLL and Clocking

The processor and the peripheral clocks operate from a single 14.7456 MHz crystal.

The real time clock operates from a 32.768 kHz external oscillator.

Table M. PLL and Clocking Pin Assignments

| Pin Mnemonic | Pin Name - Description |
|--------------|------------------------|
| XTALI        | Main Oscillator Input  |
| XTALO        | Main Oscillator Output |
| VDD_PLL      | Main Oscillator Power  |
| GND_PLL      | Main Oscillator Ground |

## Timers

The Watchdog Timer insures proper operation by requiring periodic attention to prevent a reset-on-time-out.

Two 16-bit timers operate as free running down-counters or as periodic timers for fixed interval interrupts and have a range of 0.03 ms to 4.27 seconds.

One 32-bit timer, plus a 6-bit prescale counter, has a range of 0.03  $\mu$ s to 73.3 hours.

One 40-bit debug timer, plus 6-bit prescale counter, has a range of 1.0  $\mu$ s to 12.7 days.

## Interrupt Controller

The interrupt controller allows up to 64 interrupts to generate an Interrupt Request (IRQ) or Fast Interrupt Request (FIQ) signal to the processor core. Thirty-two hardware priority assignments are provided for assisting IRQ vectoring, and two levels are provided for FIQ vectoring. This allows time critical interrupts to be processed in the shortest time possible. Internal interrupts may be programmed as active-high or active-

low, level-sensitive inputs. GPIO may be programmed as active-high, level-sensitive, active-low, level-sensitive, rising-edge-triggered, falling-edge-triggered, or combined rising/falling-edge-triggered.

- Supports 64 interrupts from a variety of sources (such as UARTs, GPIO, and key matrix)
- Routes interrupt sources to either the ARM920T's IRQ or FIQ (Fast IRQ) inputs
- Four dedicated off-chip interrupt lines INT[3:0] operate as active-high, level-sensitive interrupts
- Any of the 16 GPIO lines maybe configured to generate interrupts
- Software supported priority mask for all FIQs and IRQs

Table N. External Interrupt Pin Assignment

| Pin Mnemonic | Pin Name - Description |
|--------------|------------------------|
| INT[3:0]     | External Interrupt 3-0 |

## Dual LED Drivers

Two pins are assigned specifically to drive external LEDs.

Table O. Dual LED Pin Assignments

| Pin Mnemonic | Pin Name - Description | Alternative Usage   |
|--------------|------------------------|---------------------|
| GRLED        | Green LED              | General Purpose I/O |
| REDLED       | Red LED                | General Purpose I/O |

## General Purpose Input/Output (GPIO)

The 16 EGPIOS may each be configured individually as an output, an input, or an interrupt input. Port F may be configured as GPIO. Each Port F pin may be configured individually as an output, input or an interrupt input.

There are 23 pins that may be used as alternate inputs or outputs, but do not support interrupts. These pins are:

- Key Matrix ROW[7:0], COL[7:0]
- Ethernet MDIO
- Both LED Outputs
- Two-wire Clock and Data
- SLA [1:0]

6 pins may alternatively be used as inputs only:

- CTS<sub>n</sub>, DSR<sub>n</sub> / DCD<sub>n</sub>
- 4 Interrupt Lines

2 pins may alternatively be used as outputs only:

- RTS<sub>n</sub>
- ARST<sub>n</sub>

**Table P. General Purpose Input/Output Pin Assignment**

| Pin Mnemonic | Pin Name - Description                                       |
|--------------|--|
| EGPIO[15:0]  | Expanded General Purpose Input / Output Pins with Interrupts |
| FGPIO[7:0]   | Expanded General Purpose Input / Output Pins with Interrupts |

*Note: Port F defaults as PCMCIA pins. Port F must be configured by software to be used as GPIO.*

## Reset and Power Management

The chip may be reset through the PRSTn pin or through the open drain common reset pin, RSTOn.

Clocks are managed on a peripheral-by-peripheral basis and may be turned off to conserve power.

The processor clock is dynamically adjustable from 0 to 200 MHz (184 MHz for industrial conditions).

**Table Q. Reset and Power Management Pin Assignments**

| Pin Mnemonic | Pin Name - Description   |
|--------------|--|
| PRSTn        | Power On Reset   |
| RSTOn        | User Reset In/Out – Open Drain – Preserves Real Time Clock value |

## Hardware Debug Interface

The JTAG interface allows use of ARM's Multi-ICE or other in-circuit emulators.

*Note: The JTAG interface does not support boundary scan.*

**Table R. Hardware Debug Interface**

| Pin Mnemonic | Pin Name - Description |
|--------------|------------------------|
| TCK          | JTAG Clock             |
| TDI          | JTAG Data In           |
| TDO          | JTAG Data Out          |
| TMS          | JTAG Test Mode Select  |
| TRSTn        | JTAG Port Reset        |

## Internal Boot ROM

The Internal 16-kbyte ROM allows booting from FLASH memory, SPI or UART. Consult the EP93xx User's Manual for operational details

## 12-channel DMA Controller

The DMA module contains 12 separate DMA channels. Ten of these may be used for peripheral-to-memory or memory-to-peripheral access. Two of these are dedicated to memory-to-memory transfers. Each DMA channel is connected to the 16-bit DMA request bus.

The request bus is a collection of requests, Serial Audio, and UARTs. Each DMA channel can be used independently or dedicated to any request signal. For each DMA channel, source and destination addressing can be independently programmed to increment, decrement, or stay at the same value. All DMA addresses are physical, not virtual addresses.

## PCMCIA Interface

The EP9315 has a single PCMCIA port which can be used to access either 8 or 16-bit devices.

**Table S. PCMCIA Interface**

| Pin Mnemonic | Pin Name - Description             |
|--------------|------------------------------------|
| VS1          | Voltage sense                      |
| VS2          | Voltage sense                      |
| MCD1         | Card detect                        |
| MCD2         | Card detect                        |
| MCBVD1       | Voltage detection / status change  |
| MCBVD2       | Voltage detection                  |
| MCDIR        | Data transceiver direction control |
| MCDAENn      | Data bus transceiver enable        |
| MCADENn      | Address bus transceiver enable     |
| MCREGn       | Memory card register               |
| MCEHn        | Memory card high byte select       |
| MCELn        | Memory card low byte select        |
| IORDn        | I/O card read                      |
| IOWRn        | I/O card write                     |
| MCRDn        | Memory card read                   |
| MCWRn        | Memory card write                  |
| READY        | Ready / interrupt                  |
| WP           | Write protect                      |
| MCWAITn      | Wait Input                         |
| MCRESETn     | Card reset                         |

## Electrical Specifications

### Absolute Maximum Ratings

(All grounds = 0 V, all voltages with respect to 0 V)

| Parameter                                      | Symbol  | Min  | Max      | Unit |
|--|---------|------|----------|------|
| Power Supplies                                 | RVDD    | -    | 3.96     | V    |
|  | CVDD    | -    | 2.16     | V    |
|  | VDD_PLL | -    | 2.16     | V    |
|  | VDD_ADC | -    | 3.96     | V    |
| Total Power Dissipation<br>(Note 1)            |         | -    | 2        | W    |
| Input Current per Pin, DC (Except supply pins) |         | -    | $\pm 10$ | mA   |
| Output current per pin, DC                     |         | -    | $\pm 50$ | mA   |
| Digital Input voltage<br>(Note 2)              |         | -0.3 | RVDD+0.3 | V    |
| Storage temperature                            |         | -40  | +125     | °C   |

Note:

1. Includes all power generated due to AC and/or DC output loading.
2. The power supply pins are at recommended maximum values.
3. At ambient temperatures above 70° C, total power dissipation must be limited to less than 2.5 Watts.

**WARNING:** Operation beyond these limits may result in permanent damage to the device.  
Normal operation is not guaranteed at these extremes.

### Recommended Operating Conditions

(All grounds = 0 V, all voltages with respect to 0 V)

| Parameter                                  | Symbol         | Min  | Typ  | Max  | Unit |
|--|----------------|------|------|------|------|
| Power Supplies                             | RVDD           | 3.0  | 3.3  | 3.6  | V    |
|  | CVDD           | 1.65 | 1.80 | 1.94 | V    |
|  | VDD_PLL        | 1.65 | 1.80 | 1.94 | V    |
|  | VDD_ADC        | 3.0  | 3.3  | 3.6  | V    |
| Operating Ambient Temperature - Commercial | T <sub>A</sub> | 0    | +25  | +70  | °C   |
| Operating Ambient Temperature - Industrial | T <sub>A</sub> | -40  | +25  | +85  | °C   |
| Processor Clock Speed - Commercial         | FCLK           | -    | -    | 200  | MHz  |
| Processor Clock Speed - Industrial         | FCLK           | -    | -    | 184  | MHz  |
| System Clock Speed - Commercial            | HCLK           | -    | -    | 100  | MHz  |
| System Clock Speed - Industrial            | HCLK           | -    | -    | 92   | MHz  |

## DC Characteristics

( $T_A = 0$  to  $70^\circ C$ ;  $CVDD = VDD\_PLL = 1.8$ ;  $RVDD = 3.3$  V;

All grounds = 0 V; all voltages with respect to 0 V unless otherwise noted)

| Parameter   | Symbol   | Min                | Max                | Unit    |
|---|----------|--------------------|--------------------|---------|
| High level output voltage<br>Iout = -4 mA<br>(Note 4)   | $V_{oh}$ | $0.85 \times RVDD$ | -                  | V       |
| Low level output voltage<br>Iout = 4 mA                 | $V_{ol}$ | -                  | $0.15 \times RVDD$ | V       |
| High level input voltage<br>(Note 5)                    | $V_{ih}$ | $0.65 \times RVDD$ | $VDD + 0.3$        | V       |
| Low level input voltage<br>(Note 5)                     | $V_{il}$ | -0.3               | $0.35 \times RVDD$ | V       |
| High level leakage current<br>$Vin = 3.3$ V<br>(Note 5) | $I_{ih}$ | -                  | 10                 | $\mu A$ |
| Low level leakage current<br>$Vin = 0$<br>(Note 5)      | $I_{il}$ | -                  | -10                | $\mu A$ |

| Parameter   | Min | Typ       | Max       | Unit         |
|---|-----|-----------|-----------|--------------|
| Power Supply Pins (Outputs Unloaded), $25^\circ C$            |     |           |           |              |
| Power Supply Current:<br>CVDD / VDD_PLL Total<br>RVDD         | -   | 190<br>45 | 240<br>80 | $mA$<br>$mA$ |
| Low-Power Mode Supply Current<br>CVDD / VDD_PLL Total<br>RVDD | -   | 2<br>1    | 3.5<br>2  | $mA$<br>$mA$ |

Note: 4. For open drain pins, high level output voltage is dependent on the external load.

5. All inputs that do not include internal pull-ups or pull-downs, must be externally driven for proper operation (See [Table S on page 60](#)). If an input is not driven, it should be tied to power or ground, depending on the particular function. If an I/O pin is not driven and programmed as an input, it should be tied to power or ground through its own resistor.

## Timings

### Timing Diagram Conventions

This data sheet contains one or more timing diagrams. The following key explains the components used in these diagrams. Any variations are clearly labelled when they occur. Therefore, no additional meaning should be attached unless specifically stated.

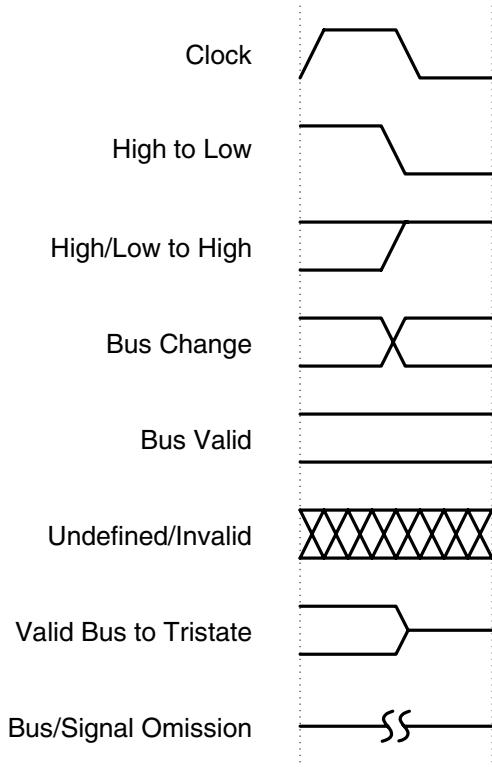


Figure 1. Timing Diagram Drawing Key

### Timing Conditions

Unless specified otherwise, the following conditions are true for all timing measurements.

- $T_A = 0$  to  $70^\circ C$
- $CVDD = VDD\_PLL = 1.8V$
- $RVDD = 3.3 V$
- All grounds = 0 V
- Logic 0 = 0 V, Logic 1 = 3.3 V
- Output loading = 50 pF
- Timing reference levels = 1.5 V
- The Processor Bus Clock (HCLK) is programmable and is set by the user. The frequency is typically between 33 MHz and 100 MHz (92 MHz for industrial conditions).

## Memory Interface

Figure 2 through Figure 5 define the timings associated with all phases of the SDRAM. The following table contains the values for the timings of each of the SDRAM modes.

| Parameter                                 | Symbol          | Min | Typ              | Max | Unit |
|---|-----------------|-----|------------------|-----|------|
| SDCLK high time                           | $t_{clk\_high}$ | -   | $(t_{HCLK}) / 2$ | -   | ns   |
| SDCLK low time                            | $t_{clk\_low}$  | -   | $(t_{HCLK}) / 2$ | -   | ns   |
| SDCLK rise/fall time                      | $t_{clkrf}$     | -   | 2                | 4   | ns   |
| Signal delay from SDCLK rising edge time  | $t_d$           | -   | -                | 8   | ns   |
| Signal hold from SDCLK rising edge time   | $t_h$           | 1   | -                | -   | ns   |
| DQMn delay from SDCLK rising edge time    | $t_{DQd}$       | -   | -                | 8   | ns   |
| DQMn hold from SDCLK rising edge time     | $t_{DQh}$       | 1   | -                | -   | ns   |
| DA valid setup to SDCLK rising edge time  | $t_{DAs}$       | 2   | -                | -   | ns   |
| DA valid hold from SDCLK rising edge time | $t_{DAh}$       | 3   | -                | -   | ns   |

## SDRAM Load Mode Register Cycle

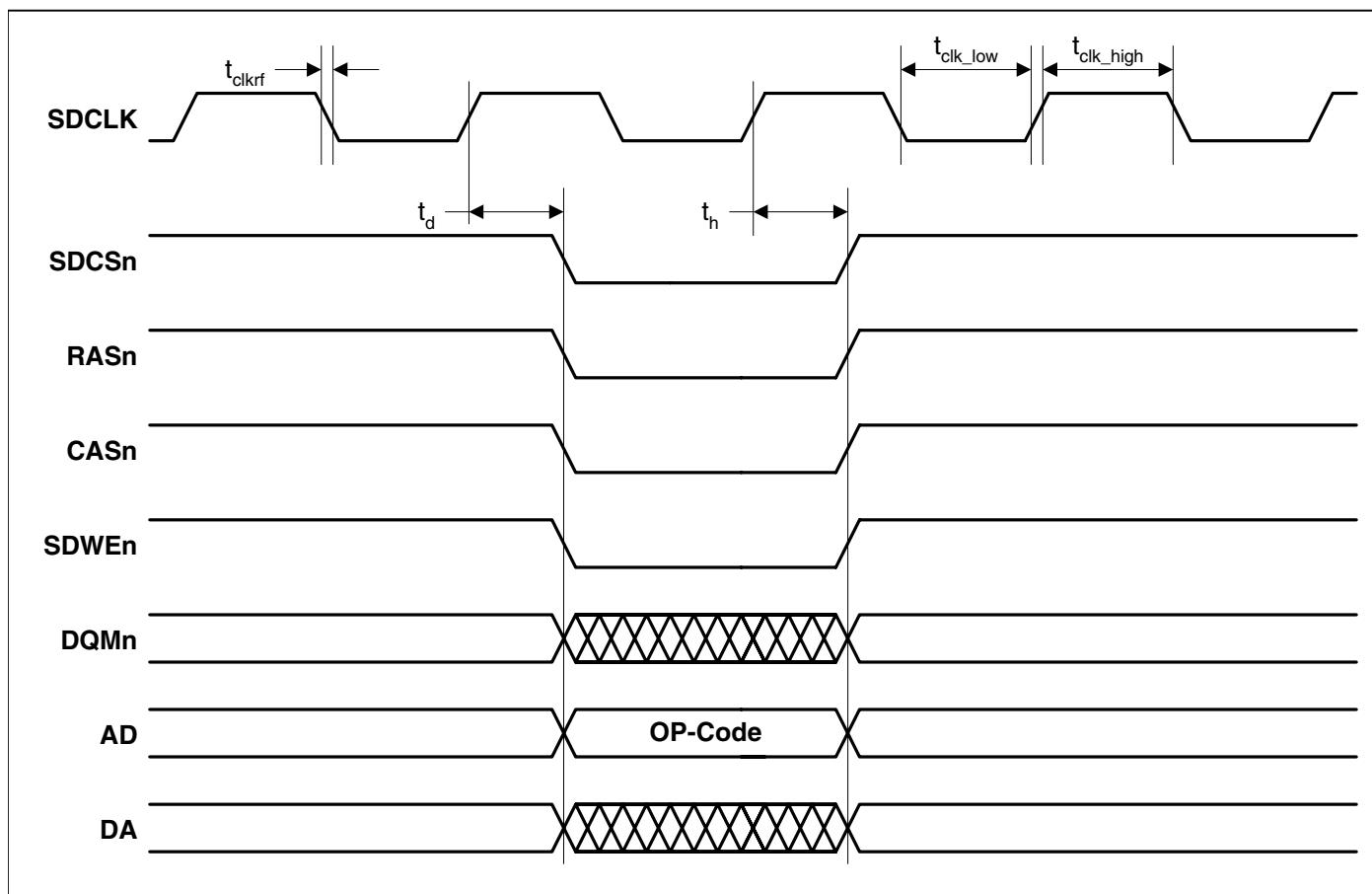


Figure 2. SDRAM Load Mode Register Cycle Timing Measurement

### SDRAM Burst Read Cycle

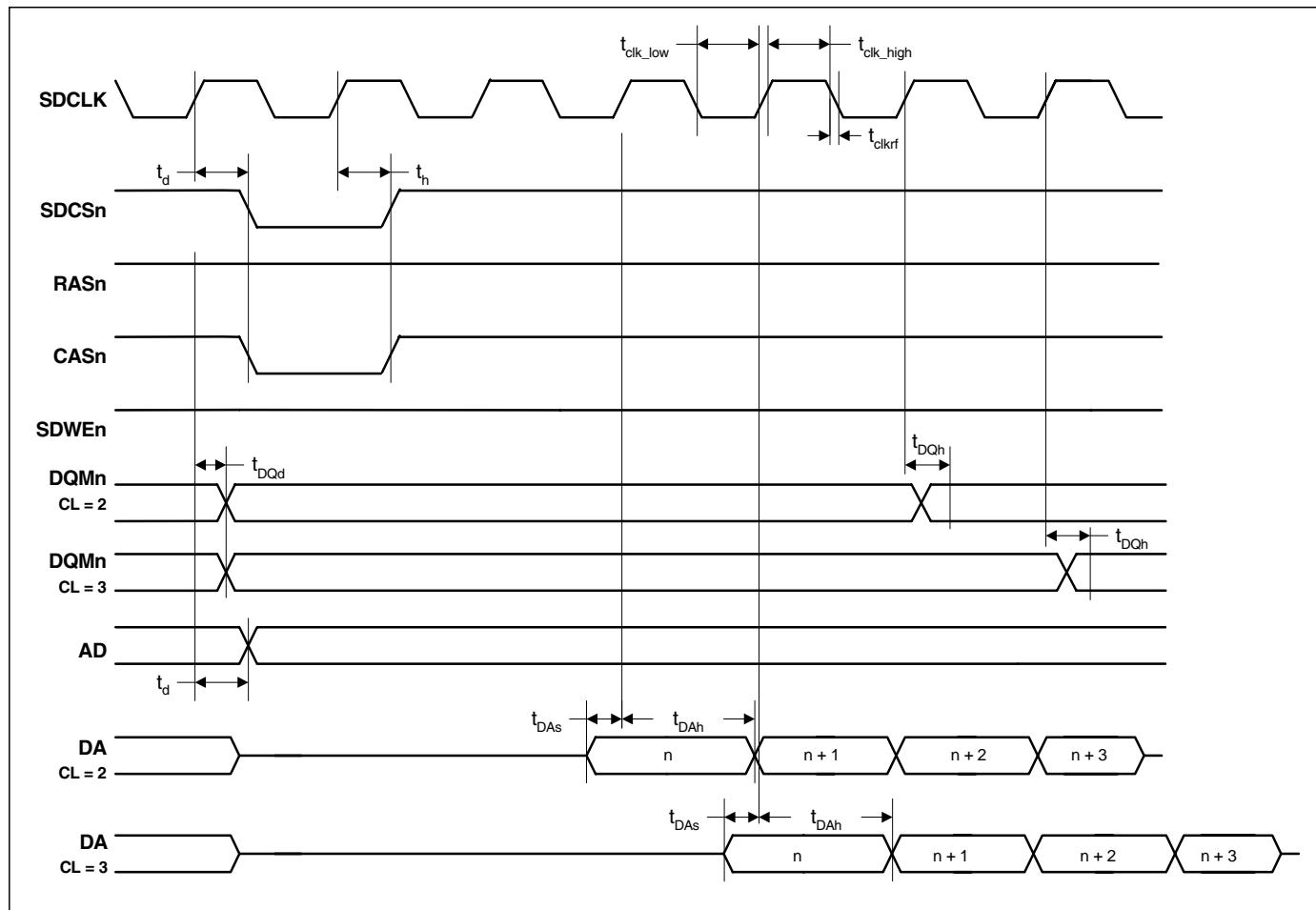


Figure 3. SDRAM Burst Read Cycle Timing Measurement

### SDRAM Burst Write Cycle

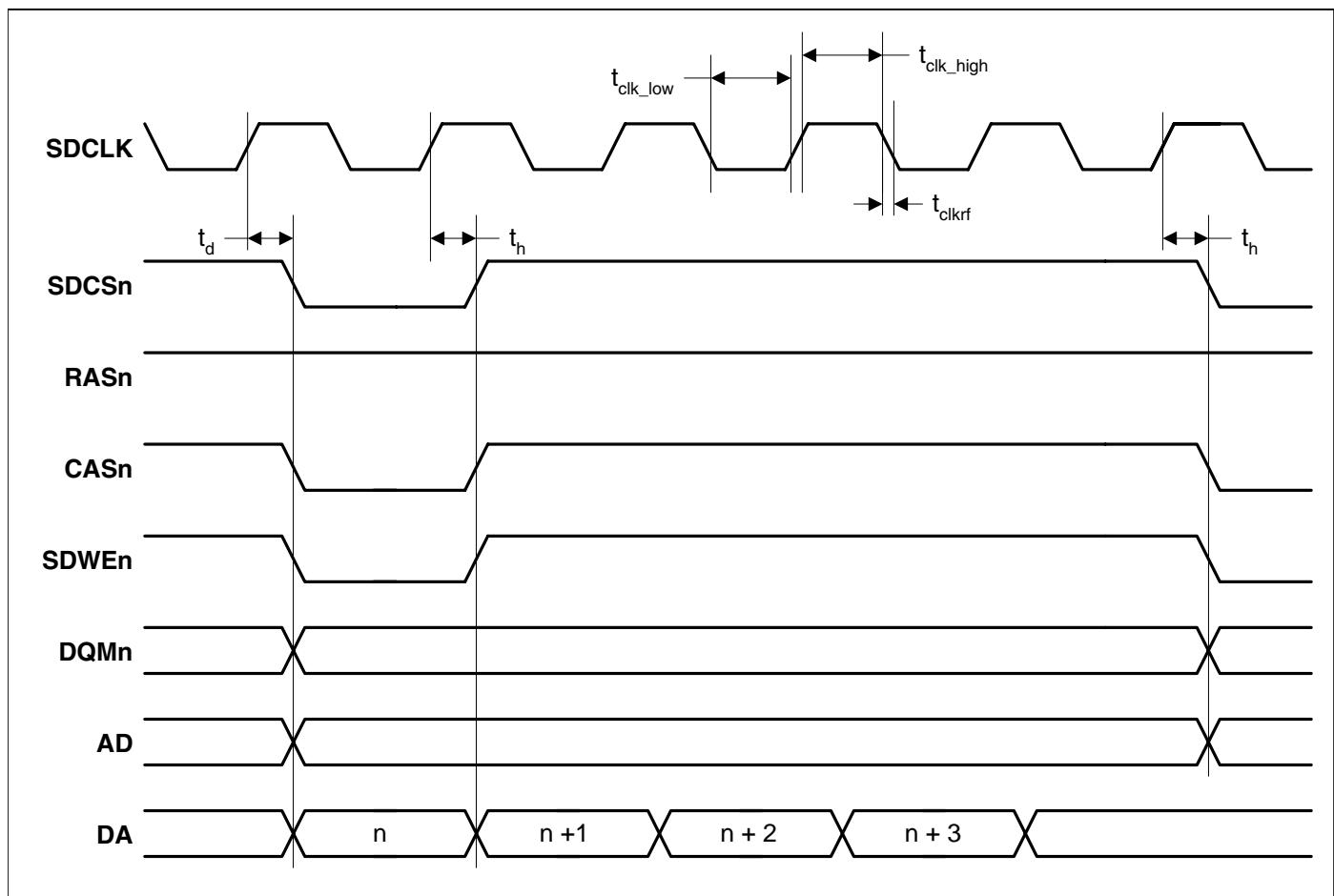
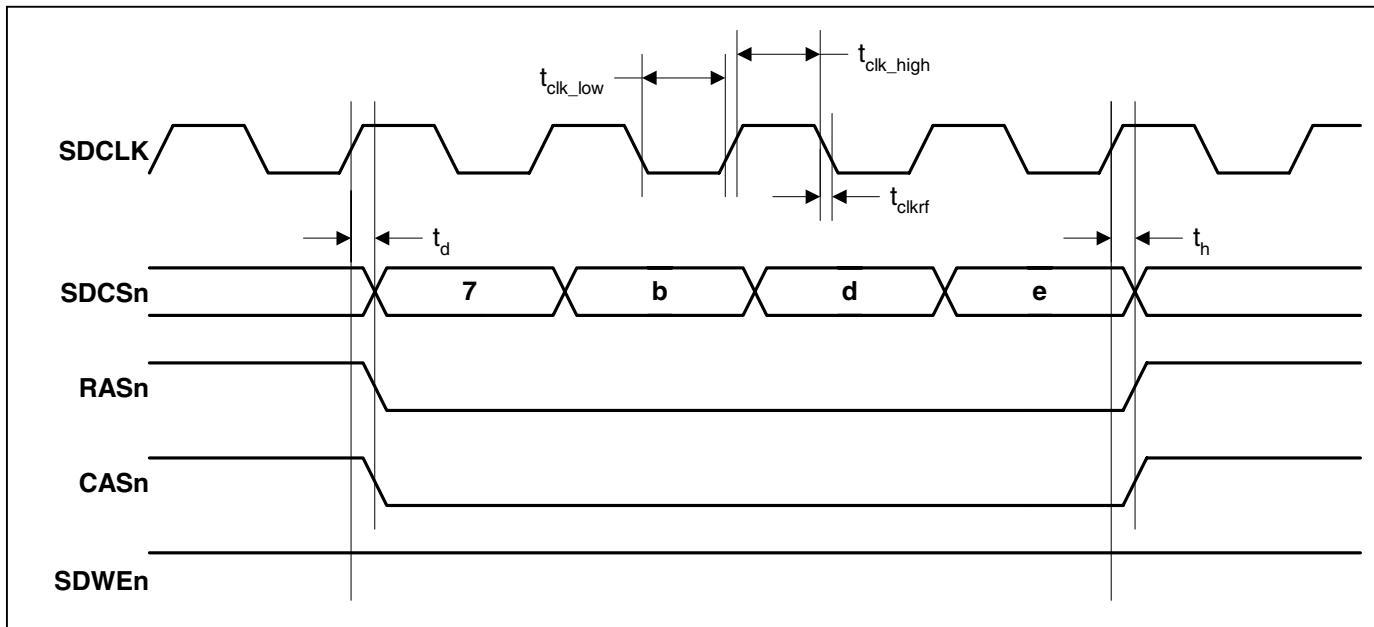


Figure 4. SDRAM Burst Write Cycle Timing Measurement

### SDRAM Auto Refresh Cycle



Note: Chip select shown as bus to illustrate multiple devices being put into auto refresh in one access

Figure 5. SDRAM Auto Refresh Cycle Timing Measurement

### Static Memory Single Word Read Cycle

| Parameter                            | Symbol     | Min             | Typ                          | Max | Unit |
|--------------------------------------|------------|-----------------|------------------------------|-----|------|
| AD setup to CSn assert time          | $t_{ADs}$  | 0               | -                            | -   | ns   |
| AD hold from CSn deassert time       | $t_{ADh}$  | $t_{HCLK}$      | -                            | -   | ns   |
| RDn assert time                      | $t_{RDpW}$ | -               | $t_{HCLK} \times (WST1 + 2)$ | -   | ns   |
| CSn to RDn delay time                | $t_{RDd}$  | -               | -                            | 3   | ns   |
| CSn assert to DQMn assert delay time | $t_{DQMd}$ | -               | -                            | 1   | ns   |
| DA setup to RDn deassert time        | $t_{DAs}$  | $t_{HCLK} + 12$ | -                            | -   | ns   |
| DA hold from RDn deassert time       | $t_{DAh}$  | 0               | -                            | -   | ns   |

See “Timing Conditions” on page 14 for definition of HCLK.

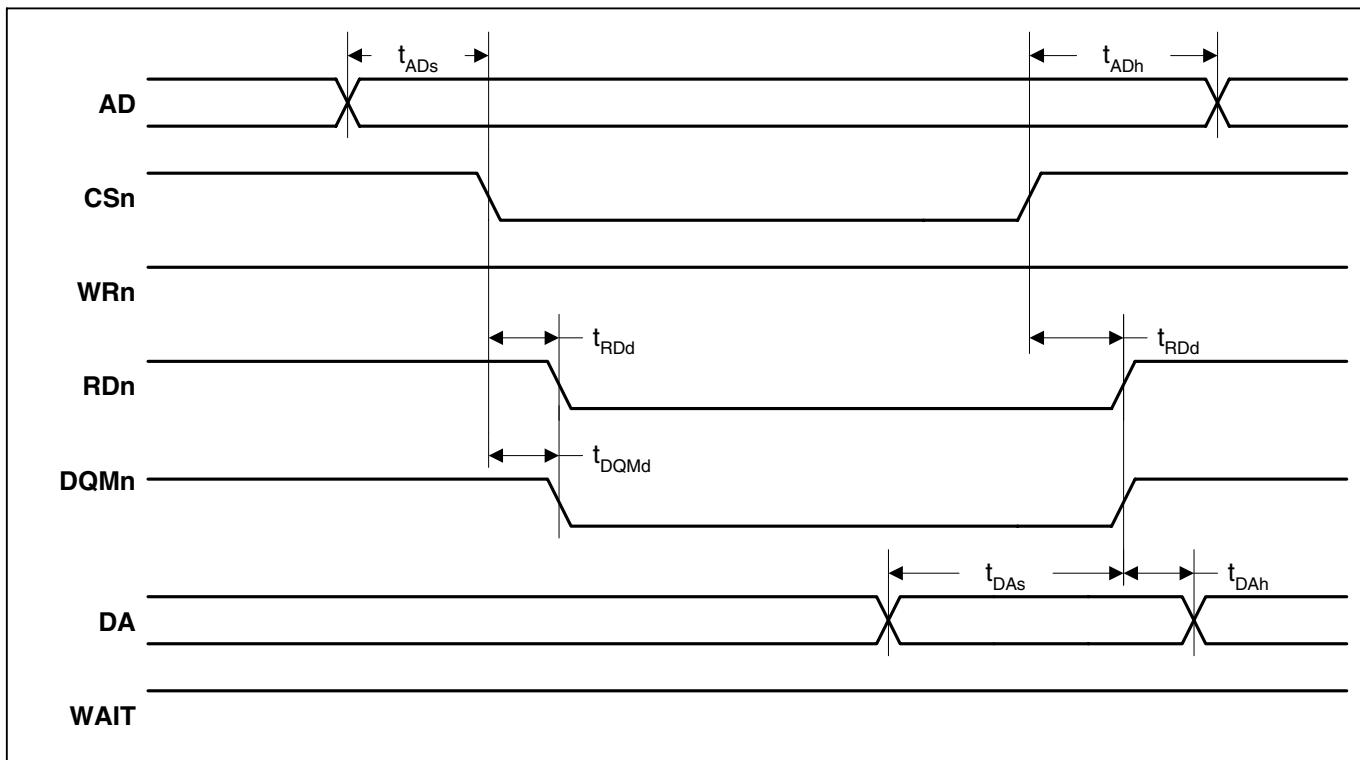


Figure 6. Static Memory Single Word Read Cycle Timing Measurement

### Static Memory Single Word Write Cycle

| Parameter                          | Symbol     | Min                 | Typ                          | Max | Unit |
|------------------------------------|------------|---------------------|------------------------------|-----|------|
| AD setup to WRn assert time        | $t_{ADs}$  | $t_{HCLK} - 3$      | -                            | -   | ns   |
| AD hold from WRn deassert time     | $t_{ADh}$  | $t_{HCLK} \times 2$ | -                            | -   | ns   |
| WRn deassert to CSn deassert time  | $t_{CSh}$  | 7                   | -                            | -   | ns   |
| CSn to WRn assert delay time       | $t_{WRd}$  | -                   | -                            | 2   | ns   |
| WRn assert time                    | $t_{WRpw}$ | -                   | $t_{HCLK} \times (WST1 + 1)$ | -   | ns   |
| CSn to DQMn assert delay time      | $t_{DQMd}$ | -                   | -                            | 1   | ns   |
| WRn deassert to DA transition time | $t_{DAh}$  | $t_{HCLK}$          | -                            | -   | ns   |
| WRn assert to DA valid             | $t_{DAV}$  | -                   | -                            | 8   | ns   |

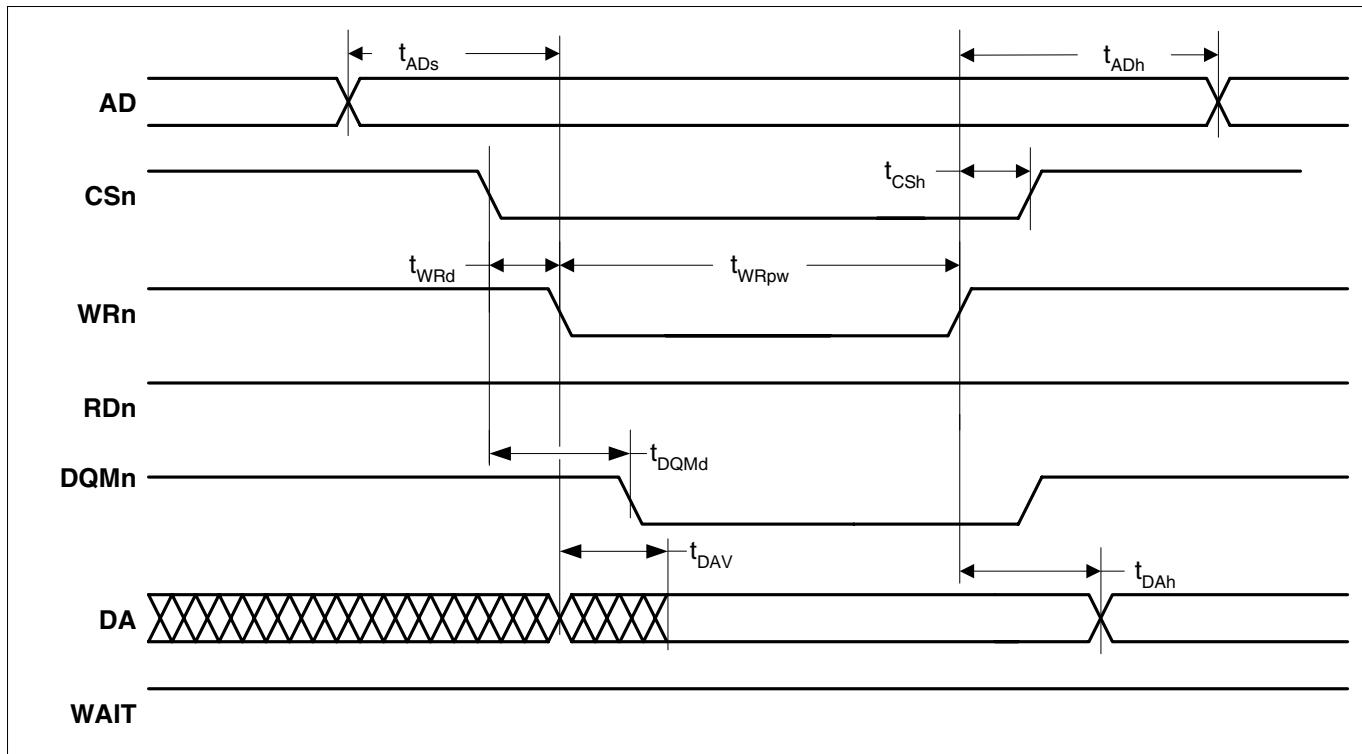
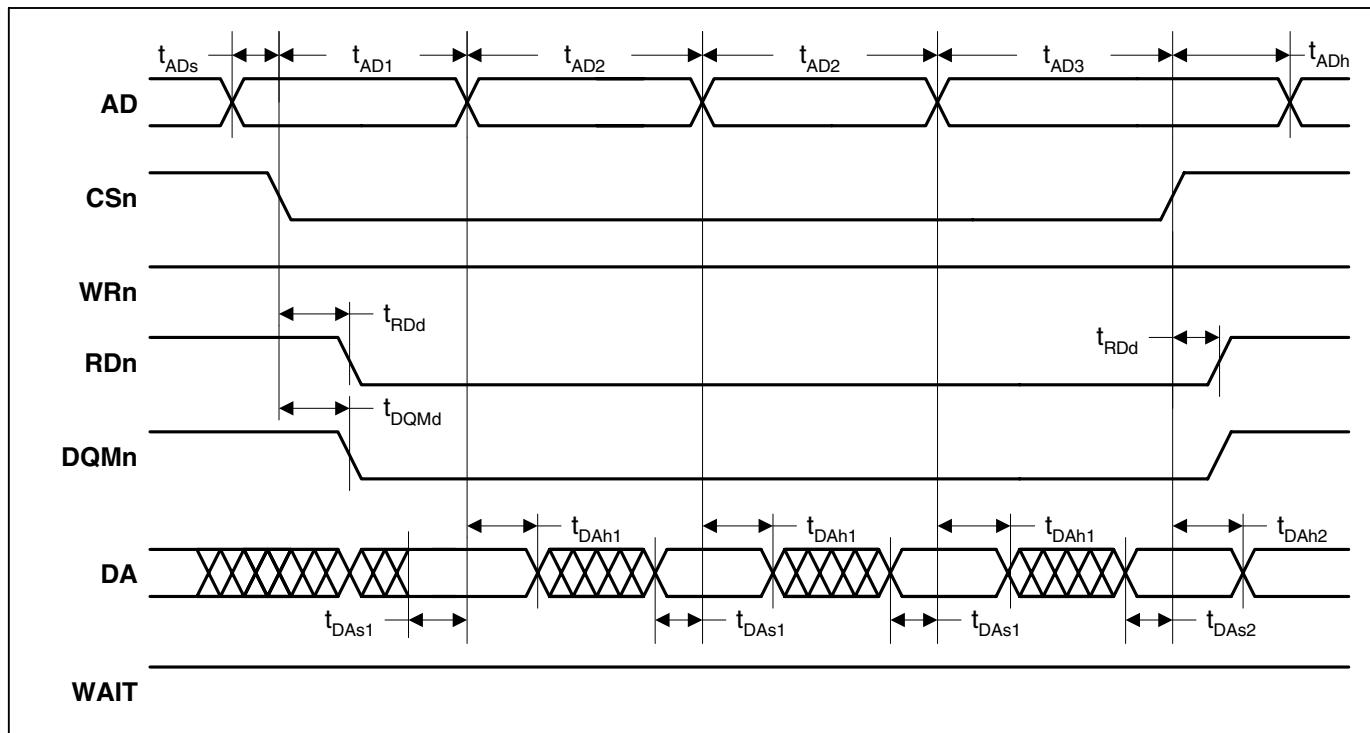


Figure 7. Static Memory Single Word Write Cycle Timing Measurement

**Static Memory 32-bit Read on 8-bit External Bus**

| Parameter                             | Symbol      | Min             | Typ                                   | Max | Unit |
|---------------------------------------|-------------|-----------------|---------------------------------------|-----|------|
| AD setup to CSn assert time           | $t_{ADs}$   | $t_{HCLK}$      | -                                     | -   | ns   |
| CSn assert to Address transition time | $t_{AD1}$   | -               | $t_{HCLK} \times (WST1 + 1)$          | -   | ns   |
| Address assert time                   | $t_{AD2}$   | -               | $t_{HCLK} \times (WST1 + 1)$          | -   | ns   |
| AD transition to CSn deassert time    | $t_{AD3}$   | -               | $t_{HCLK} \times (WST1 + 2)$          | -   | ns   |
| AD hold from CSn deassert time        | $t_{ADh}$   | $t_{HCLK}$      | -                                     | -   | ns   |
| RDn assert time                       | $t_{RDpwl}$ | -               | $t_{HCLK} \times (4 \times WST1 + 5)$ | -   | ns   |
| CSn to RDn delay time                 | $t_{RDd}$   | -               | -                                     | 3   | ns   |
| CSn assert to DQMn assert delay time  | $t_{DQMd}$  | -               | -                                     | 1   | ns   |
| DA setup to AD transition time        | $t_{DAs1}$  | 15              | -                                     | -   | ns   |
| DA setup to RDn deassert time         | $t_{DAs2}$  | $t_{HCLK} + 12$ | -                                     | -   | ns   |
| DA hold from AD transition time       | $t_{DAh1}$  | 0               | -                                     | -   | ns   |
| DA hold from RDn deassert time        | $t_{DAh2}$  | 0               | -                                     | -   | ns   |


**Figure 8. Static Memory Multiple Word Read 8-bit Cycle Timing Measurement**

### Static Memory 32-bit Write on 8-bit External Bus

| Parameter                                 | Symbol       | Min                 | Typ                          | Max                        | Unit |
|---|--------------|---------------------|------------------------------|----------------------------|------|
| AD setup to WRn assert time               | $t_{ADs}$    | $t_{HCLK} - 3$      | -                            | -                          | ns   |
| WRn/DQMn deassert to AD transition time   | $t_{ADD}$    | -                   | -                            | $t_{HCLK} + 6$             | ns   |
| AD hold from WRn deassert time            | $t_{ADh}$    | $t_{HCLK} \times 2$ | -                            | -                          | ns   |
| CSn hold from WRn deassert time           | $t_{CSH}$    | 7                   | -                            | -                          | ns   |
| CSn to WRn assert delay time              | $t_{WRd}$    | -                   | -                            | 2                          | ns   |
| WRn assert time                           | $t_{WRpwL}$  | -                   | $t_{HCLK} \times (WST1 + 1)$ | -                          | ns   |
| WRn deassert time                         | $t_{WRpwH}$  | -                   | $t_{HCLK} \times 2$          | $(t_{HCLK} \times 2) + 14$ | ns   |
| CSn to DQMn assert delay time             | $t_{DQMd}$   | -                   | -                            | 1                          | ns   |
| DQMn assert time                          | $t_{DQMpwl}$ | -                   | $t_{HCLK} \times (WST1 + 1)$ | -                          | ns   |
| DQMn deassert time                        | $t_{DQMpwh}$ | -                   | -                            | $(t_{HCLK} \times 2) + 7$  | ns   |
| WRn / DQMn deassert to DA transition time | $t_{DAh}$    | $t_{HCLK}$          | -                            | -                          | ns   |
| WRn / DQMn assert to DA valid time        | $t_{DAV}$    | -                   | -                            | 8                          | ns   |

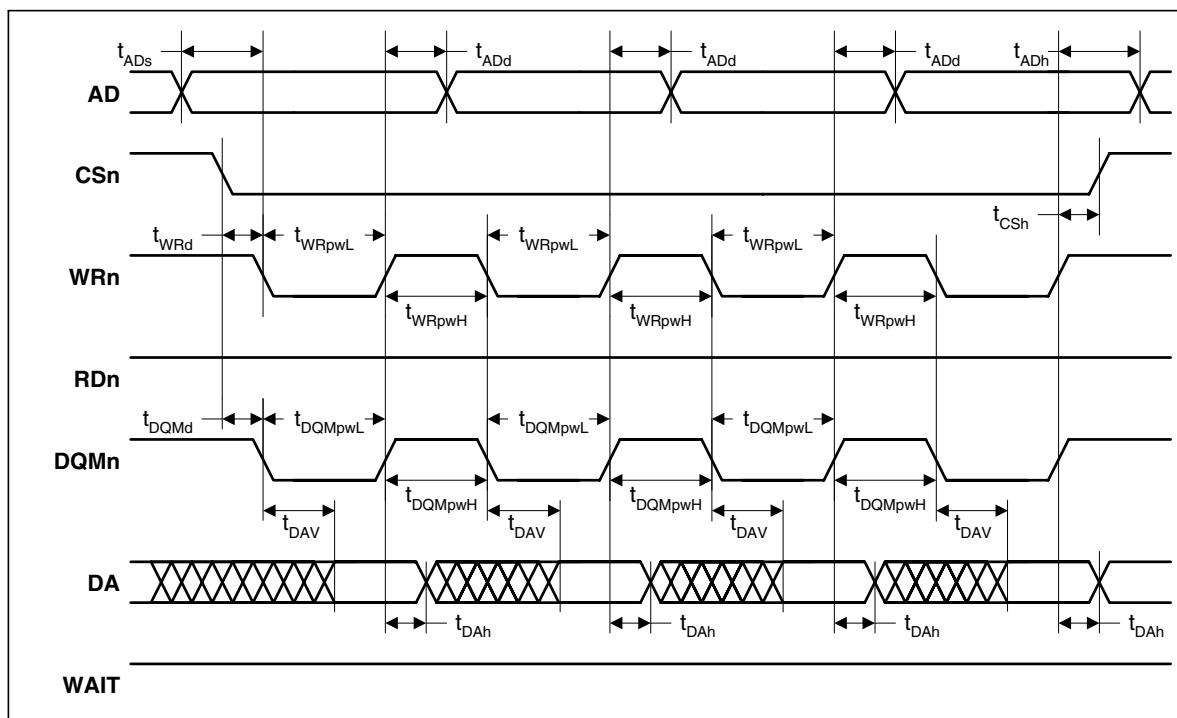
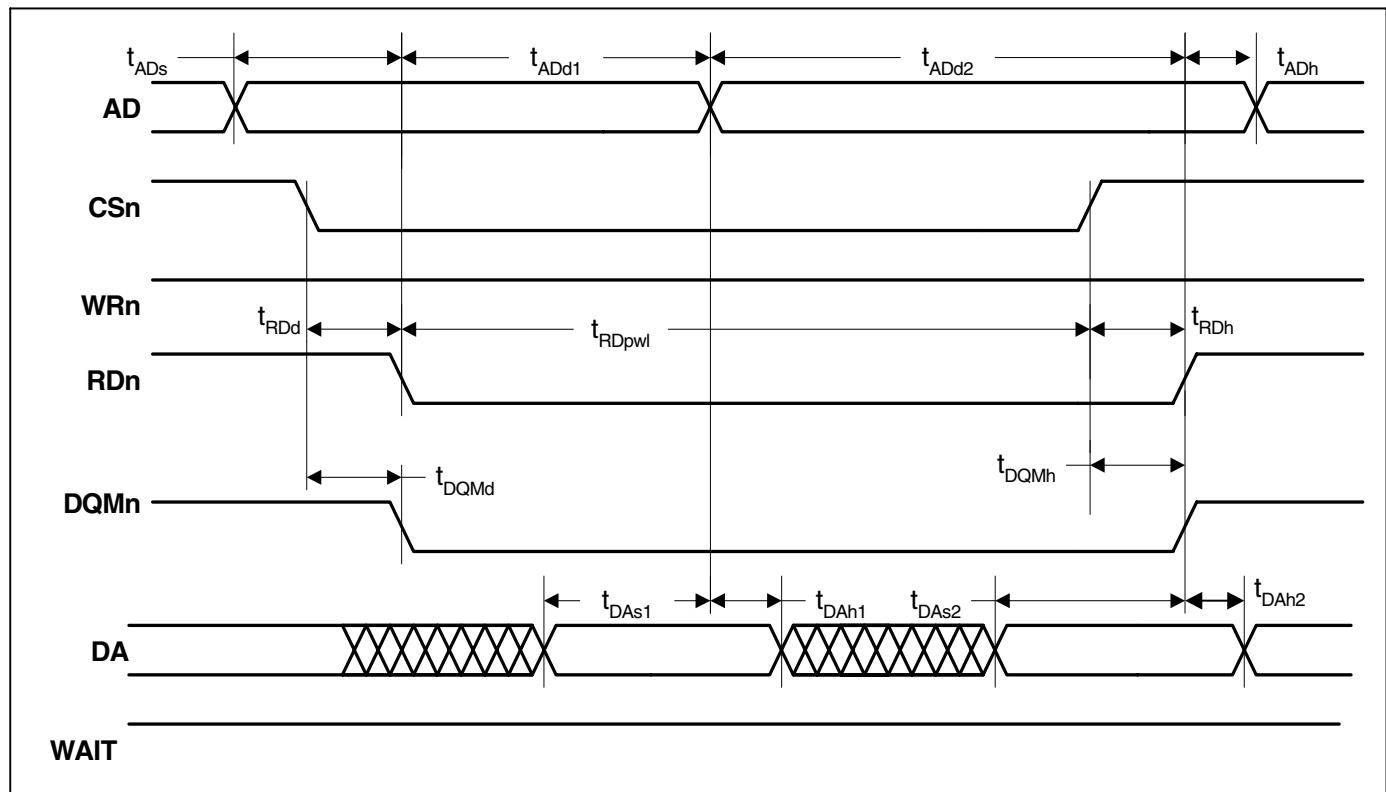


Figure 9. Static Memory Multiple Word Write 8-bit Cycle Timing Measurement

**Static Memory 32-bit Read on 16-bit External Bus**

| Parameter                            | Symbol      | Min             | Typ                                     | Max | Unit |
|--------------------------------------|-------------|-----------------|---|-----|------|
| AD setup to CSn assert time          | $t_{ADs}$   | $t_{HCLK}$      | -                                       | -   | ns   |
| CSn assert to AD transition time     | $t_{ADD1}$  | -               | $t_{HCLK} \times (WST1 + 1)$            | -   | ns   |
| AD transition to CSn deassert time   | $t_{ADD2}$  | -               | $t_{HCLK} \times (WST1 + 2)$            | -   | ns   |
| AD hold from CSn deassert time       | $t_{ADh}$   | $t_{HCLK}$      | -                                       | -   | ns   |
| RDn assert time                      | $t_{RDpwL}$ | -               | $t_{HCLK} \times ((2 \times WST1) + 3)$ | -   | ns   |
| CSn to RDn delay time                | $t_{RDd}$   | -               | -                                       | 3   | ns   |
| CSn assert to DQMn assert delay time | $t_{DQMd}$  | -               | -                                       | 1   | ns   |
| DA setup to AD transition time       | $t_{DAs1}$  | 15              | -                                       | -   | ns   |
| DA to RDn deassert time              | $t_{DAs2}$  | $t_{HCLK} + 12$ | -                                       | -   | ns   |
| DA hold from AD transition time      | $t_{DAh1}$  | 0               | -                                       | -   | ns   |
| DA hold from RDn deassert time       | $t_{DAh2}$  | 0               | -                                       | -   | ns   |


**Figure 10. Static Memory Multiple Word Read 16-bit Cycle Timing Measurement**

### Static Memory 32-bit Write on 16-bit External Bus

| Parameter                                 | Symbol       | Min                 | Typ                          | Max                        | Unit |
|---|--------------|---------------------|------------------------------|----------------------------|------|
| AD setup to WRn assert time               | $t_{ADs}$    | $t_{HCLK} - 3$      | -                            | -                          | ns   |
| WRn/DQMn deassert to AD transition time   | $t_{ADd}$    | -                   | -                            | $t_{HCLK} + 6$             | ns   |
| AD hold from WRn deassert time            | $t_{ADh}$    | $t_{HCLK} \times 2$ | -                            | -                          | ns   |
| CSn hold from WRn deassert time           | $t_{CSh}$    | 7                   | -                            | -                          | ns   |
| CSn to WRn assert delay time              | $t_{WRd}$    | -                   | -                            | 2                          | ns   |
| WRn assert time                           | $t_{WRpwL}$  | -                   | $t_{HCLK} \times (WST1 + 1)$ | -                          | ns   |
| WRn deassert time                         | $t_{WRpwH}$  | -                   | -                            | $(t_{HCLK} \times 2) + 14$ | ns   |
| CSn to DQMn assert delay time             | $t_{DQMd}$   | -                   | -                            | 1                          | ns   |
| DQMn assert time                          | $t_{DQMpwl}$ | -                   | $t_{HCLK} \times (WST1 + 1)$ | -                          | ns   |
| DQMn deassert time                        | $t_{DQMpwh}$ | -                   | -                            | $(t_{HCLK} \times 2) + 7$  | ns   |
| WRn / DQMn deassert to DA transition time | $t_{DAh1}$   | $t_{HCLK}$          | -                            | -                          | ns   |
| WRn / DQMn assert to DA valid time        | $t_{DAV}$    | -                   | -                            | 8                          | ns   |

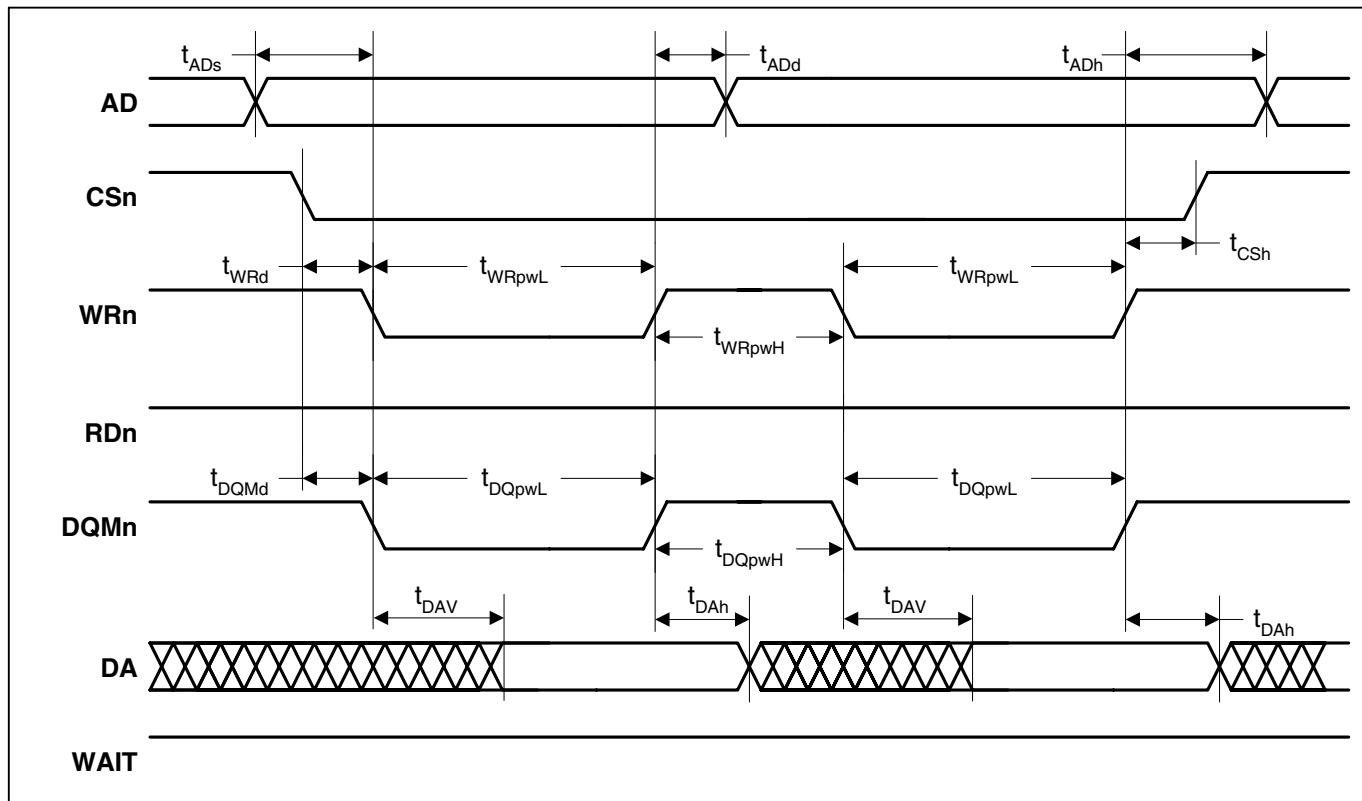


Figure 11. Static Memory Multiple Word Write 16-bit Cycle Timing Measurement

### Static Memory Burst Read Cycle

| Parameter                               | Symbol     | Min             | Typ                          | Max | Unit |
|---|------------|-----------------|------------------------------|-----|------|
| CSn assert to Address 1 transition time | $t_{ADD1}$ | -               | $t_{HCLK} \times (WST1 + 1)$ | -   | ns   |
| Address assert time                     | $t_{ADD2}$ | -               | $t_{HCLK} \times (WST2 + 1)$ | -   | ns   |
| AD transition to CSn deassert time      | $t_{ADD3}$ | -               | $t_{HCLK} \times (WST1 + 2)$ | -   | ns   |
| AD hold from CSn deassert time          | $t_{ADh}$  | $t_{HCLK}$      | -                            | -   | ns   |
| CSn to RDn delay time                   | $t_{RDd}$  | -               | -                            | 3   | ns   |
| CSn to DQMn assert delay time           | $t_{DQMd}$ | -               | -                            | 1   | ns   |
| DA setup to AD transition time          | $t_{DAs1}$ | 15              | -                            | -   | ns   |
| DA setup to CSn deassert time           | $t_{DAs2}$ | $t_{HCLK} + 12$ | -                            | -   | ns   |
| DA hold from AD transition time         | $t_{DAh1}$ | 0               | -                            | -   | ns   |
| DA hold from RDn deassert time          | $t_{DAh2}$ | 0               | -                            | -   | ns   |

Note: These characteristics are valid when the Page Mode Enable (Burst Mode) bit is set. See the User's Guide for details.

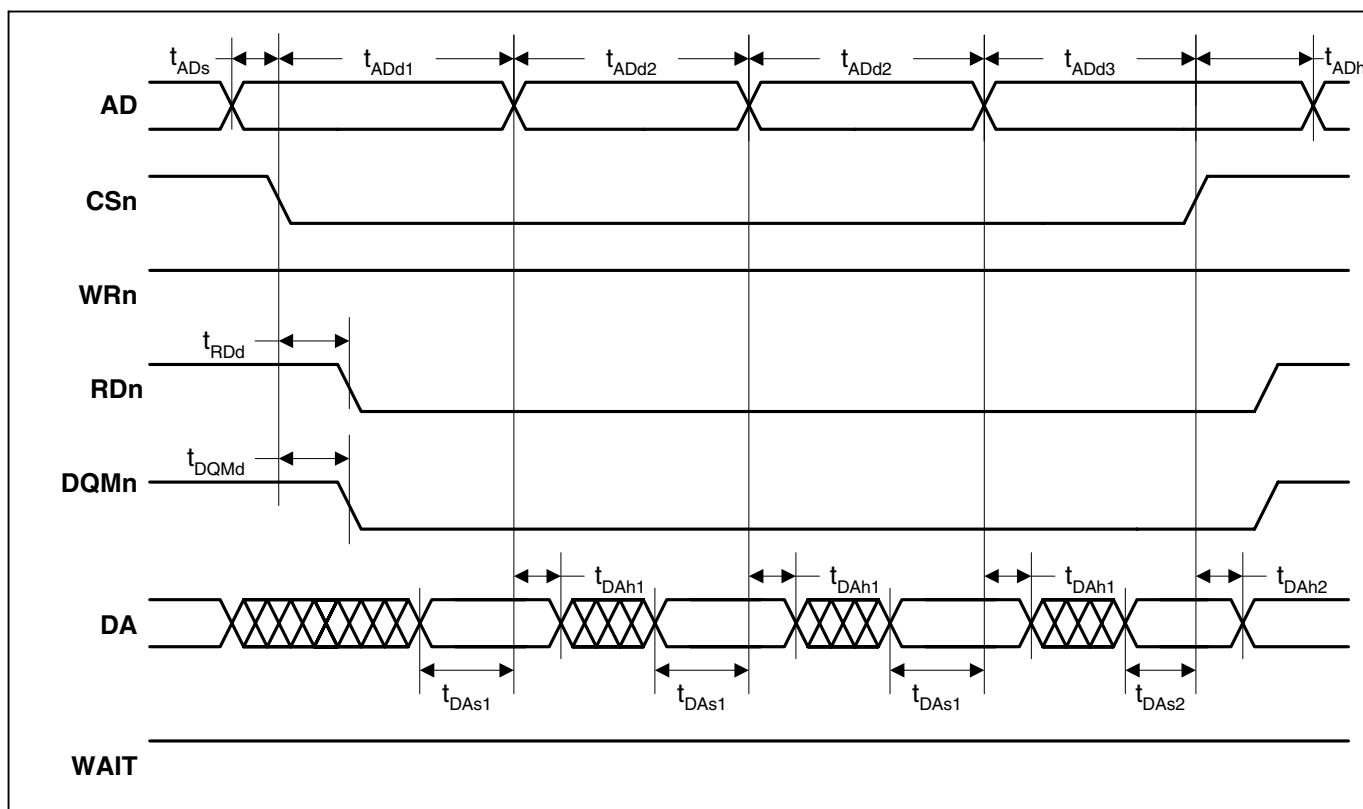


Figure 12. Static Memory Burst Read Cycle Timing Measurement

### Static Memory Burst Write Cycle

| Parameter                               | Symbol      | Min                 | Typ                           | Max                        | Unit |
|---|-------------|---------------------|-------------------------------|----------------------------|------|
| AD setup to WRn assert time             | $t_{ADs}$   | $t_{HCLK} - 3$      |                               |                            | ns   |
| AD hold from WRn deassert time          | $t_{ADh}$   | $t_{HCLK} \times 2$ |                               |                            | ns   |
| WRn/DQMn deassert to AD transition time | $t_{ADD}$   |                     |                               | $t_{HCLK} + 6$             | ns   |
| CSn hold from WRn deassert time         | $t_{CSH}$   | 7                   |                               |                            | ns   |
| CSn to WRn assert delay time            | $t_{WRd}$   |                     |                               | 2                          | ns   |
| CSn to DQMn assert delay time           | $t_{DQMD}$  |                     |                               | 1                          | ns   |
| DQMn assert time                        | $t_{DQpwL}$ |                     | $t_{HCLK} \times (WST1 + 1)$  |                            | ns   |
| DQMn deassert time                      | $t_{DQpwH}$ |                     |                               | $(t_{HCLK} \times 2) + 14$ | ns   |
| WRn assert time                         | $t_{WRpwL}$ |                     | $t_{HCLK} \times (WST1 + 11)$ |                            | ns   |
| WRn deassert time                       | $t_{WRpwH}$ |                     |                               | $(t_{HCLK} \times 2) + 7$  | ns   |
| WRn/DQMn deassert to DA transition time | $t_{DAh}$   | $t_{HCLK}$          |                               |                            | ns   |
| WRn/DQMn assert to DA valid time        | $t_{DAv}$   |                     |                               | 8                          | ns   |

Note: These characteristics are valid when the Page Mode Enable (Burst Mode) bit is set. See the User's Guide for details.

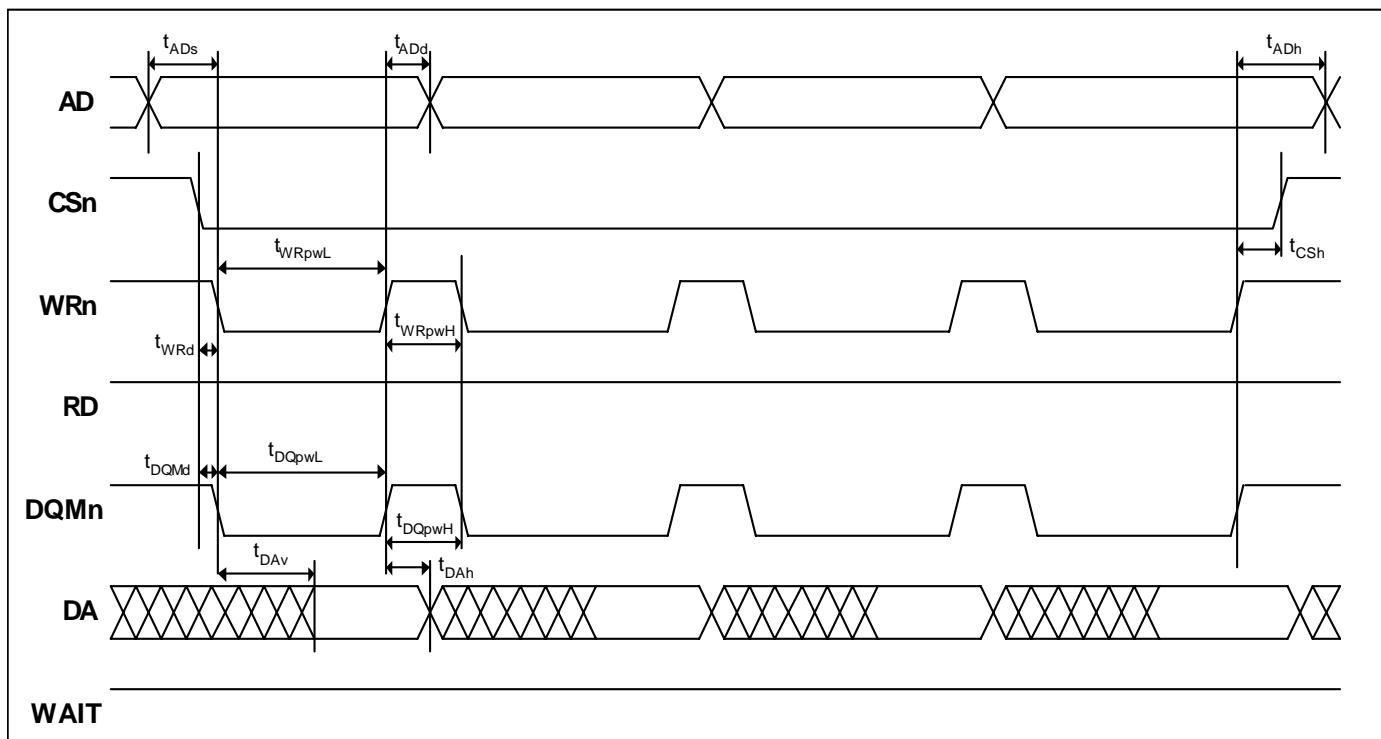


Figure 13. Static Memory Burst Write Cycle Timing Measurement

### Static Memory Single Read Wait Cycle

| Parameter                       | Symbol       | Min                 | Typ | Max                        | Unit |
|---------------------------------|--------------|---------------------|-----|----------------------------|------|
| CSn assert to WAIT time         | $t_{WAITd}$  | -                   | -   | $t_{HCLK} \times (WST1-2)$ | ns   |
| WAIT assert time                | $t_{WAITpw}$ | $t_{HCLK} \times 2$ | -   | $t_{HCLK} \times 510$      | ns   |
| WAIT to CSn deassert delay time | $t_{CSnd}$   | $t_{HCLK} \times 3$ | -   | $t_{HCLK} \times 5$        | ns   |

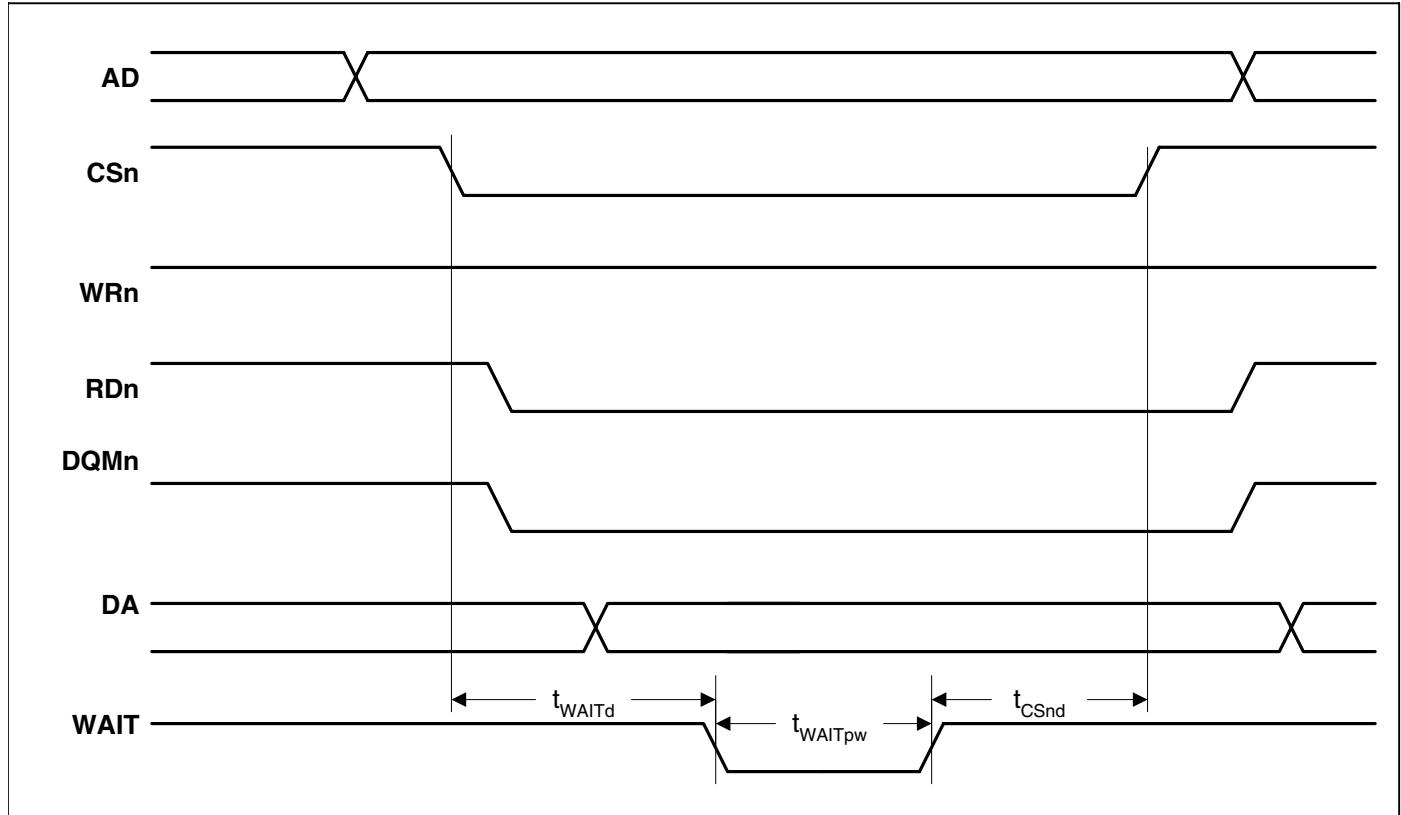


Figure 14. Static Memory Single Read Wait Cycle Timing Measurement

### Static Memory Single Write Wait Cycle

| Parameter                       | Symbol       | Min                 | Typ | Max                        | Unit |
|---------------------------------|--------------|---------------------|-----|----------------------------|------|
| WAIT to WRn deassert delay time | $t_{WRd}$    | $t_{HCLK} \times 2$ | -   | $t_{HCLK} \times 4$        | ns   |
| CSn assert to WAIT time         | $t_{WAITd}$  | -                   | -   | $t_{HCLK} \times (WST1-2)$ | ns   |
| WAIT assert time                | $t_{WAITpw}$ | $t_{HCLK} \times 2$ | -   | $t_{HCLK} \times 510$      | ns   |
| WAIT to CSn deassert delay time | $t_{CSnd}$   | $t_{HCLK} \times 3$ | -   | $t_{HCLK} \times 5$        | ns   |

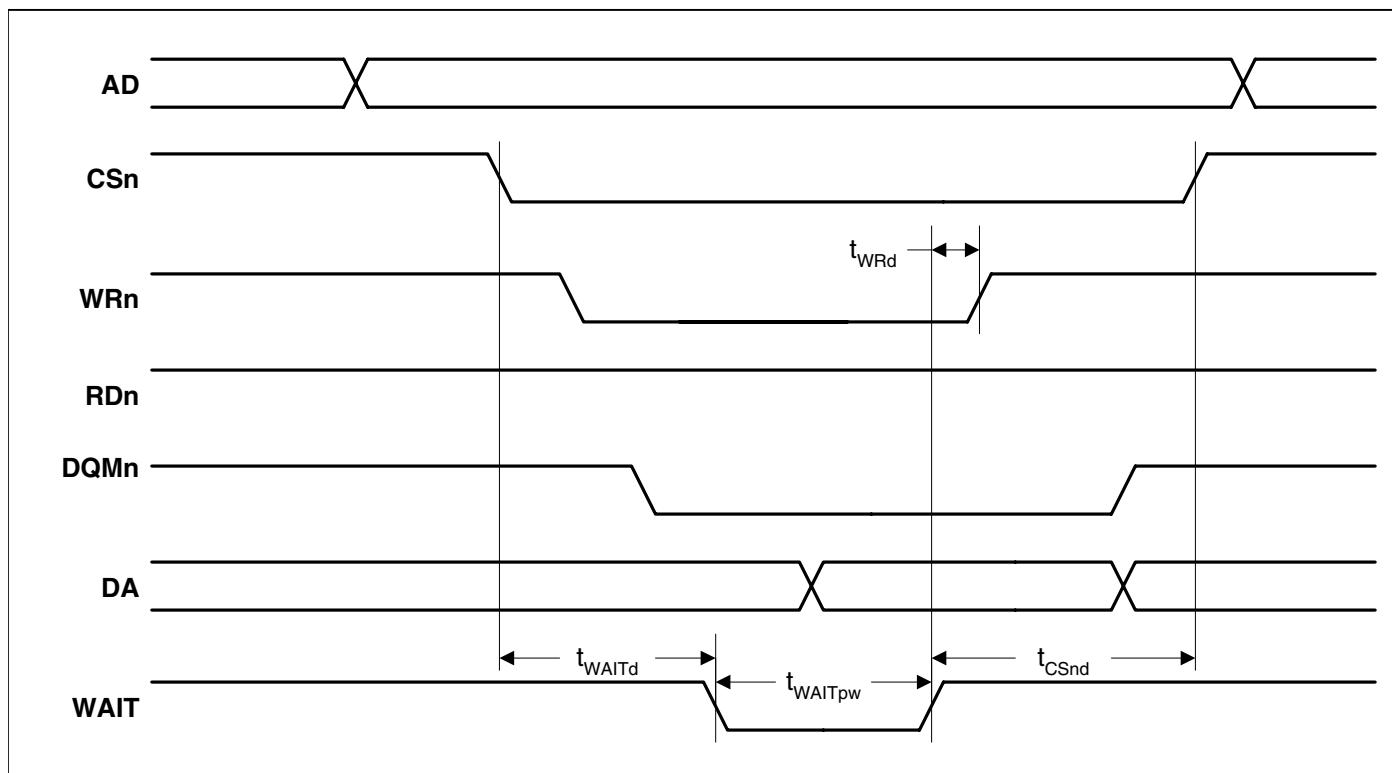


Figure 15. Static Memory Single Write Wait Cycle Timing Measurement

### Static Memory Turnaround Cycle

| Parameter                         | Symbol      | Min | Typ                        | Max | Unit |
|-----------------------------------|-------------|-----|----------------------------|-----|------|
| CSnX deassert to CSnY assert time | $t_{BTcyc}$ | -   | $t_{HCLK} \times (IDCY+1)$ | -   | ns   |

Notes:

1. X and Y represent any two chip select numbers.
2. IDCY occurs on read-to-write and write-to-read.
3. IDCY is honored when going from a asynchronous device (CSx) to a synchronous device (/SDCSy).

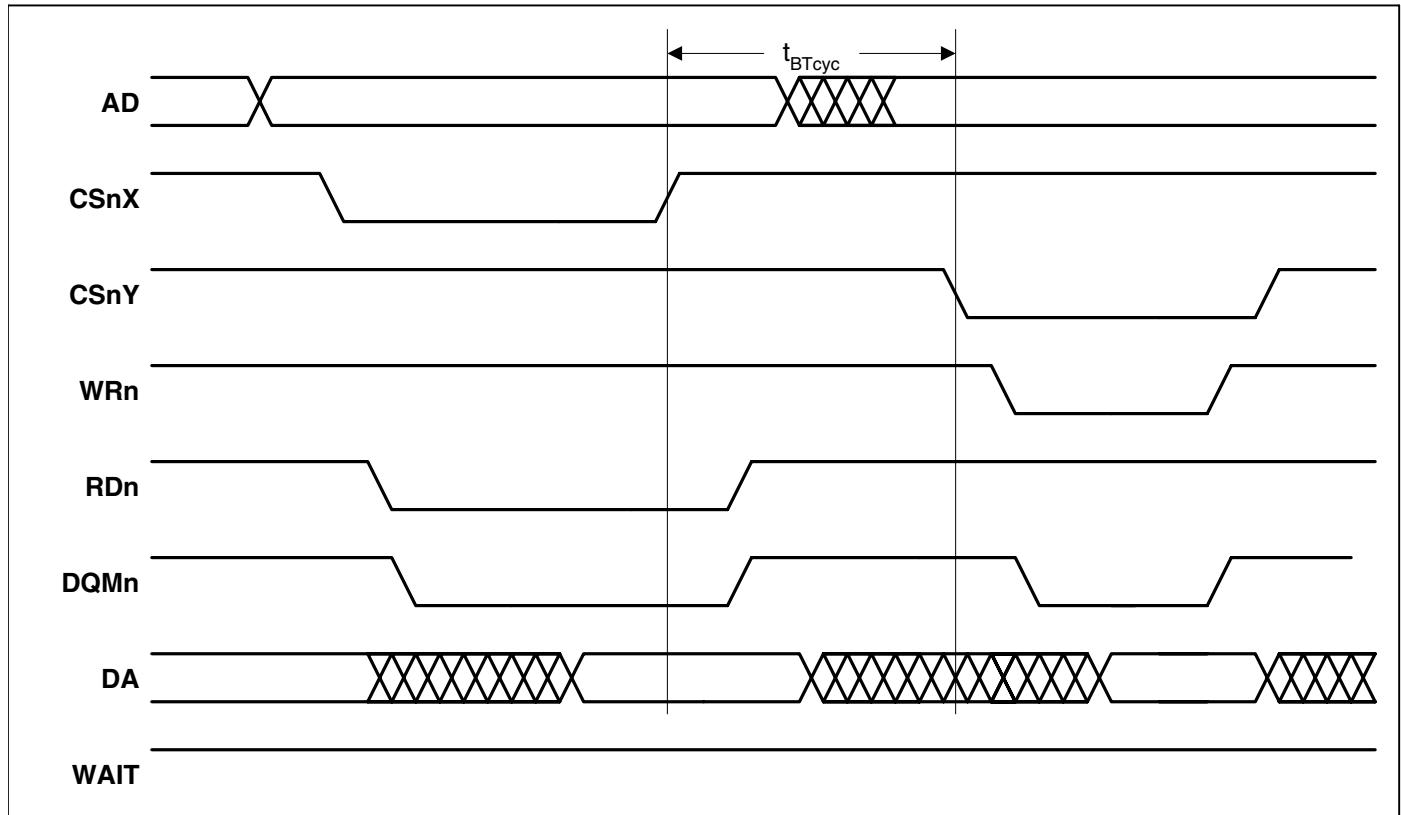


Figure 16. Static Memory Turnaround Cycle Timing Measurement

## PCMCIA Interface

### PCMCIA Read Cycle

| Parameter                              | Symbol     | Min                               | Typ                        | Max | Unit |
|--|------------|-----------------------------------|----------------------------|-----|------|
| AD setup to signal transition time     | $t_{ADS}$  | 0                                 | -                          | -   | ns   |
| Attribute access time                  | $t_A$      | $[(AA + 1) \times t_{HCLK}] - 14$ | $(AA + 1) \times t_{HCLK}$ | -   | ns   |
| Attribute hold time                    | $t_H$      | $[(HA + 1) \times t_{HCLK}] - 3$  | $(HA + 1) \times t_{HCLK}$ | -   | ns   |
| Attribute space pre-charge delay time  | $t_p$      | $(PA + 1) \times t_{HCLK}$        | $(PA + 1) \times t_{HCLK}$ | -   | ns   |
| Common access time                     | $t_A$      | $[(AC + 1) \times t_{HCLK}] - 14$ | $(AC + 1) \times t_{HCLK}$ | -   | ns   |
| Common hold time                       | $t_H$      | $[(HC + 1) \times t_{HCLK}] - 3$  | $(HC + 1) \times t_{HCLK}$ | -   | ns   |
| Common space pre-charge delay time     | $t_p$      | $(PC + 1) \times t_{HCLK}$        | $(PC + 1) \times t_{HCLK}$ | -   | ns   |
| I/O access time                        | $t_A$      | $[(AI + 1) \times t_{HCLK}] - 14$ | $(AI + 1) \times t_{HCLK}$ | -   | ns   |
| I/O hold time                          | $t_H$      | $[(HI + 1) \times t_{HCLK}] - 3$  | $(HI + 1) \times t_{HCLK}$ | -   | ns   |
| I/O space pre-charge delay time        | $t_p$      | $(PI + 1) \times t_{HCLK}$        | $(PI + 1) \times t_{HCLK}$ | -   | ns   |
| MCDIR hold time                        | $t_{MCDh}$ | 0                                 | -                          | -   | ns   |
| DA setup to MCRDn / IORDn rising edge  | $t_s$      | 10                                | -                          | -   | ns   |
| DA hold from MCRDn / IORDn rising edge | $t_h$      | 0                                 | -                          | -   | ns   |

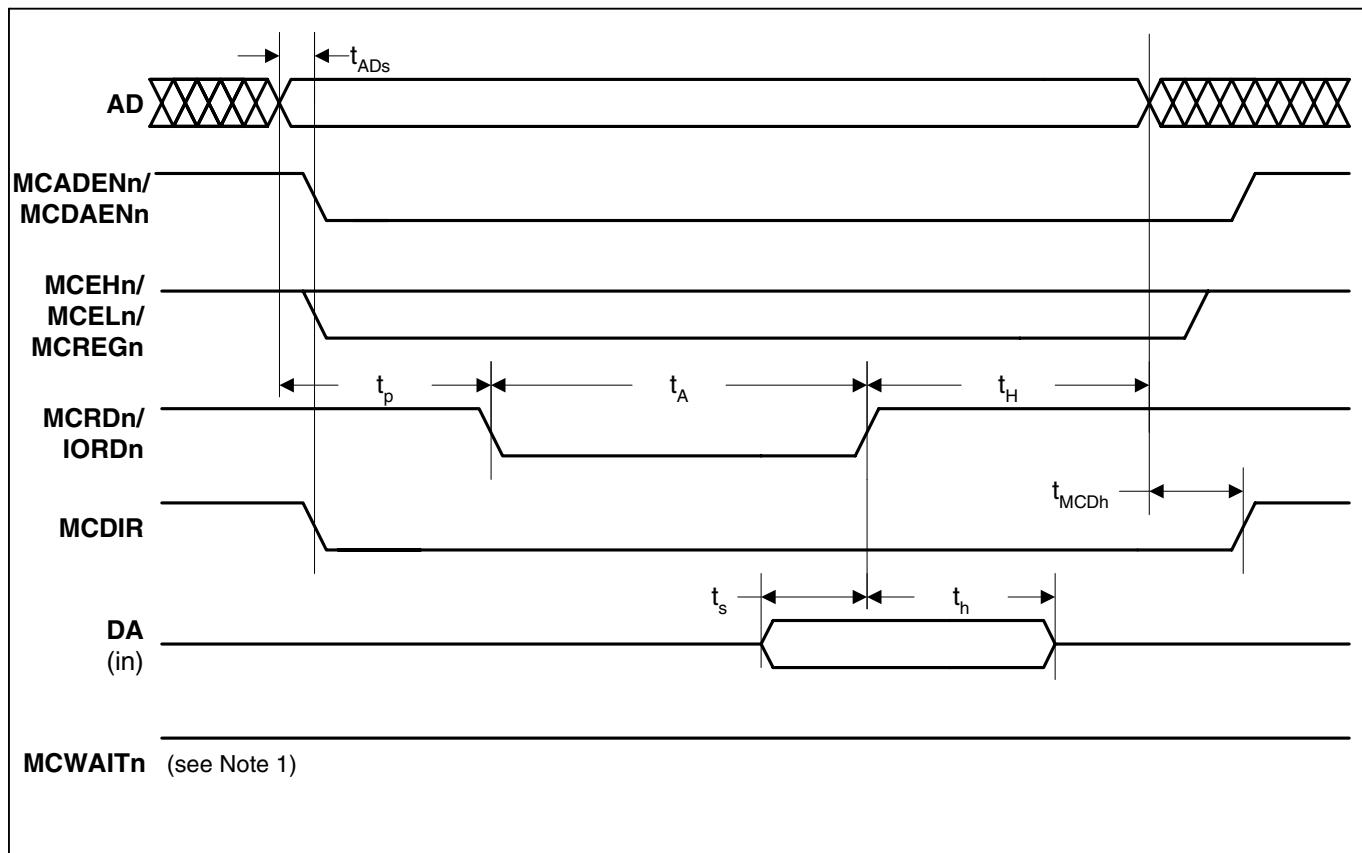


Figure 17. PCMCIA Read Cycle Timing Measurement

Note: 1 - MCWAITn asserted will extend the MCRD / IORD strobe time.

### PCMCIA Write Cycle

| Parameter                             | Symbol     | Min                               | Typ                        | Max | Unit |
|---------------------------------------|------------|-----------------------------------|----------------------------|-----|------|
| AD setup to signal transition time    | $t_{ADs}$  | 0                                 | -                          | -   | ns   |
| Attribute access time                 | $t_A$      | $[(AA + 1) \times t_{HCLK}] - 14$ | $(AA + 1) \times t_{HCLK}$ | -   | ns   |
| Attribute hold time                   | $t_H$      | $[(HA + 1) \times t_{HCLK}] - 3$  | $(HA + 1) \times t_{HCLK}$ | -   | ns   |
| Attribute space pre-charge delay time | $t_p$      | $(PA + 1) \times t_{HCLK}$        | $(PA + 1) \times t_{HCLK}$ | -   | ns   |
| Common access time                    | $t_A$      | $[(AC + 1) \times t_{HCLK}] - 14$ | $(AC + 1) \times t_{HCLK}$ | -   | ns   |
| Common hold time                      | $t_H$      | $[(HC + 1) \times t_{HCLK}] - 3$  | $(HC + 1) \times t_{HCLK}$ | -   | ns   |
| Common space pre-charge delay time    | $t_p$      | $(PC + 1) \times t_{HCLK}$        | $(PC + 1) \times t_{HCLK}$ | -   | ns   |
| I/O access time                       | $t_A$      | $[(AI + 1) \times t_{HCLK}] - 14$ | $(AI + 1) \times t_{HCLK}$ | -   | ns   |
| I/O hold time                         | $t_H$      | $[(HI + 1) \times t_{HCLK}] - 3$  | $(HI + 1) \times t_{HCLK}$ | -   | ns   |
| I/O space pre-charge delay time       | $t_p$      | $(PI + 1) \times t_{HCLK}$        | $(PI + 1) \times t_{HCLK}$ | -   | ns   |
| MCDIR hold time                       | $t_{MCDh}$ | 0                                 | -                          | -   | ns   |
| DATA invalid delay time               | $t_{DAfo}$ | 0                                 | -                          | -   | ns   |

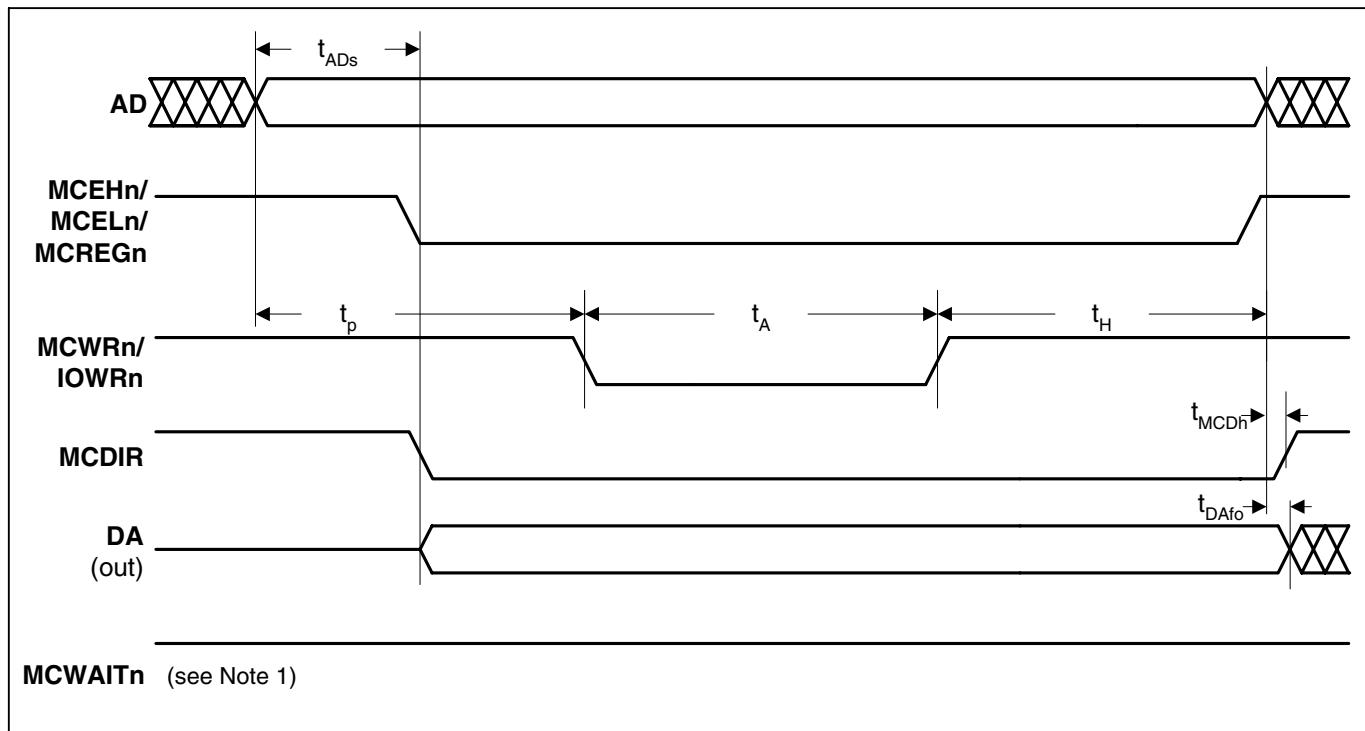


Figure 18. PCMCIA Write Cycle Timing Measurement

Note: 1 - MCWAITn asserted will extend the MCWR / IOWR strobe time.

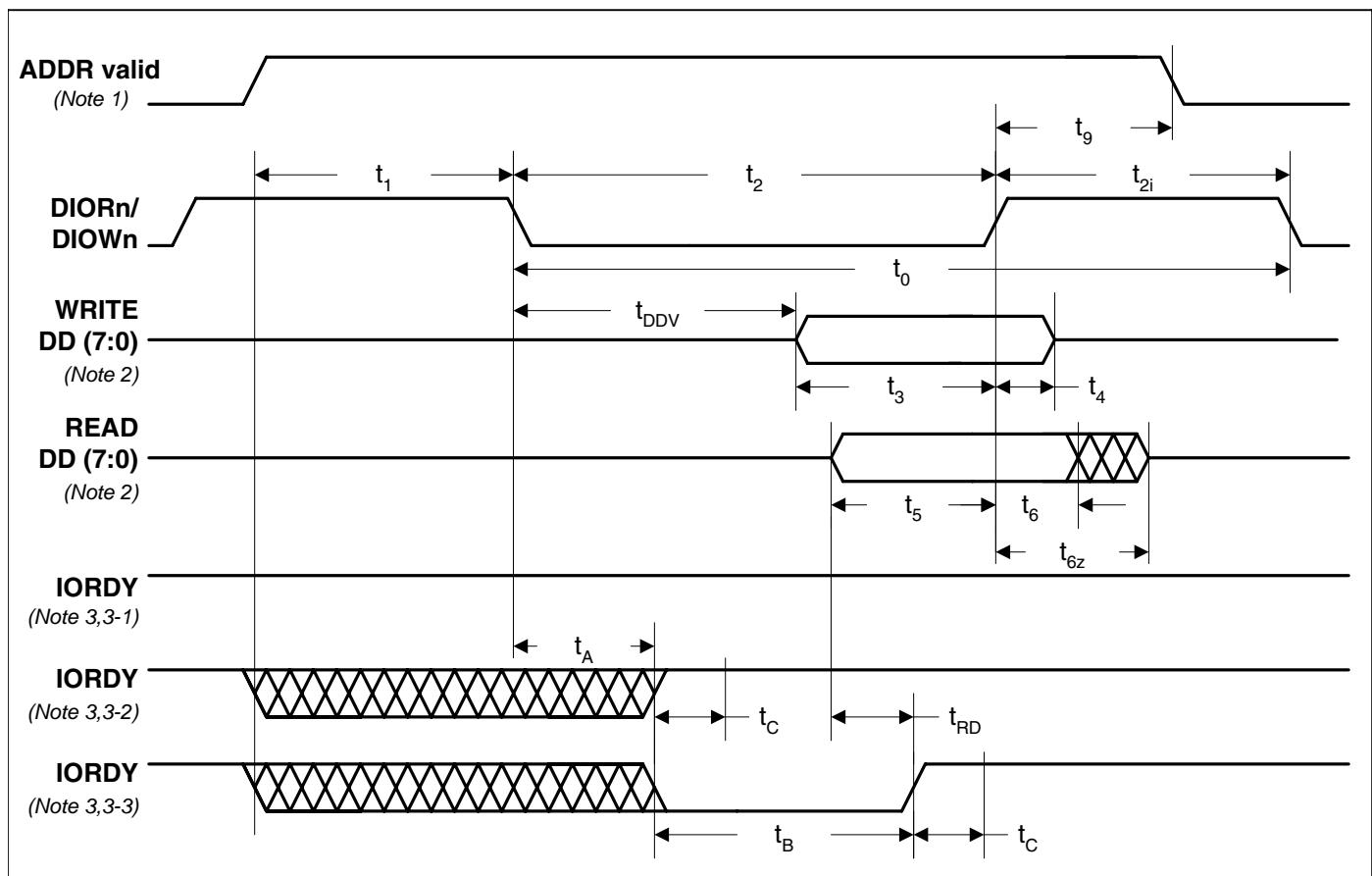
## IDE Interface

### Register Transfers

| Parameter  | Symbol    | Mode 0<br>(in ns) | Mode 1<br>(in ns) | Mode 2<br>(in ns) | Mode 3<br>(in ns) | Mode 4<br>(in ns) |
|--|-----------|-------------------|-------------------|-------------------|-------------------|-------------------|
| Cycle time (min) (Notes 1, 4, 5)   | $t_0$     | 600               | 383               | 330               | 180               | 120               |
| Address valid to DIORn / DIOWn setup (min) (Note 4)                                  | $t_1$     | 70                | 50                | 30                | 30                | 25                |
| DIORn / DIOWn pulse width 8-bit (min) (Note 1, 4)                                    | $t_2$     | 290               | 290               | 290               | 80                | 70                |
| DIORn / DIOWn recovery time (min) (Note 1, 4)  | $t_{2i}$  | -                 | -                 | -                 | 70                | 25                |
| DIOWn data setup (min) (Note 4)  | $t_3$     | 60                | 45                | 30                | 30                | 20                |
| DIOWn data hold (min)  | $t_4$     | 0                 | 0                 | 0                 | 0                 | 0                 |
| DIORn data setup (min)   | $t_5$     | 20                | 20                | 20                | 20                | 20                |
| DIORn data hold (min)  | $t_6$     | 0                 | 0                 | 0                 | 0                 | 0                 |
| DIORn data high impedance state (max) (Note 2, 4)                                    | $t_{6z}$  | 30                | 30                | 30                | 30                | 30                |
| DIORn / DIOWn to address valid hold (min) (Note 4)                                   | $t_9$     | 20                | 15                | 10                | 10                | 10                |
| Read Data Valid to IORDY active (if IORDY initially low after $t_A$ ) (min) (Note 4) | $t_{RD}$  | 0                 | 0                 | 0                 | 0                 | 0                 |
| IORDY Setup time (Note 3, 4)   | $t_A$     | 35                | 35                | 35                | 35                | 35                |
| IORDY Pulse Width (max) (Note 4)   | $t_B$     | 1250              | 1250              | 1250              | 1250              | 1250              |
| IORDY assertion to release (max)   | $t_C$     | 5                 | 5                 | 5                 | 5                 | 5                 |
| DIOWn assert to data valid (max)   | $t_{DDV}$ | 10                | 10                | 10                | 10                | 10                |

Note: 1.  $t_0$  is the minimum total cycle time,  $t_2$  is the minimum DIORn / DIOWn assertion time, and  $t_{2i}$  is the minimum DIORn / DIOWn negation time. A host implementation shall lengthen  $t_2$  and/or  $t_{2i}$  to ensure that  $t_0$  is equal to or greater than the value reported in the devices IDENTIFY DEVICE data. A device implementation shall support any legal host implementation.

2. This parameter specifies the time from the negation edge of DIORn to the time that the data bus is released by the device.
3. The delay from the activation of DIORn or DIOWn until the state of IORDY is first sampled. If IORDY is inactive then the host shall wait until IORDY is active before the register transfer cycle is completed. If the device is not driving IORDY negated at the  $t_A$  after the activation of DIORn or DIOWn, then  $t_5$  shall be met and  $t_{RD}$  is not applicable. If the device is driving IORDY negated at the time  $t_A$  after the activation of DIORn or DIOWn, then  $t_{RD}$  shall be met and  $t_5$  is not applicable.
4. Timings based upon software control. See User's Guide.
5. ATA / ATAPI standards prior to ATA / ATAPI-5 inadvertently specified an incorrect value for mode 2 time  $t_0$  by utilizing the 16-bit PIO value.
6. All IDE timing is based upon HCLK = 100 MHz.



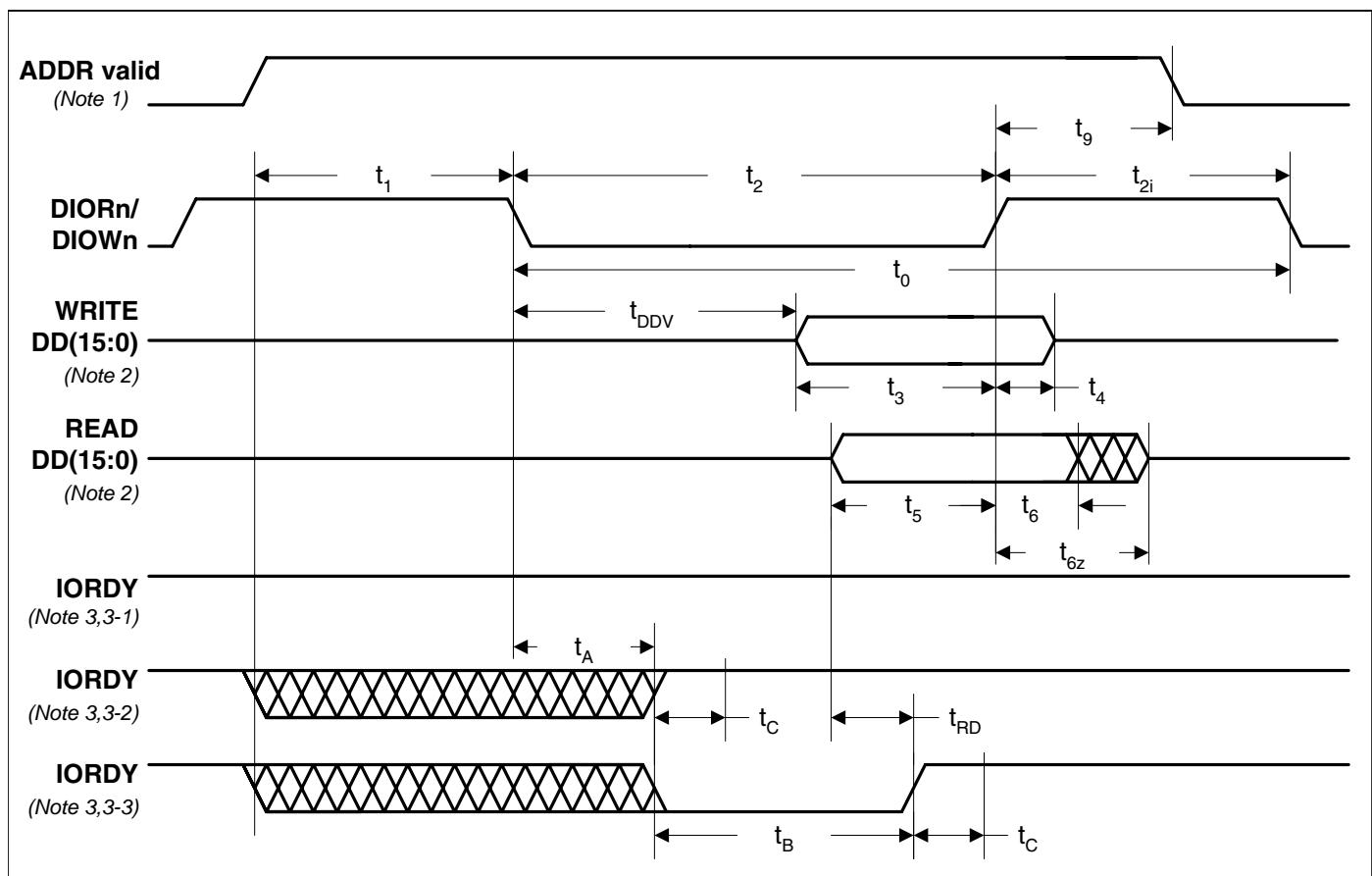
- Note:
1. Device address consists of signals IDECS0n, IDECS1n and IDEDA (2:0)
  2. Data consists of DD (7:0)
  3. The negation of IORDY by the device is used to extend the register transfer cycle. The determination of whether the cycle is to be extended is made by the host after  $t_A$  from the assertion of DIORn or DIOWn. The assertion and negation of IORDY are described in the following three cases:
    - 3-1 Device never negates IORDY, devices keeps IORDY released: no wait is generated.
    - 3-2 Device negates IORDY before  $t_A$ , but causes IORDY to be asserted before  $t_A$ . IORDY is released prior to negation and may be asserted for no more than  $t_C$  before release: no wait generated.
    - 3-3 Device negates IORDY before  $t_A$ . IORDY is released prior to negation and may be asserted for no more than  $t_C$  before release: wait generated. The cycle completes after IORDY is reasserted. For cycles where a wait is generated and DIORn is asserted, the device shall place read data on DD (7:0) for  $t_{RD}$  before asserting IORDY.

**Figure 19. Register Transfer to/from Device**

## PIO Data Transfers

| Parameter  | Symbol    | Mode 0<br>(in ns) | Mode 1<br>(in ns) | Mode 2<br>(in ns) | Mode 3<br>(in ns) | Mode 4<br>(in ns) |
|--|-----------|-------------------|-------------------|-------------------|-------------------|-------------------|
| Cycle time (min) (Note 1, 4)   | $t_0$     | 600               | 383               | 240               | 180               | 120               |
| Address valid to DIORn / DIOWn setup (min) (Note 4)                                  | $t_1$     | 70                | 50                | 30                | 30                | 25                |
| DIORn / DIOWn 16-bit (min) (Note 1, 4)   | $t_2$     | 165               | 125               | 100               | 80                | 70                |
| DIORn / DIOWn recovery time (min) (Note 1, 4)  | $t_{2i}$  | -                 | -                 | -                 | 70                | 25                |
| DIOWn data setup (min) (Note 4)  | $t_3$     | 60                | 45                | 30                | 30                | 20                |
| DIOWn data hold (min)  | $t_4$     | 0                 | 0                 | 0                 | 0                 | 0                 |
| DIORn data setup (min)   | $t_5$     | 20                | 20                | 20                | 20                | 20                |
| DIORn data hold (min)  | $t_6$     | 0                 | 0                 | 0                 | 0                 | 0                 |
| DIORn data high impedance state (max) (Note 2, 4)                                    | $t_{6z}$  | 30                | 30                | 30                | 30                | 30                |
| DIORn / DIOWn to address valid hold (min) (Note 4)                                   | $t_9$     | 20                | 15                | 10                | 10                | 10                |
| Read Data Valid to IORDY active (if IORDY initially low after $t_A$ ) (min) (Note 4) | $t_{RD}$  | 0                 | 0                 | 0                 | 0                 | 0                 |
| IORDY Setup time (Note 3, 4)   | $t_A$     | 35                | 35                | 35                | 35                | 35                |
| IORDY Pulse Width (max) (Note 4)   | $t_B$     | 1250              | 1250              | 1250              | 1250              | 1250              |
| IORDY assertion to release (max)   | $t_C$     | 5                 | 5                 | 5                 | 5                 | 5                 |
| DIOWn assert to data valid (max)   | $t_{DDV}$ | 10                | 10                | 10                | 10                | 10                |

- Note:
1.  $t_0$  is the minimum total cycle time,  $t_2$  is the minimum DIORn / DIOWn assertion time, and  $t_{2i}$  is the minimum DIORn / DIOWn negation time. A host implementation shall lengthen  $t_2$  and/or  $t_{2i}$  to ensure that  $t_0$  is equal to or greater than the value reported in the devices IDENTIFY DEVICE data. A device implementation shall support any legal host implementation.
  2. This parameter specifies the time from the negation edge of DIORn to the time that the data bus is released by the device.
  3. The delay from the activation of DIORn or DIOWn until the state of IORDY is first sampled. If IORDY is inactive then the host shall wait until IORDY is active before the register transfer cycle is completed. If the device is not driving IORDY negated at the  $t_A$  after the activation of DIORn or DIOWn, then  $t_5$  shall be met and  $t_{RD}$  is not applicable. If the device is driving IORDY negated at the time  $t_A$  after the activation of DIORn or DIOWn, then  $t_{RD}$  shall be met and  $t_5$  is not applicable.
  4. Timings based upon software control. See User's Guide.
  5. All IDE timing is based upon HCLK = 100 MHz.



- Note:
1. Device address consists of signals IDECS0n, IDECS1n and IDEDA (2:0)
  2. Data consists of DD (15:0)
  3. The negation of IORDY by the device is used to extend the register transfer cycle. The determination of whether the cycle is to be extended is made by the host after  $t_A$  from the assertion of DIORn or DIOWn. The assertion and negation of IORDY are described in the following three cases:
    - 3-1 Device never negates IORDY, devices keeps IORDY released: no wait is generated.
    - 3-2 Device negates IORDY before  $t_A$ , but causes IORDY to be asserted before  $t_A$ . IORDY is released prior to negation and may be asserted for no more than  $t_C$  before release: no wait generated.
    - 3-3 Device negates IORDY before  $t_A$ . IORDY is released prior to negation and may be asserted for no more than  $t_C$  before release: wait generated. The cycle completes after IORDY is reasserted. For cycles where a wait is generated and DIORn is asserted, the device shall place read data on DD (15:0) for  $t_{RD}$  before asserting IORDY.

Figure 20. PIO Data Transfer to/from Device

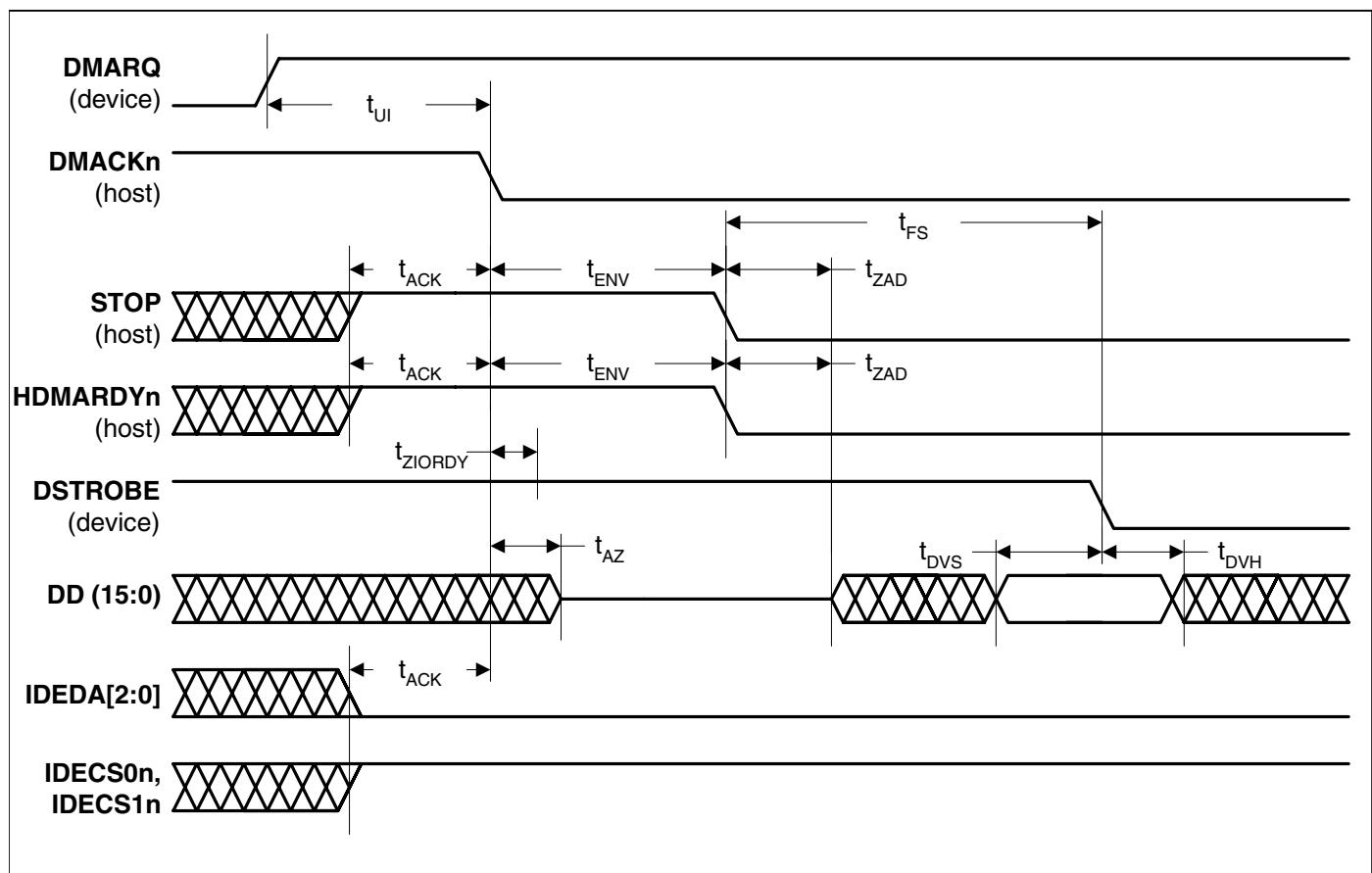
## Ultra DMA Data Transfer

**Figure 21** through **Figure 30** define the timings associated with all phases of Ultra DMA bursts. The following table contains the values for the timings for each of the Ultra DMA modes.

Timing reference levels = 1.5 V

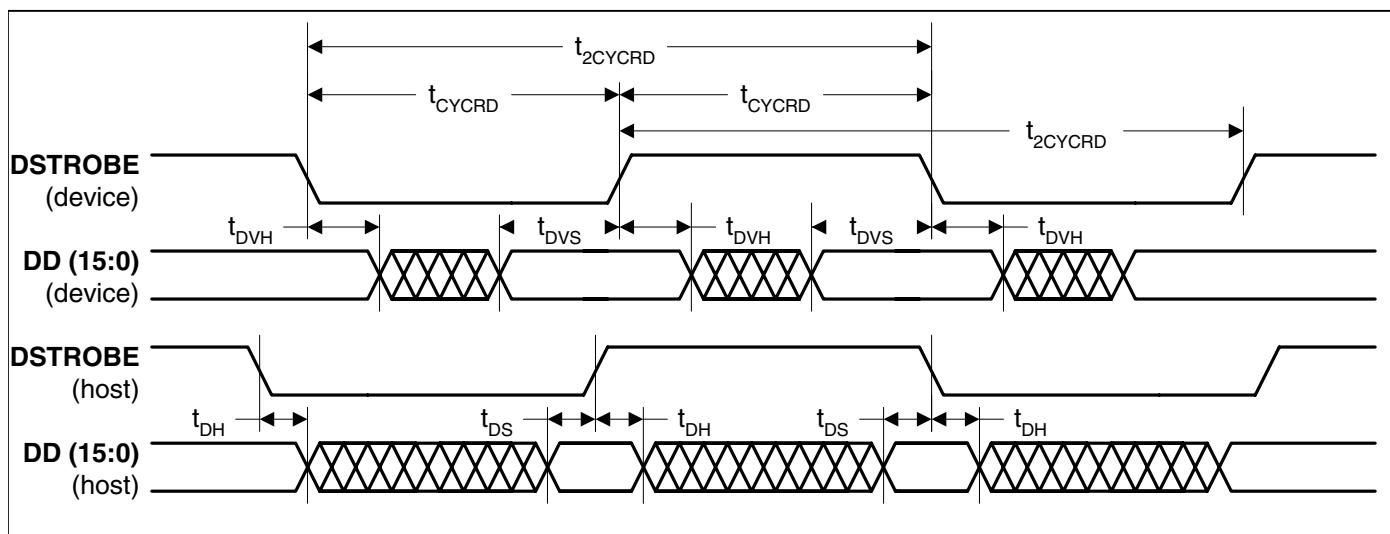
| Parameter   | Symbol       | Mode 0<br>(in ns) |     | Mode 1<br>(in ns) |     | Mode 2<br>(in ns) |     | Mode 3<br>(in ns) |     |
|---|--------------|-------------------|-----|-------------------|-----|-------------------|-----|-------------------|-----|
|   |              | min               | max | min               | max | min               | max | min               | max |
| Cycle time allowing for asymmetry and clock variations (from DSTROBE edge to DSTROBE edge)  | $t_{CYCRD}$  | 112               | -   | 73                | -   | 54                | -   | 39                | -   |
| Two-cycle time allowing for clock variations (from rising edge to next rising edge or from falling edge to next falling edge of DSTROBE)  | $t_{2CYCRD}$ | 230               | -   | 154               | -   | 115               | -   | 86                | -   |
| Cycle time allowing for asymmetry and clock variations (from HSTROBE edge to HSTROBE edge)  | $t_{CYCWR}$  | 230               | -   | 170               | -   | 130               | -   | 100               | -   |
| Two-cycle time allowing for clock variations (from rising edge to next rising edge or from falling edge to next falling edge of HSTROBE)  | $t_{2CYCWR}$ | 460               | -   | 340               | -   | 260               | -   | 200               | -   |
| Data setup time at recipient (Read)   | $t_{DS}$     | 15                | -   | 10                | -   | 7                 | -   | 7                 | -   |
| Data hold time at recipient (Read)  | $t_{DH}$     | 8                 | -   | 8                 | -   | 8                 | -   | 8                 | -   |
| Data valid setup time at sender (Write) (Note 2)<br>(from data valid until STROBE edge)   | $t_{DVS}$    | 70                | -   | 48                | -   | 30                | -   | 20                | -   |
| Data valid hold time at sender (Write) (Note 2)<br>(from STROBE edge until data may become invalid)                                       | $t_{DVH}$    | 6                 | -   | 6                 | -   | 6                 | -   | 6                 | -   |
| First STROBE time (for device to first negate DSTROBE from STOP during a data in burst)   | $t_{FS}$     | 0                 | 230 | 0                 | 200 | 0                 | 170 | 0                 | 130 |
| Limited interlock time (Note 3)   | $t_{LI}$     | 0                 | 150 | 0                 | 150 | 0                 | 150 | 0                 | 100 |
| Interlock time with minimum (Note 3)  | $t_{MLI}$    | 20                | -   | 20                | -   | 20                | -   | 20                | -   |
| Unlimited interlock time (Note 3)   | $t_{UI}$     | 0                 | -   | 0                 | -   | 0                 | -   | 0                 | -   |
| Maximum time allowed for output drivers to release (from asserted or negated)   | $t_{AZ}$     | -                 | 10  | -                 | 10  | -                 | 10  | -                 | 10  |
| Minimum delay time required for output  | $t_{ZAH}$    | 20                | -   | 20                | -   | 20                | -   | 20                | -   |
| Drivers to assert or negate (from released)   | $t_{ZAD}$    | 0                 | -   | 0                 | -   | 0                 | -   | 0                 | -   |
| Envelope time (from DMACKn to STOP and HDMARDYn during data in burst initiation and from DMACKn to STOP during data out burst initiation) | $t_{ENV}$    | 20                | 70  | 20                | 70  | 20                | 70  | 20                | 55  |
| Ready-to-final-STROBE time (no STROBE edges shall be sent this long after negation of DMARDYn)  | $t_{RFS}$    | -                 | 75  | -                 | 70  | -                 | 60  | -                 | 60  |
| Ready-to-pause time (that recipient shall wait to pause after negating DMARDYn)   | $t_{RP}$     | 160               | -   | 125               | -   | 100               | -   | 100               | -   |
| Maximum time before releasing IORDY   | $t_{IORDYZ}$ | -                 | 20  | -                 | 20  | -                 | 20  | -                 | 20  |
| Minimum time before driving STROBE (Note 4)   | $t_{ZIORDY}$ | 0                 | -   | 0                 | -   | 0                 | -   | 0                 | -   |
| Setup and hold times for DMACKn (before assertion or negation)  | $t_{ACK}$    | 20                | -   | 20                | -   | 20                | -   | 20                | -   |
| Time from STROBE edge to negation of DMARQ or assertion of STOP (when sender terminates a burst)  | $t_{SS}$     | 50                | -   | 50                | -   | 50                | -   | 50                | -   |

- Note:
1. Timing parameters shall be measured at the connector of the sender or receiver to which the parameter applies.
  2. The test load for  $t_{DVS}$  and  $t_{DVH}$  shall be a lumped capacitor load with no cable or receivers. Timing for  $t_{DVS}$  and  $t_{DVH}$  shall be met for all capacitive loads from 15 to 40 pF where all signals have the same capacitive load value.
  3.  $t_{UI}$ ,  $t_{MLI}$  and  $t_{LI}$  indicate sender-to-recipient or recipient-to-sender interlocks, i.e., either sender or recipient is waiting for the other to respond with a signal before proceeding.  $t_{UI}$  is an unlimited interlock that has no maximum time value.  $t_{MLI}$  is a limited time-out that has a defined minimum.  $t_{LI}$  is a limited time-out that has a defined maximum.
  4.  $t_{ZIORDY}$  may be greater than  $t_{ENV}$  since the device has a pull up on IORDYn giving it a known state when released.
  5. All IDE timing is based upon HCLK = 100 MHz.



Note: The definitions for the DIOWn:STOP, DIORn:HDMARDYn:HSTROBE and IORDY:DDMARDYn:DSTROBE signal lines are not in effect until DMARQ and DMACKn are asserted.

**Figure 21. Initiating an Ultra DMA data-in Burst**



Note: DD (15:0) and DSTROBE signals are shown at both the host and the device to emphasize that cable settling time as well as cable propagation delay shall not allow the data signals to be considered stable at the host until some time after they are driven by the device.

Figure 22. Sustained Ultra DMA data-in Burst

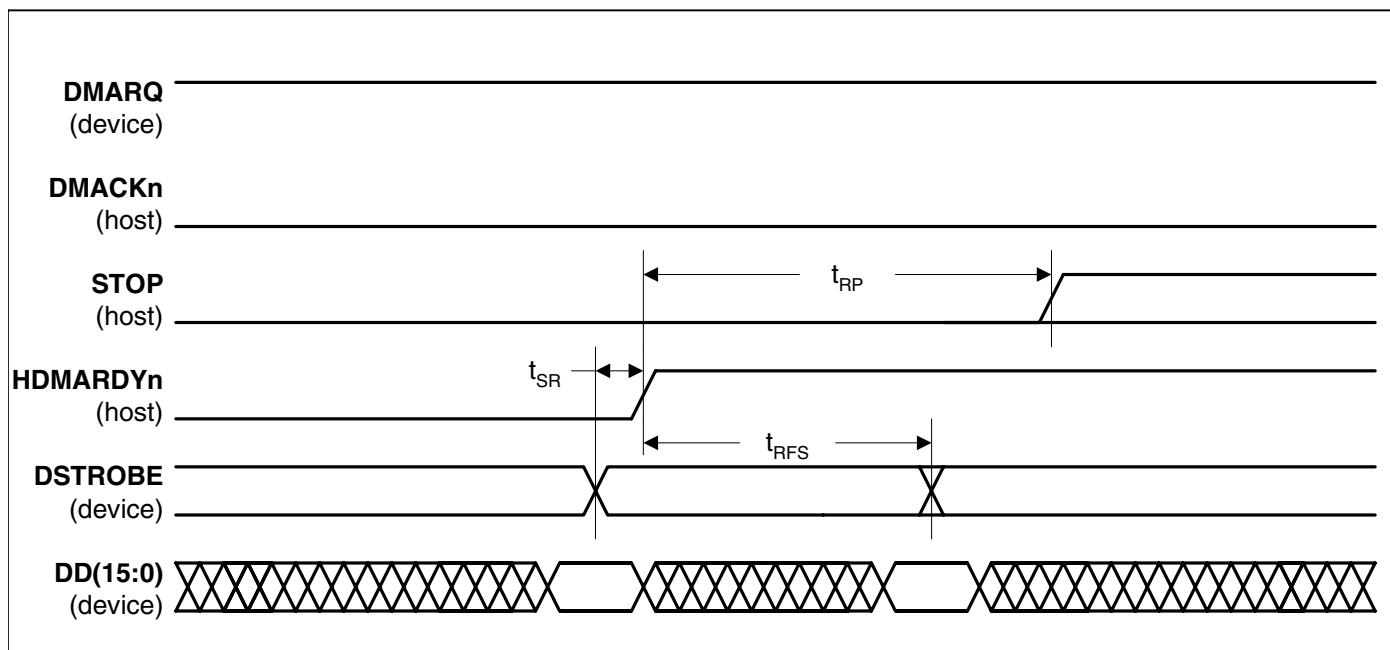
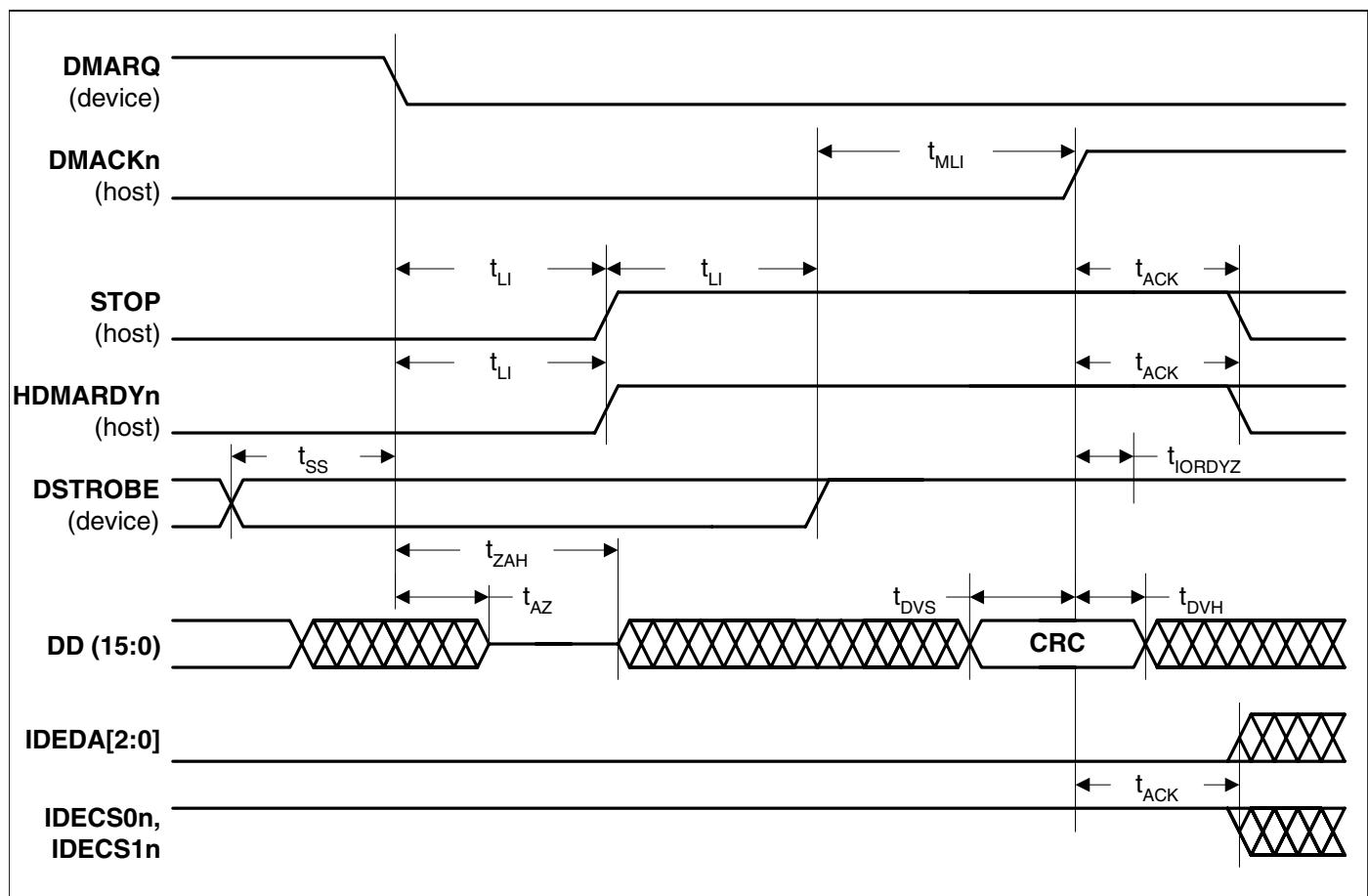
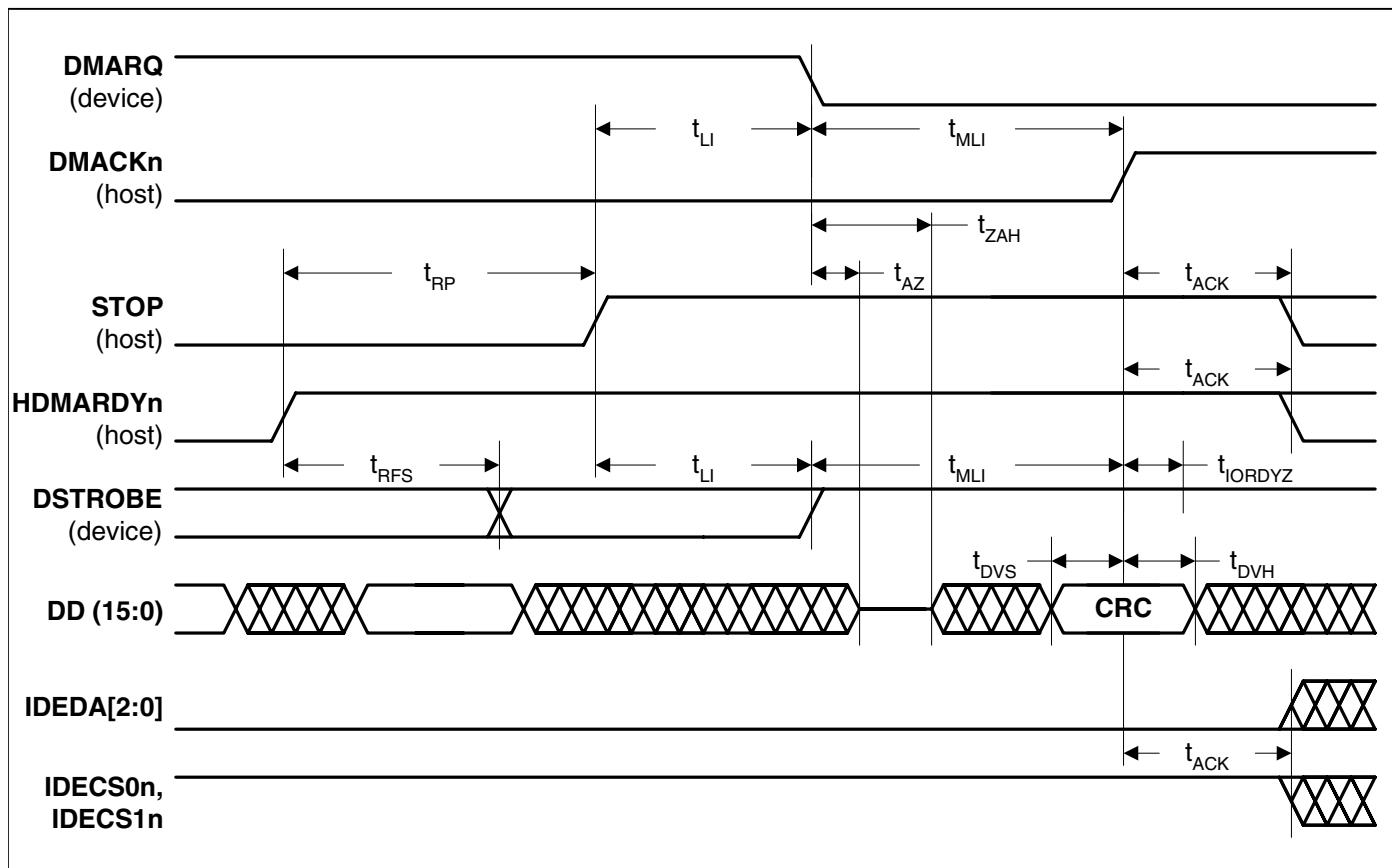


Figure 23. Host Pausing an Ultra DMA data-in Burst



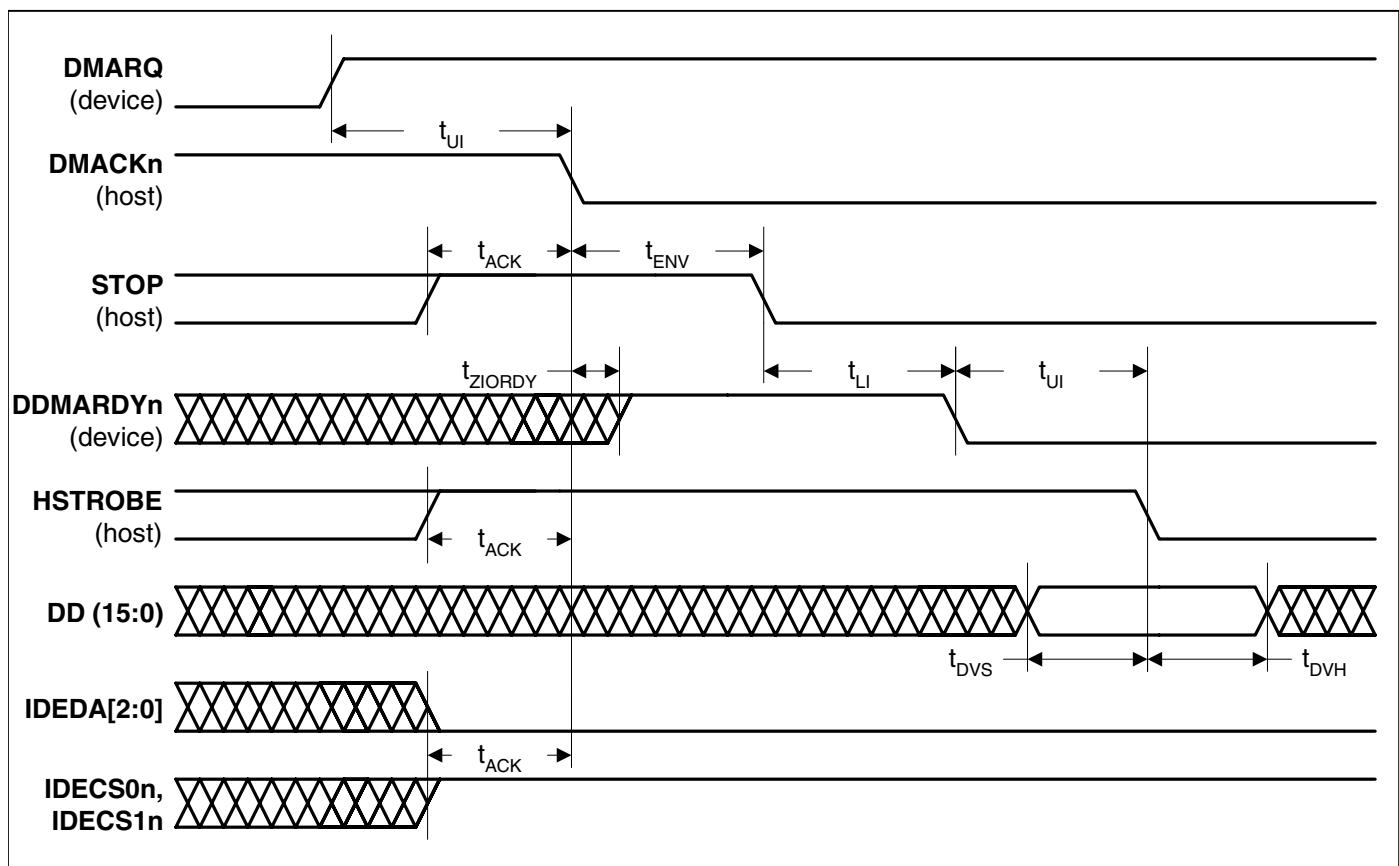
Note: The definitions for the DIOWn:STOP, DIORn:HDMARDYn:HSTROBE and IORDY:DDMARDYn:DSTROBE signal lines are no longer in effect after DMARQ and DMACKn are negated.

Figure 24. Device Terminating an Ultra DMA data-in Burst



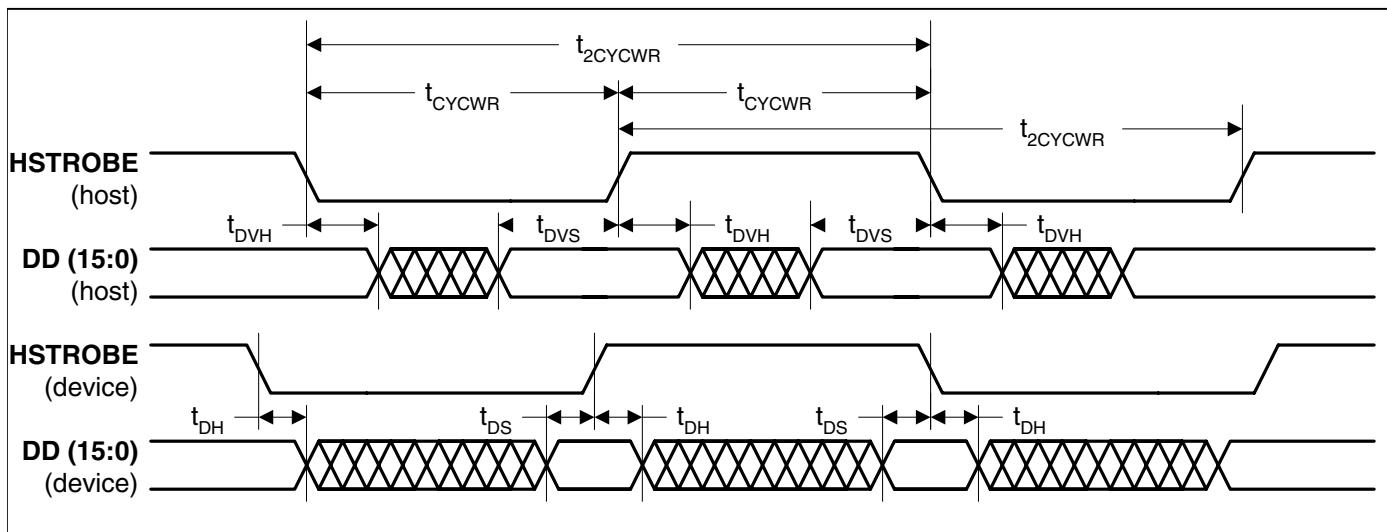
Note: The definitions for the DIOWn:STOP, DIORn:HDMARDYn:HSTROBE and IORDY:DDMARDYn:DSTROBE signal lines are no longer in effect after DMARQ and DMACKn are negated.

Figure 25. Host Terminating an Ultra DMA data-in Burst



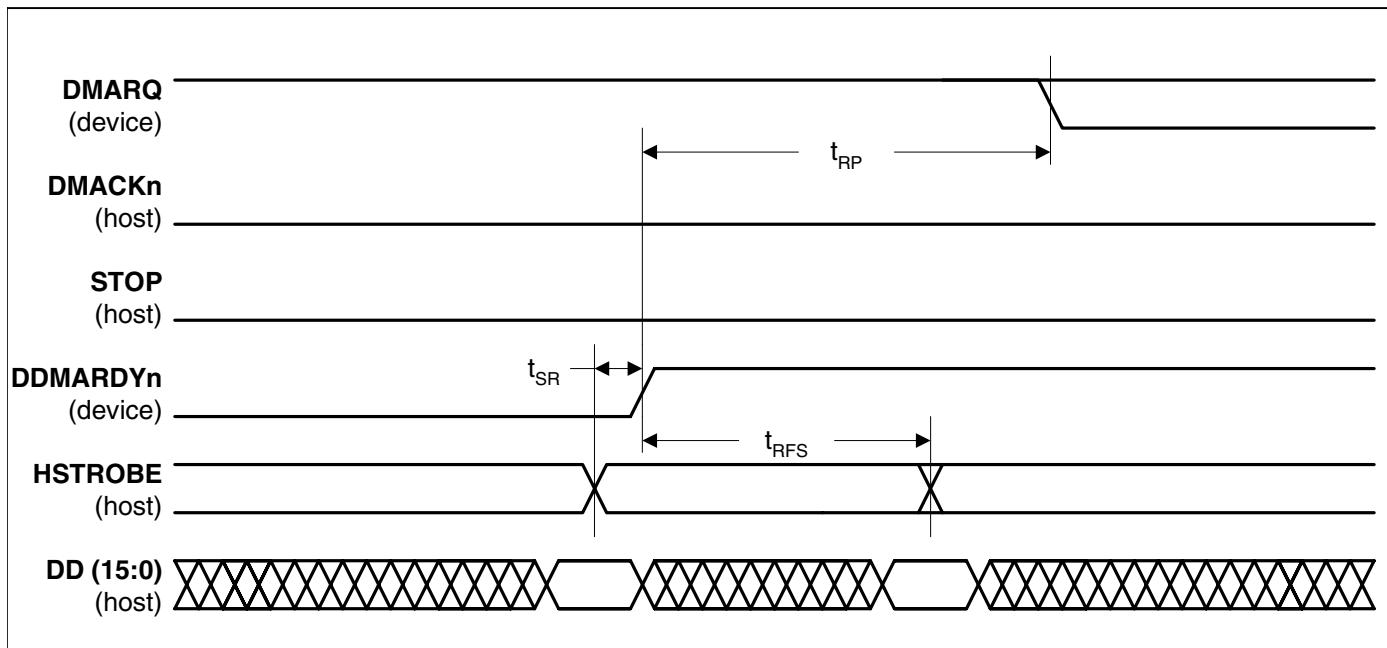
Note: The definitions for the DIOWN:STOP, DIORn:HDMARDYn:HSTROBE and IORDY:DDMARDYn:DSTROBE signal lines are not in effect until DMARQ and DMACKn are asserted.

**Figure 26. Initiating an Ultra DMA data-out Burst**



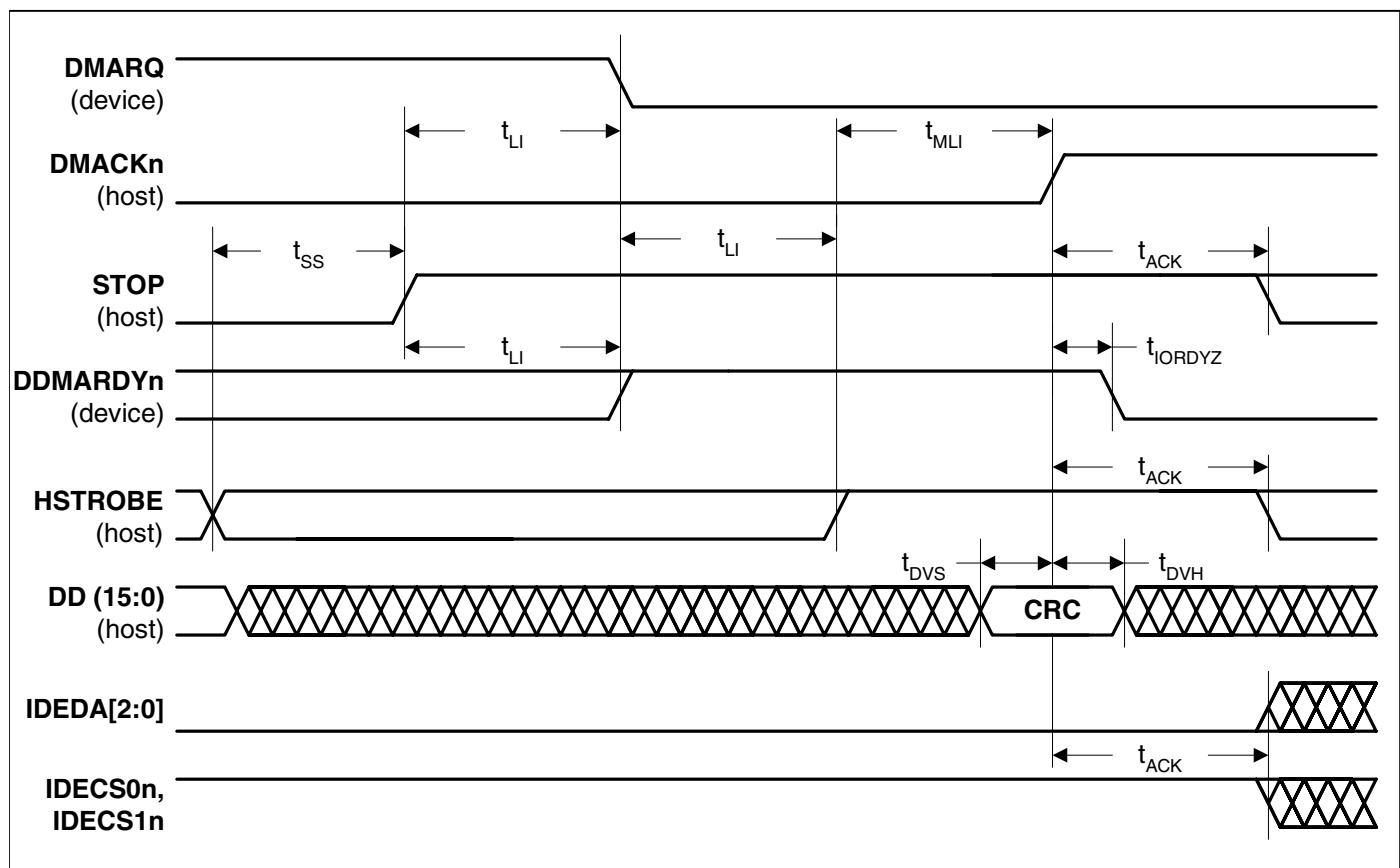
Note: DD (15:0) and HSTROBE signals are shown at both the device and the host to emphasize that cable settling time as well as cable propagation delay shall not allow the data signals to be considered stable at the device until some time after they are driven by the host.

Figure 27. Sustained Ultra DMA data-out Burst



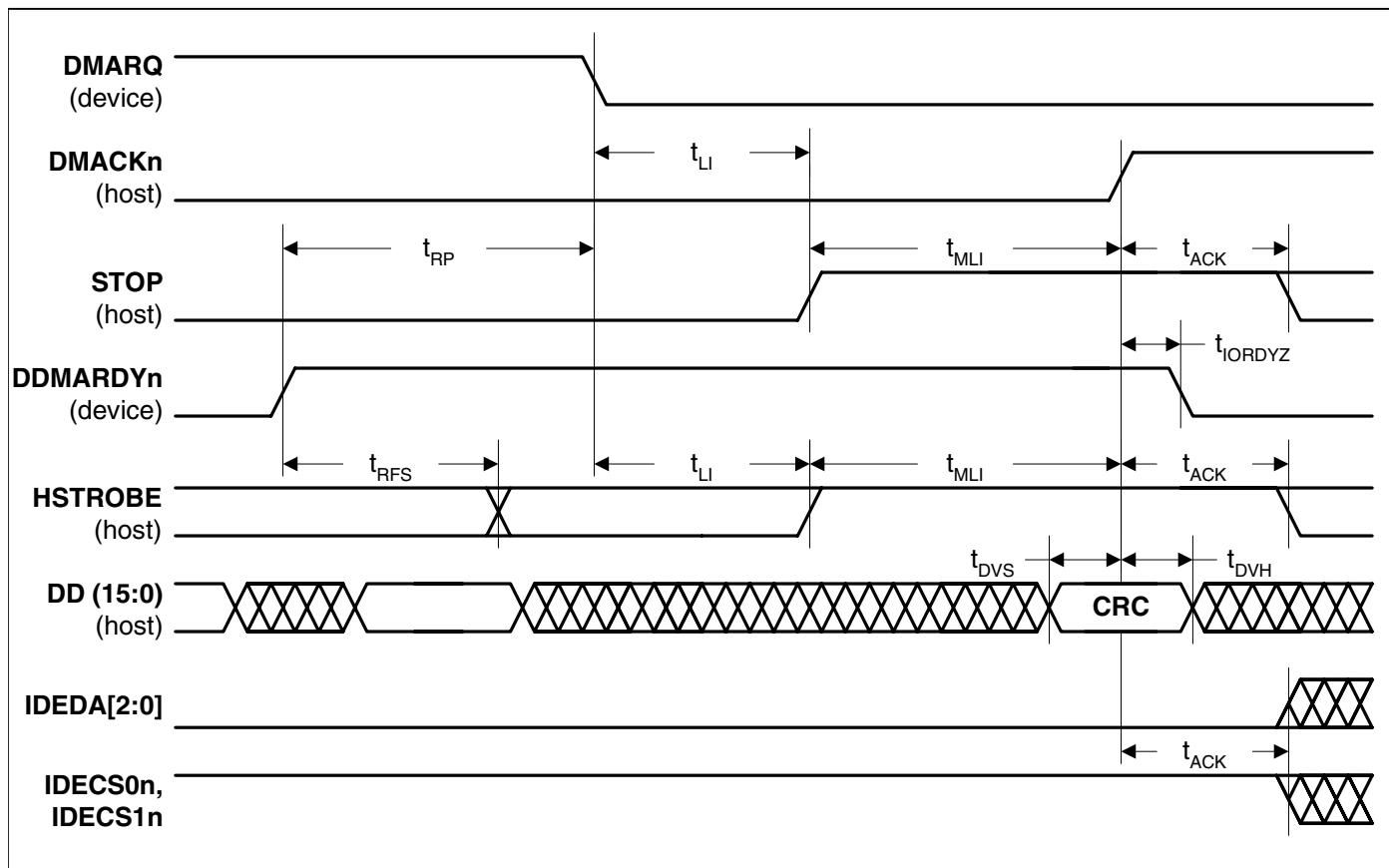
Note: 1. The device may negate DMARQ to request termination of the Ultra DMA burst no sooner than  $t_{RP}$  after DDMARDYn is negated.  
2. If the  $t_{SR}$  timing is not satisfied, the device may receive zero, one, or two more data words from the host.

Figure 28. Device Pausing an Ultra DMA data-out Burst



Note: The definitions for the DIOWn:STOP, IORDY:DDMARDYn:DSTROBE and DIORn:HDMARDYn:HSTROBE signal lines are no longer in effect after DMARQ and DMACKn are negated.

**Figure 29. Host Terminating an Ultra DMA data-out Burst**



Note: The definitions for the DIOWn:STOP, IORDY:DDMARDYn:DSTROBE and DIOrn:HDMARDYn:HSTROBE signal lines are no longer in effect after DMARQ and DMACKn are negated.

Figure 30. Device Terminating an Ultra DMA data-out Burst

## Ethernet MAC Interface

| Parameter  | Symbol          | Min          |               | Typ          |               | Max          |               | Unit |
|--|-----------------|--------------|---------------|--------------|---------------|--------------|---------------|------|
|  |                 | 10 Mbit mode | 100 Mbit mode | 10 Mbit mode | 100 Mbit mode | 10 Mbit mode | 100 Mbit mode |      |
| TXCLK cycle time                                       | $t_{TX\_per}$   | -            | -             | 400          | 40            | -            | -             | ns   |
| TXCLK high time  | $t_{TX\_high}$  | 140          | 14            | 200          | 20            | 260          | 26            | ns   |
| TXCLK low time   | $t_{TX\_low}$   | 140          | 14            | 200          | 20            | 260          | 26            | ns   |
| TXCLK to signal transition delay time                  | $t_{TXd}$       | 0            | 0             | 10           | 10            | 25           | 25            | ns   |
| TXCLK rise/fall time                                   | $t_{TXrf}$      | -            | -             | -            | -             | 5            | 5             | ns   |
| RXCLK cycle time                                       | $t_{RX\_per}$   | -            | -             | 400          | 40            | -            | -             | ns   |
| RXCLK high time  | $t_{RX\_high}$  | 140          | 14            | 200          | 20            | 260          | 26            | ns   |
| RXCLK low time   | $t_{RX\_low}$   | 140          | 14            | 200          | 20            | 260          | 26            | ns   |
| RXDVAL / RXERR setup time                              | $t_{RXs}$       | 10           | 10            | -            | -             | -            | -             | ns   |
| RXDVAL / RXERR hold time                               | $t_{RXh}$       | 10           | 10            | -            | -             | -            | -             | ns   |
| RXCLK rise/fall time                                   | $t_{RXrf}$      | -            | -             | -            | -             | 5            | 5             | ns   |
| MDC cycle time   | $t_{MDC\_per}$  | -            | -             | 400          | 400           | -            | -             | ns   |
| MDC high time  | $t_{MDC\_high}$ | 160          | 160           | -            | -             | -            | -             | ns   |
| MDC low time   | $t_{MDC\_low}$  | 160          | 160           | -            | -             | -            | -             | ns   |
| MDC rise/fall time                                     | $t_{MDCrf}$     | -            | -             | -            | -             | 5            | 5             | ns   |
| MDIO setup time (STA sourced)                          | $t_{MDIOS}$     | 10           | 10            | -            | -             | -            | -             | ns   |
| MDIO hold time (STA sourced)                           | $t_{MDIOh}$     | 10           | 10            | -            | -             | -            | -             | ns   |
| MDC to MDIO signal transition delay time (PHY sourced) | $t_{MDIOD}$     | -            | -             | -            | -             | 300          | 300           | ns   |

STA - Station - Any device that contains an IEEE 802.11 conforming Medium Access Control (MAC) and physical layer (PHY) interface to the wireless medium.

PHY - Ethernet physical layer interface.

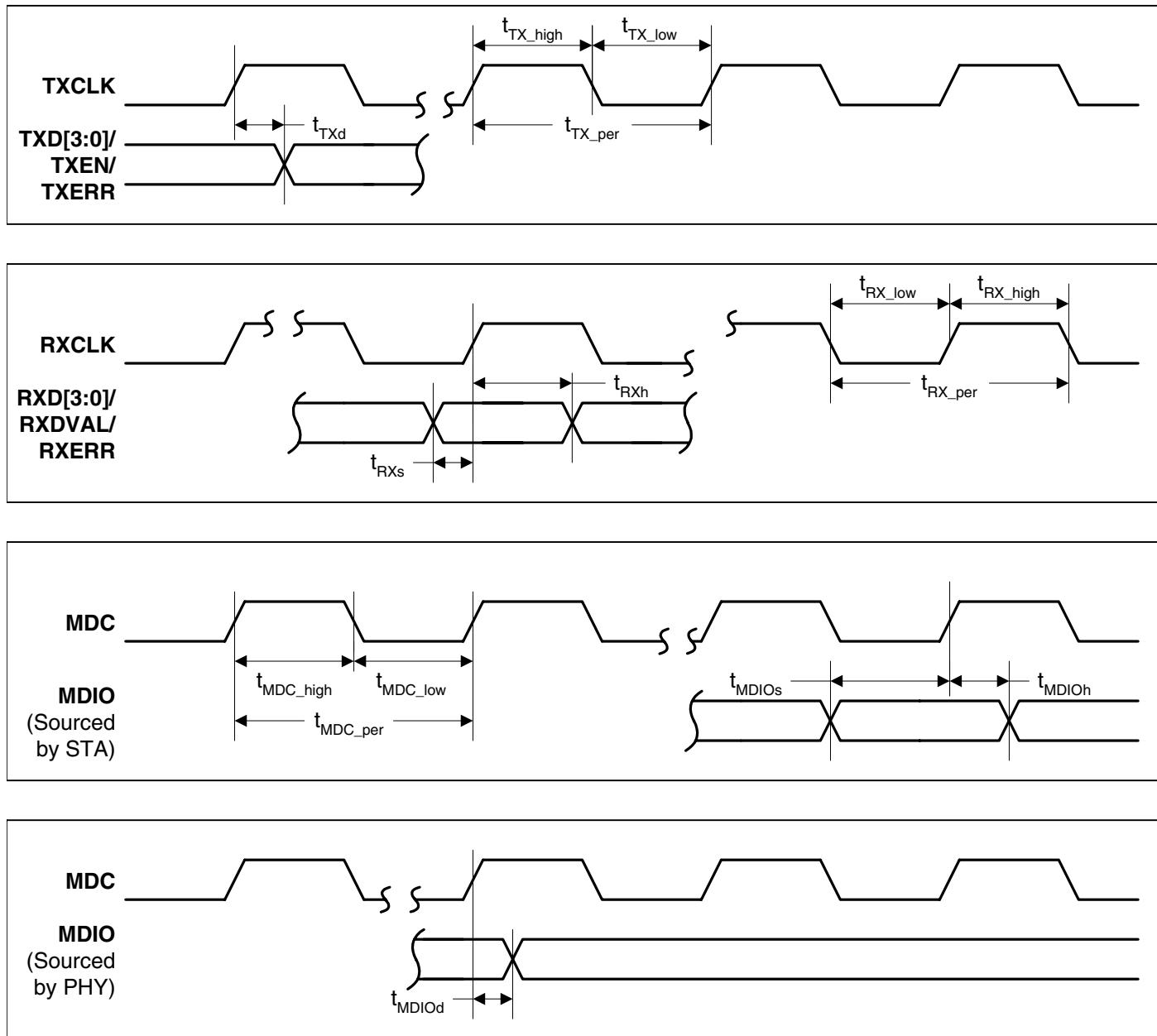


Figure 31. Ethernet MAC Timing Measurement

## Audio Interface

The following table contains the values for the timings of each of the SPI modes.

| Parameter                         | Symbol          | Min | Typ                   | Max | Unit |
|-----------------------------------|-----------------|-----|-----------------------|-----|------|
| SCLK cycle time                   | $t_{clk\_per}$  | -   | $t_{spix\_clk}$       | -   | ns   |
| SCLK high time                    | $t_{clk\_high}$ | -   | $(t_{spix\_clk}) / 2$ | -   | ns   |
| SCLK low time                     | $t_{clk\_low}$  | -   | $(t_{spix\_clk}) / 2$ | -   | ns   |
| SCLK rise/fall time               | $t_{clkrf}$     | 1   | -                     | 8   | ns   |
| Data from master valid delay time | $t_{DMd}$       | -   | -                     | 3   | ns   |
| Data from master setup time       | $t_{DMs}$       | 20  | -                     | -   | ns   |
| Data from master hold time        | $t_{DMh}$       | 40  | -                     | -   | ns   |
| Data from slave setup time        | $t_{DSs}$       | 20  | -                     | -   | ns   |
| Data from slave hold time         | $t_{DSh}$       | 40  | -                     | -   | ns   |

Note: The  $t_{spix\_clk}$  is programmable by the user.

### Texas Instruments' Synchronous Serial Format

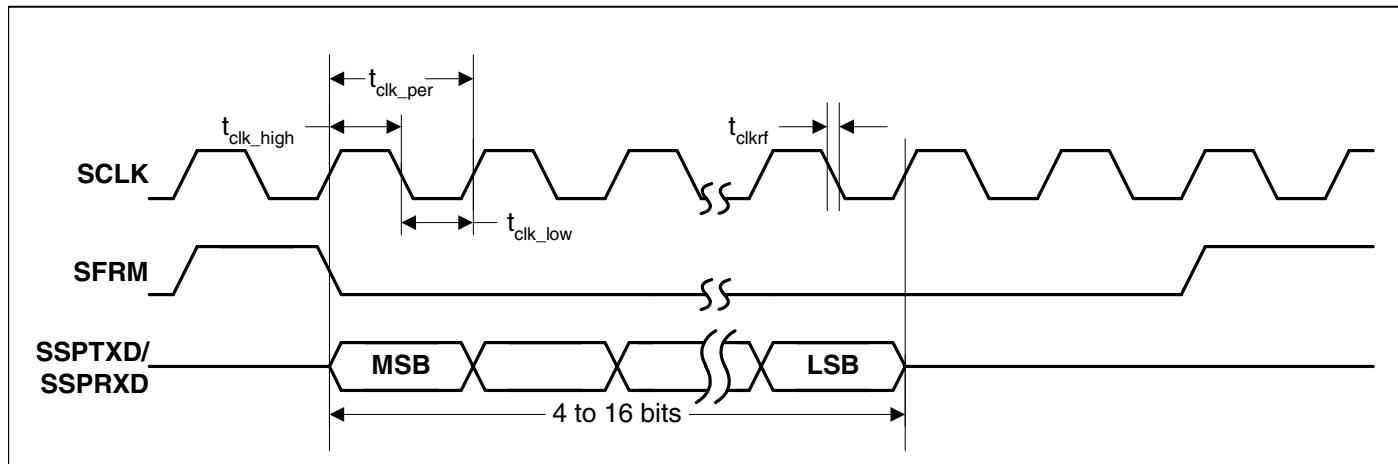


Figure 32. TI Single Transfer Timing Measurement

### Microwire

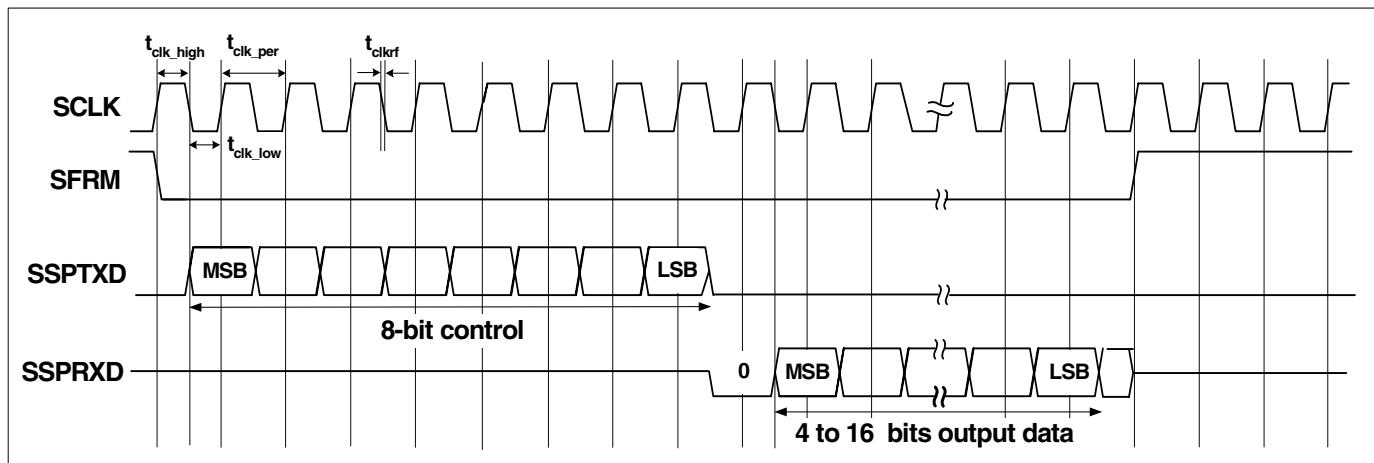


Figure 33. Microwire Frame Format, Single Transfer

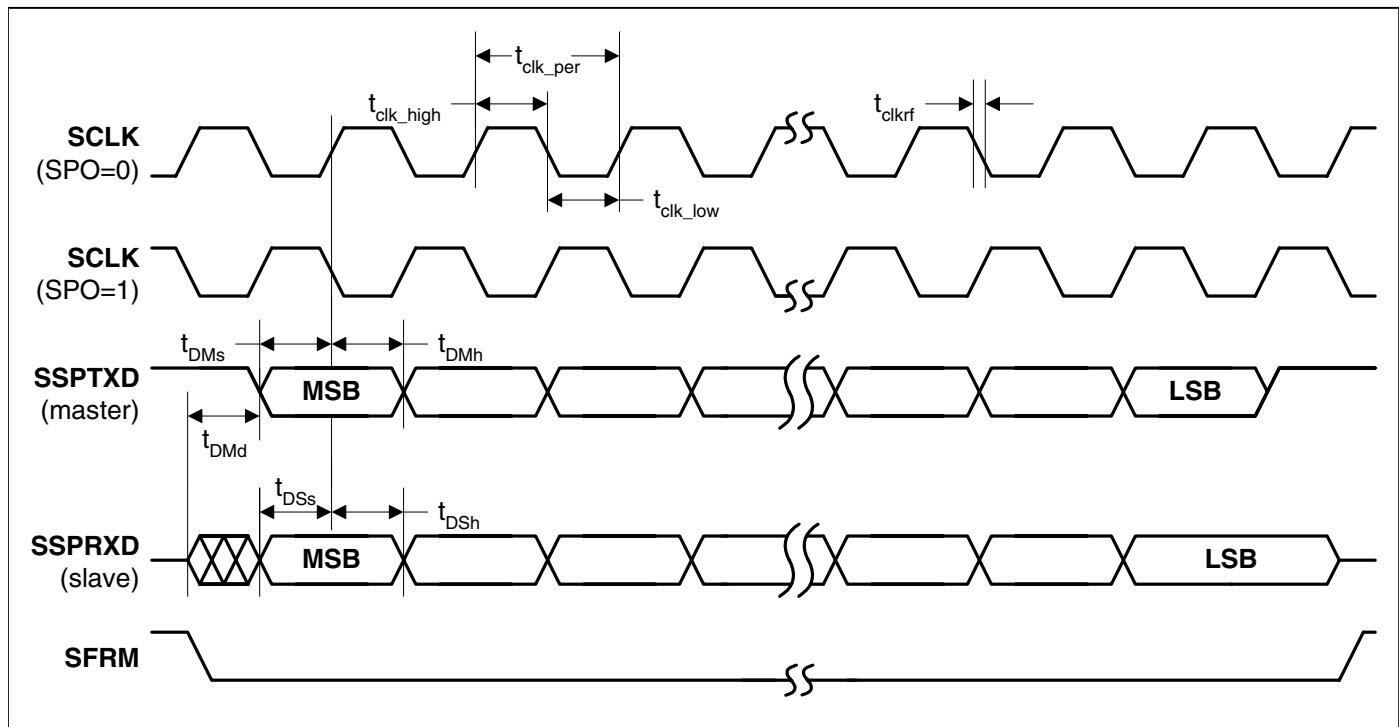
**Motorola SPI**


Figure 34. SPI Format with  $\text{SPH}=1$  Timing Measurement

## Inter-IC Sound - I<sup>2</sup>S

| Parameter  | Symbol          | Min | Typ                  | Max | Unit |
|--|-----------------|-----|----------------------|-----|------|
| SCLK cycle time  | $t_{clk\_per}$  | -   | $t_{i2s\_clk}$       | -   | ns   |
| SCLK high time   | $t_{clk\_high}$ | -   | $(t_{i2s\_clk}) / 2$ | -   | ns   |
| SCLK low time  | $t_{clk\_low}$  | -   | $(t_{i2s\_clk}) / 2$ | -   | ns   |
| SCLK rise/fall time  | $t_{clkrf}$     | 1   | 4                    | 8   | ns   |
| SCLK to LRCLK assert delay time  | $t_{LRd}$       | -   | -                    | 3   | ns   |
| Hold between SCLK assert then LRCLK deassert<br>or<br>Hold between LRCLK deassert then SCLK assert | $t_{LRh}$       | 0   | -                    | -   | ns   |
| SDI to SCLK deassert setup time  | $t_{SDIs}$      | 12  | -                    | -   | ns   |
| SDI from SCLK deassert hold time   | $t_{SDIh}$      | 0   | -                    | -   | ns   |
| SCLK assert to SDO delay time  | $t_{SDOd}$      | -   | -                    | 9   | ns   |
| SDO from SCLK assert hold time   | $t_{SDOh}$      | 1   | -                    | -   | ns   |

Note:  $t_{i2s\_clk}$  is programmable by the user.

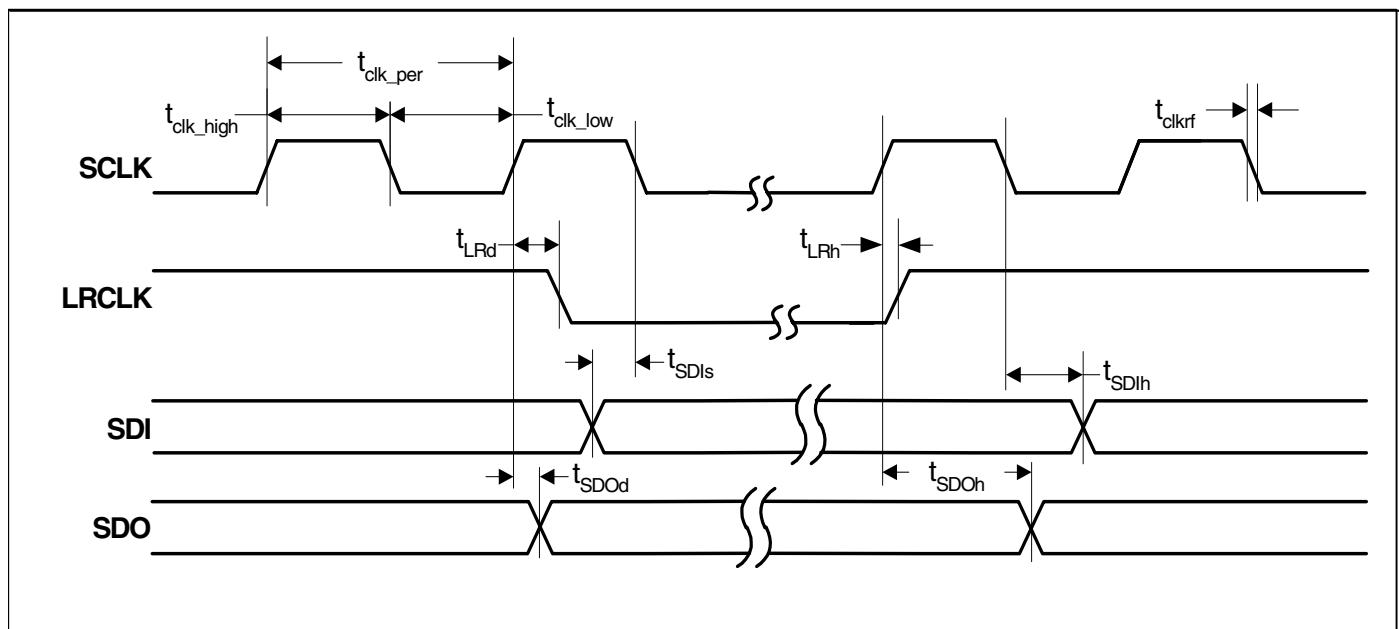
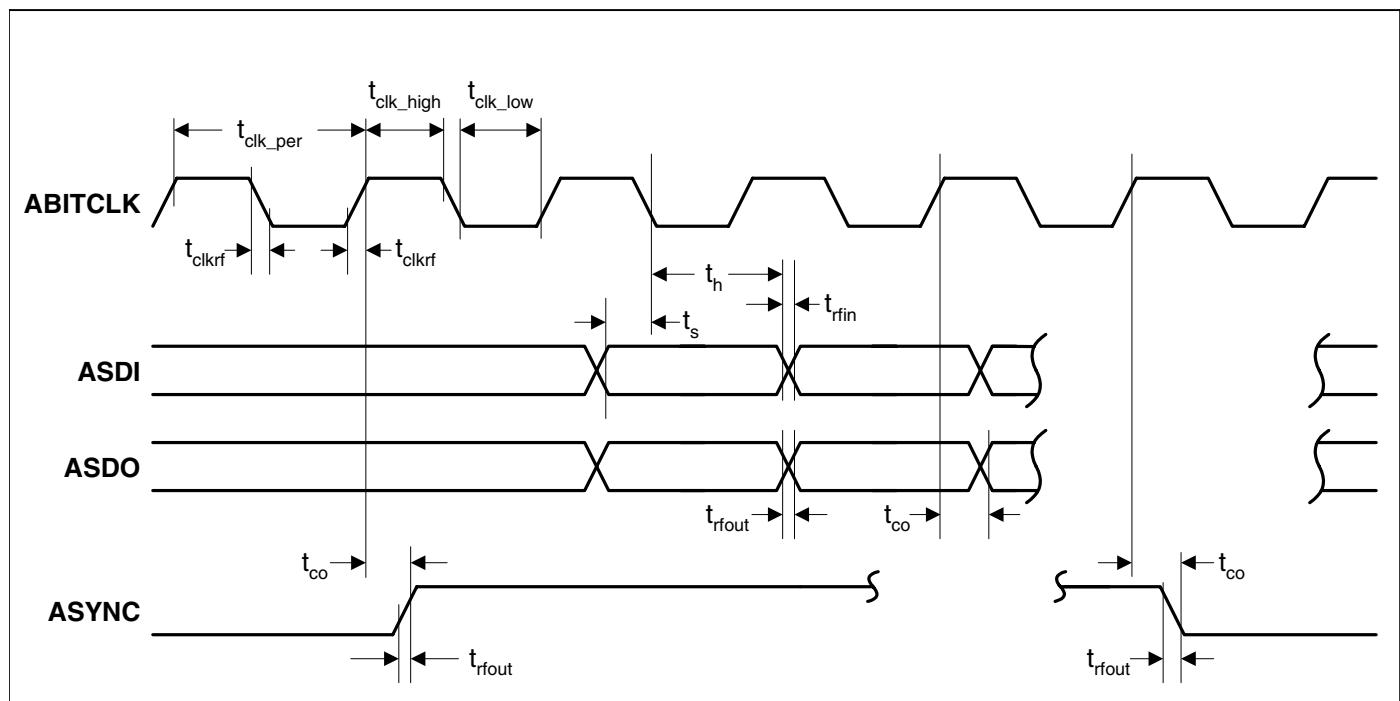


Figure 35. Inter-IC Sound (I<sup>2</sup>S) Timing Measurement

**AC'97**

| Parameter   | Symbol          | Min | Typ  | Max | Unit |
|---|-----------------|-----|------|-----|------|
| ABITCLK input cycle time                                    | $t_{clk\_per}$  | -   | 81.4 | -   | ns   |
| ABITCLK input high time                                     | $t_{clk\_high}$ | 36  | -    | 45  | ns   |
| ABITCLK input low time                                      | $t_{clk\_low}$  | 36  | -    | 45  | ns   |
| ABITCLK input rise/fall time                                | $t_{clkrf}$     | 2   | -    | 6   | ns   |
| ASDI setup to ABITCLK falling                               | $t_s$           | 10  | -    | -   | ns   |
| ASDI hold after ABITCLK falling                             | $t_h$           | 10  | -    | -   | ns   |
| ASDI input rise/fall time                                   | $t_{rfin}$      | 2   | -    | 6   | ns   |
| ABITCLK rising to ASDO / ASYNC valid, $C_L = 55 \text{ pF}$ | $t_{co}$        | 2   | -    | 15  | ns   |
| ASYNC / ASDO rise/fall time, $C_L = 55 \text{ pF}$          | $t_{rfout}$     | 2   | -    | 6   | ns   |


**Figure 36. AC '97 Configuration Timing Measurement**

## LCD Interface

| Parameter   | Symbol      | Min         | Typ | Max | Unit |
|---|-------------|-------------|-----|-----|------|
| SPCLK rise/fall time                                | $t_{clkrf}$ | 2           | -   | 8   | ns   |
| SPCLK rising edge to control signal transition time | $t_{CD}$    | -           | -   | 3   | ns   |
| SPCLK rising edge to data transition time           | $t_{DD}$    | -           | -   | 10  | ns   |
| Data valid time                                     | $t_{Dv}$    | $t_{SPCLK}$ | -   | -   | ns   |

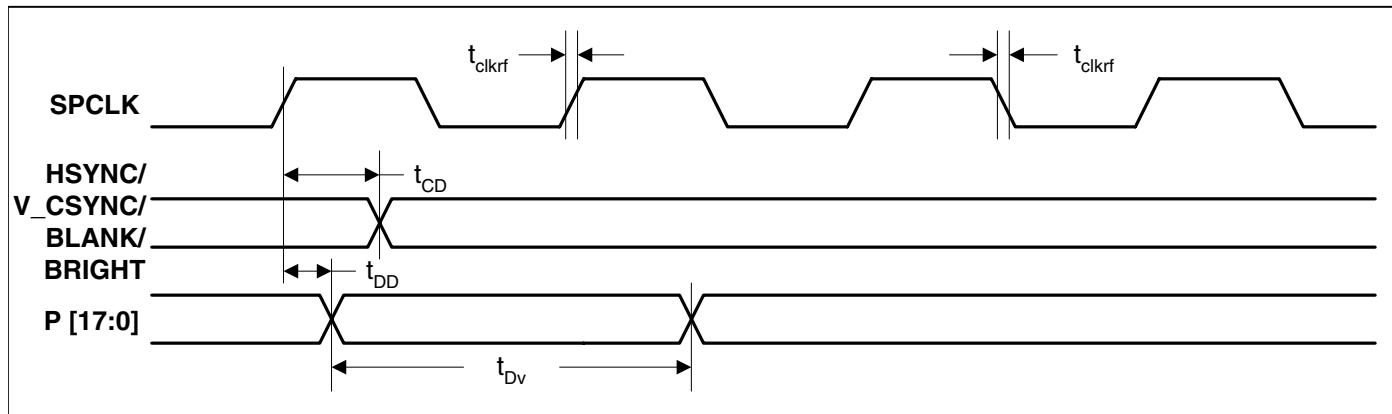


Figure 37. LCD Timing Measurement

## ADC

| Parameter                    | Comment                                 | Value                    | Units                                    |
|------------------------------|---|--------------------------|--|
| Resolution                   | No missing codes<br>Range of 0 to 3.3 V | 50K counts (approximate) |  |
| Integral non-linearity       |   | 0.01%                    |  |
| Offset error                 |   | ±15                      | mV                                       |
| Full scale error             |   | 0.2%                     |  |
| Maximum sample rate          | ADIV = 0<br>ADIV = 1                    | 3750<br>925              | Samples per second<br>Samples per second |
| Channel switch settling time | ADIV = 0<br>ADIV = 1                    | 500<br>2                 | μs<br>ms                                 |
| Noise (RMS) - typical        |   | 120                      | μV                                       |

Note: ADIV refers to bit 16 in the KeyTchClkDiv register.

ADIV = 0 means the input clock to the ADC module is equal to the external 14.7456 MHz clock divided by 4.

ADIV = 1 means the input clock to the ADC module is equal to the external 14.7456 MHz clock divided by 16.

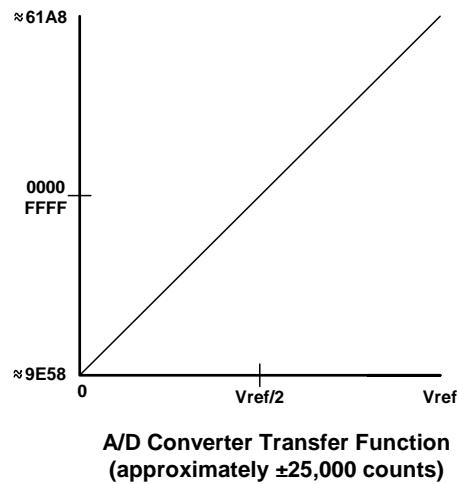


Figure 38. ADC Transfer Function

Using the ADC:

This ADC has a state-machine based conversion engine that automates the conversion process. The initiator for a conversion is the read access of the TSXYResult register by the CPU. The data returned from reading this register contains the result as well as the status bit indicating the state of the ADC. However, this peripheral requires a delay between each successful conversion and the issue of the next conversion command, or else the returned value of successive samples may not reflect the analog input. Since the state of the ADC state machine is returned through the same channel used to initiate the conversion process, there must be a delay inserted after every complete conversion. Note that reading TSXYResult during a conversion will not affect the result of the ongoing process.

The following is a recommended procedure for safely polling the ADC from software:

1. Read the TSXYResult register into a local variable to initiate a conversion.
2. If the value of bit 31 of the local variable is '0' then repeat step 1.
3. Delay long enough to meet the maximum sample rate as shown above.
4. Mask the local variable with 0xFFFF to remove extraneous data.
5. If signed mode is used, do a sign extend of the lower halfword.
6. Return the sampled value.

## JTAG

| Parameter                                | Symbol          | Min | Max | Units |
|--|-----------------|-----|-----|-------|
| TCK clock period                         | $t_{clk\_per}$  | 100 | -   | ns    |
| TCK clock high time                      | $t_{clk\_high}$ | 50  | -   | ns    |
| TCK clock low time                       | $t_{clk\_low}$  | 50  | -   | ns    |
| TMS / TDI to clock rising setup time     | $t_{JPs}$       | 20  | -   | ns    |
| Clock rising to TMS / TDI hold time      | $t_{JP_{Ph}}$   | 45  | -   | ns    |
| JTAG port clock to output                | $t_{JP_{Co}}$   | -   | 30  | ns    |
| JTAG port high impedance to valid output | $t_{JP_{zx}}$   | -   | 30  | ns    |
| JTAG port valid output to high impedance | $t_{JP_{xz}}$   | -   | 30  | ns    |

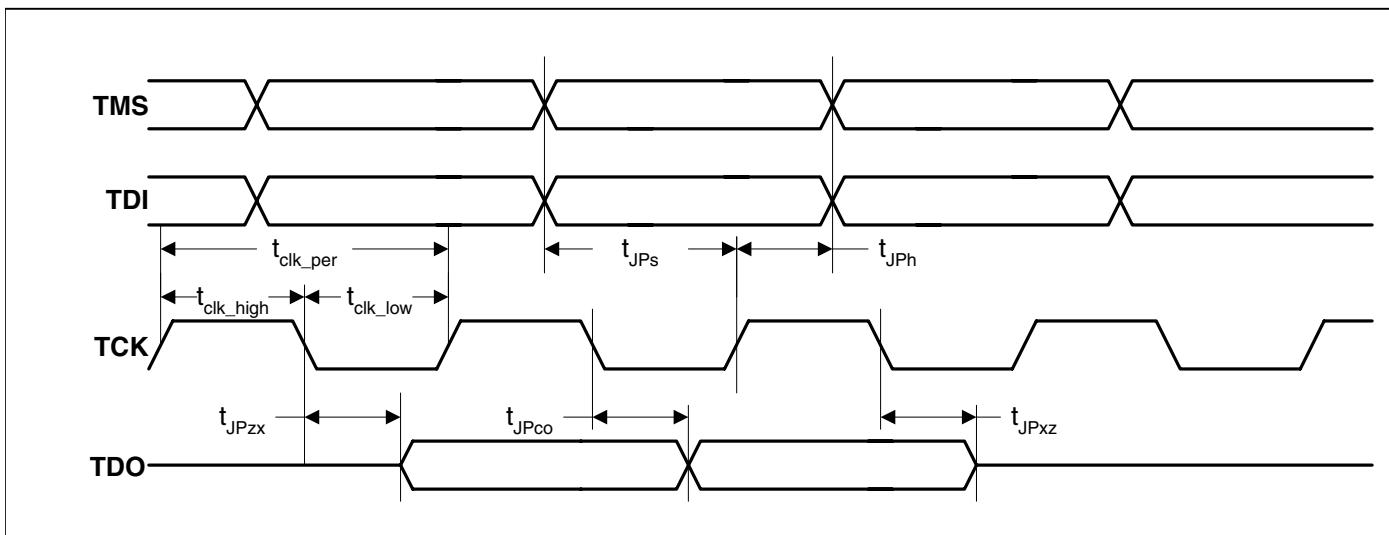


Figure 39. JTAG Timing Measurement

## 352 Pin BGA Package Outline

### 352-Ball PBGA Diagram

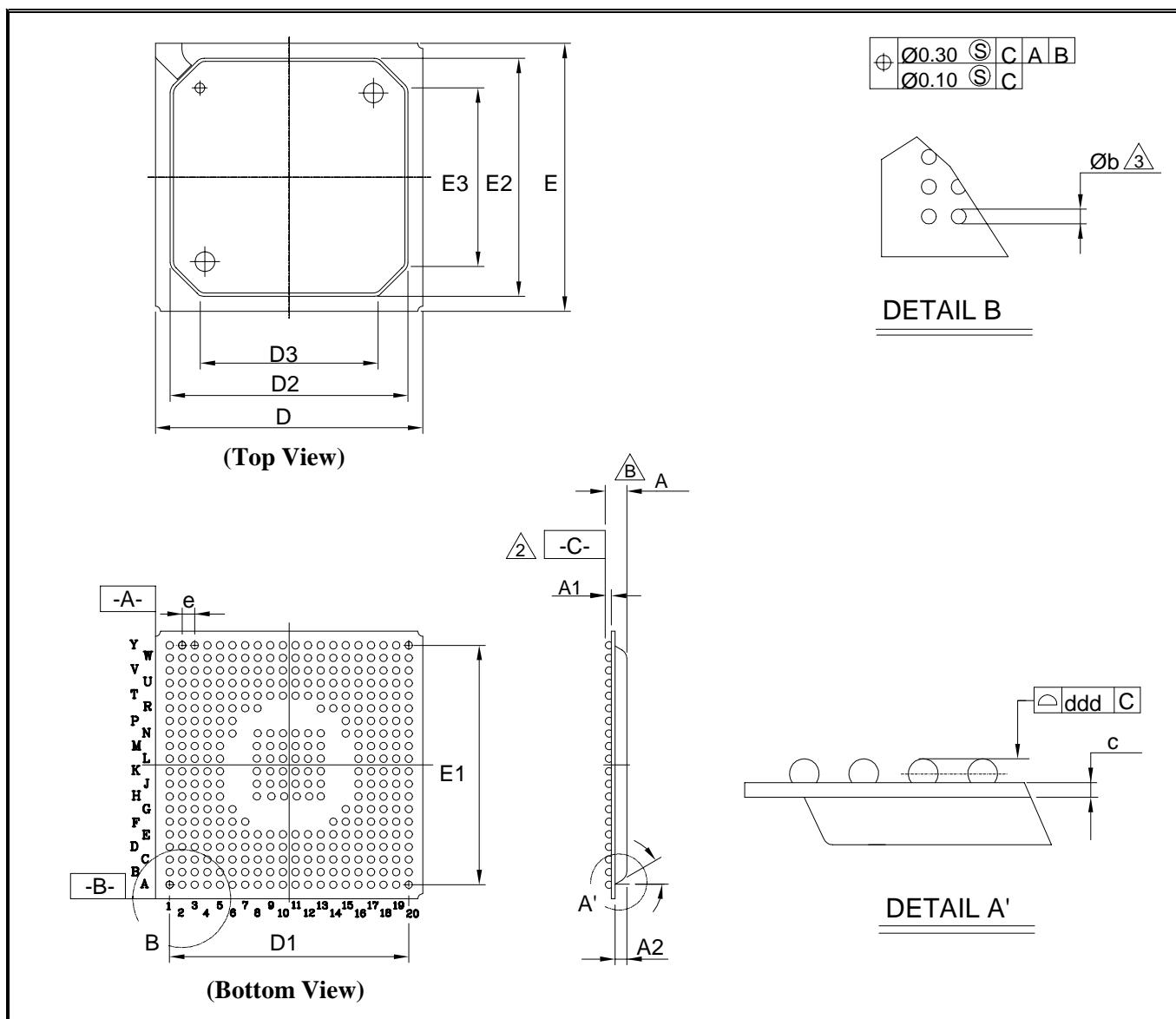


Figure 40. 352 Pin PBGA Pin Diagram

Table R. 352 Pin Diagram Dimensions

| Symbol | dimension in mm |       |       | dimension in inches |       |       |
|--------|-----------------|-------|-------|---------------------|-------|-------|
|        | MIN             | NOM   | MAX   | MIN                 | NOM   | MAX   |
| A      | 2.20            | 2.30  | 2.50  | 0.087               | 0.092 | 0.098 |
| A1     | -               | 0.60  | -     | -                   | 0.024 | -     |
| A2     | 1.12            | 1.17  | 1.22  | 0.044               | 0.046 | 0.048 |
| b      | -               | 0.75  | -     | -                   | 0.030 | -     |
| c      | 0.51            | 0.56  | 0.61  | 0.020               | 0.022 | 0.024 |
| D      | 26.80           | 27.00 | 27.20 | 1.055               | 1.063 | 1.071 |
| D1     | -               | 24.13 | -     | -                   | 0.950 | -     |
| D2     | 23.80           | 24.00 | 24.20 | 0.937               | 0.945 | 0.953 |
| D3     | 17.95           | 18.00 | 18.05 | 0.707               | 0.709 | 0.711 |
| E      | 26.80           | 27.00 | 27.20 | 1.055               | 1.063 | 1.071 |
| E1     | -               | 24.13 | -     | -                   | 0.950 | -     |
| E2     | 23.80           | 24.00 | 24.20 | 0.937               | 0.945 | 0.953 |
| E3     | 17.95           | 18.00 | 18.05 | 0.707               | 0.709 | 0.711 |
| e      | -               | 1.27  | -     | -                   | 0.050 | -     |
| ddd    | -               | -     | 0.15  | -                   | -     | 0.006 |
| q      | 30° TYP         |       |       | 30° TYP             |       |       |

- Note:
1. Controlling Dimension: Millimeter.
  2. Primary Datum C and seating plane are defined by the spherical crowns of the solder balls.
  3. Dimension b is measured at the maximum solder ball diameter, parallel to Primary Datum C.
  4. There shall be a minimum clearance of 0.25 mm between the edge of the solder ball and the body edge.
  5. Reference Document: JEDEC MO-151, BAL-2

## 352 Pin BGA Pinout (Bottom View)

The following table shows the 352 pin BGA pinout. (For better understanding, compare the coordinates on the x and y axis on [Figure 40, "352 PIN BGA PINOUT", on page 57](#) with [Figure 40, "352 Pin PBGA Pin Diagram", on page 55](#).

- VDD\_core is CVDD.
- VDD\_ring is RVDD.
- All core and ring grounds are connected together and are labelled GND.
- Other special power requirements are clearly labelled (i.e. H18=ADC\_VDD and H19=ADC\_GND).
- NC means that the pin is not connected.



Figure 40. 352 PIN BGA PINOUT

|   | 1        | 2        | 3         | 4           | 5           | 6          | 7           | 8           | 9         | 10          | 11        | 12          | 13          | 14          | 15         | 16         | 17            | 18          | 19          | 20           |           |   |
|---|----------|----------|-----------|-------------|-------------|------------|-------------|-------------|-----------|-------------|-----------|-------------|-------------|-------------|------------|------------|---------------|-------------|-------------|--------------|-----------|---|
| Y | H SYNC   | DD[1]    | DD[12]    | P[2]        | AD[15]      | DA[6]      | DA[4]       | AD[10]<br>1 | DA[1]     | AD[8]       | IDEDA[0]  | DTRN        | TDO         | BOOT[0]     | EEDAT      | ASDO       | SFRM1         | RDLED       | USBP[1]     | ABITCLK      | Y         |   |
| W | P[12]    | P[9]     | DD[0]     | P[5]        | P[3]        | DA[7]      | DA[5]       | AD[11]<br>1 | AD[9]     | IDECS1<br>N | IDEDA[1]  | TCK         | TMS         | EECLK       | SCLK1      | GRLED      | INT[3]        | SLA[1]      | SLA[0]      | RXD[2]       | W         |   |
| V | P[16]    | P[11]    | P[8]      | DD[15]      | DD[13]      | P[1]       | AD[12]<br>4 | AD[12]<br>4 | DA[2]     | IDECS0<br>N | IDEDA[2]  | TDI         | GND         | ASYNC       | SSPTX1     | INT[2]     | RTSN          | USBP[0]     | CTSN        | TXD[0]       | V         |   |
| U | AD[0]    | P[15]    | P[10]     | P[7]        | P[6]        | P[4]       | P[0]        | AD[13]<br>1 | DA[3]     | DA[0]       | DSRN      | BOOT[1]     | NC          | SSPRX1      | INT[1]     | PWMO<br>UT | USBM[0]       | RXD[1]      | TXD[1]      | ROW[1]       | U         |   |
| T | DA[8]    | BLANK    | P[13]     | SPCLK       | V_CSY<br>NC | DD[1]<br>4 | GND         | CVD<br>D    | RVDD      | GND         | GND       | RVDD        | CVDD        | GND         | INT[0]     | USBM[1]    | RXD[0]        | TXD[2]      | ROW[2]      | ROW[4]       | T         |   |
| R | AD[2]    | AD[1]    | P[17]     | P[14]       | RVDD        | RVD<br>D   | GND         | CVD<br>D    |           |             |           |             | CVDD        | GND         | RVDD       | RVDD       | ROW[0]        | ROW[3]      | PLL_GN<br>D | ROW[5]       | R         |   |
| P | AD[4]    | DA[10]   | DA[9]     | BRIGHT      | RVDD        | RVD<br>D   |             |             |           |             |           |             |             | RVDD        | RVDD       | XTAL1      | PLL_VD<br>D   | ROW[6]      | ROW[7]      | P            |           |   |
| N | DA[13]   | DA[12]   | DA[11]    | AD[3]       | CVDD        | CVD<br>D   |             |             | GND       | GND         | GND       | GND         | GND         |             | GND        | GND        | XTAL0         | COL[0]      | COL[1]      | COL[2]       | N         |   |
| M | AD[7]    | DA[14]   | AD[6]     | AD[5]       | CVDD        |            |             |             | GND       | GND         | GND       | GND         | GND         |             |            | GND        | COL[4]        | COL[3]      | COL[6]      | CSN[0]       | M         |   |
| L | DA[18]   | DA[17]   | DA[16]    | DA[15]      | GND         |            |             |             | GND       | GND         | GND       | GND         | GND         |             |            | CVDD       | COL[5]        | COL[7]      | RSTON       | PRSTN        | L         |   |
| K | AD[22]   | DA[20]   | AD[21]    | DA[19]      | RVDD        |            |             |             | GND       | GND         | GND       | GND         | GND         |             |            | CVDD       | SYM           | SYP         | SXM         | SXP          | K         |   |
| J | DQMN[0]  | DQMN[1]  | DQMN[2]   | GND         |             |            |             |             | GND       | GND         | GND       | GND         | GND         |             |            | CVDD       | RTCXTA<br>LI  | XM          | YP          | YM           | J         |   |
| H | DQMN[3]  | CASN     | RASN      | SDCSN[2]    | CVDD        |            |             |             | GND       | GND         | GND       | GND         | GND         |             |            | RVDD       | RTCXTA<br>LO  | ADC_V<br>DD | ADC_G<br>ND | XP           | H         |   |
| G | SDCSN[0] | SDCSN[1] | SDWE<br>N | SDCLK       | RVDD        | RVD<br>D   |             |             |           |             |           |             |             |             |            | RVDD       | RVDD          | EGPIO[7]    | EGPIO[9]    | EGPIO[10]    | EGPIO[11] | G |
| F | SDCSN[3] | DA[22]   | DA[24]    | AD[25]      | RVDD        | GND        | CVD<br>D    |             |           |             |           |             |             |             | CVDD       | GND        | GND           | EGPIO[2]    | EGPIO[4]    | EGPIO[6]     | EGPIO[8]  | F |
| E | AD[23]   | DA[23]   | DA[26]    | CSN[6]      | GND         | GND        | CVD<br>D    | CVD<br>D    | RVDD      | GND         | GND       | RVDD        | CVDD        | CVDD        | GND        | ASDI       | DIOWN         | EGPIO[0]    | EGPIO[3]    | EGPIO[5]     | E         |   |
| D | AD[24]   | DA[25]   | DD[11]    | SDCLK<br>EN | AD[19]      | DD[9]      | DD[5]       | AD[16]<br>1 | MIIRXD[2] | MIITXD[3]   | TXEN      | MCWAI<br>TN | MCDAE<br>NN | MCDAE<br>NN | EGPIO[14]  | WP         | USBM[2]       | ARSTN       | DIORN       | EGPIO[1]     | D         |   |
| C | CSN[1]   | CSN[3]   | AD[20]    | DA[29]      | DD[10]      | DD[6]      | DD[2]       | MDC         | MIIRXD[3] | TXCLK       | MIITXD[0] | READY       | MCD2        | MCDIR       | MCELN      | IORDN      | MCWRN         | USBP[2]     | IORDY       | DMACKN       | C         |   |
| B | CSN[2]   | DA[31]   | DA[30]    | DA[27]      | DD[7]       | DD[3]      | WRN         | MDIO        | MIIRXD[1] | RXERR       | MIITXD[1] | CRS         | VS1         | MCD1        | MCBV<br>D2 | MCEHN      | EGPIO[1<br>3] | MCRDN       | WAITN       | TRSTN        | B         |   |
| A | CSN[7]   | DA[28]   | AD[18]    | DD[8]       | DD[4]       | AD[1<br>7] | RDN         | RXCL<br>K   | MIIRXD[0] | RXDVA<br>L  | MIITXD[2] | TXERR       | CLD         | VS2         | MCBV<br>D1 | MCREG<br>N | EGPIO[1<br>2] | EGPIO[15]   | IOWRN       | MCRESE<br>TN | A         |   |
|   | 1        | 2        | 3         | 4           | 5           | 6          | 7           | 8           | 9         | 10          | 11        | 12          | 13          | 14          | 15         | 16         | 17            | 18          | 19          | 20           |           |   |

## Pin List

The following Plastic Ball Grid Array (PBGA) ball assignment table is sorted in order of ball.

| Ball | Signal    | Ball | Signal    | Ball | Signal | Ball | Signal   |
|------|-----------|------|-----------|------|--------|------|----------|
| A1   | CSN[7]    | E9   | RVDD      | L3   | DA[16] | T13  | CVDD     |
| A2   | DA[28]    | E10  | GND       | L4   | DA[15] | T14  | GND      |
| A3   | AD[18]    | E11  | GND       | L5   | GND    | T15  | INT[0]   |
| A4   | DD[8]     | E12  | RVDD      | L8   | GND    | T16  | USBM[1]  |
| A5   | DD[4]     | E13  | CVDD      | L9   | GND    | T17  | RXD[0]   |
| A6   | AD[17]    | E14  | CVDD      | L10  | GND    | T18  | TXD[2]   |
| A7   | RDN       | E15  | GND       | L11  | GND    | T19  | ROW[2]   |
| A8   | RXCLK     | E16  | ASDI      | L12  | GND    | T20  | ROW[4]   |
| A9   | MIIRXD[0] | E17  | DIOWN     | L13  | GND    | U1   | AD[0]    |
| A10  | RXDVAL    | E18  | EGPIO[0]  | L16  | CVDD   | U2   | P[15]    |
| A11  | MIITXD[2] | E19  | EGPIO[3]  | L17  | COL[5] | U3   | P[10]    |
| A12  | TXERR     | E20  | EGPIO[5]  | L18  | COL[7] | U4   | P[7]     |
| A13  | CLD       | F1   | SDCSN[3]  | L19  | RSTON  | U5   | P[6]     |
| A14  | VS2       | F2   | DA[22]    | L20  | PRSTN  | U6   | P[4]     |
| A15  | MCBVD1    | F3   | DA[24]    | M1   | AD[7]  | U7   | P[0]     |
| A16  | MCREGN    | F4   | AD[25]    | M2   | DA[14] | U8   | AD[13]   |
| A17  | EGPIO[12] | F5   | RVDD      | M3   | AD[6]  | U9   | DA[3]    |
| A18  | EGPIO[15] | F6   | GND       | M4   | AD[5]  | U10  | DA[0]    |
| A19  | IOWRN     | F7   | CVDD      | M5   | CVDD   | U11  | DSRN     |
| A20  | MCRESETN  | F14  | CVDD      | M8   | GND    | U12  | BOOT[1]  |
| B1   | CSN[2]    | F15  | GND       | M9   | GND    | U13  | NC       |
| B2   | DA[31]    | F16  | GND       | M10  | GND    | U14  | SSPRX1   |
| B3   | DA[30]    | F17  | EGPIO[2]  | M11  | GND    | U15  | INT[1]   |
| B4   | DA[27]    | F18  | EGPIO[4]  | M12  | GND    | U16  | PWMOUT   |
| B5   | DD[7]     | F19  | EGPIO[6]  | M13  | GND    | U17  | USBM[0]  |
| B6   | DD[3]     | F20  | EGPIO[8]  | M16  | GND    | U18  | RXD[1]   |
| B7   | WRN       | G1   | SDCSN[0]  | M17  | COL[4] | U19  | TXD[1]   |
| B8   | MDIO      | G2   | SDCSN[1]  | M18  | COL[3] | U20  | ROW[1]   |
| B9   | MIIRXD[1] | G3   | SDWEN     | M19  | COL[6] | V1   | P[16]    |
| B10  | RXERR     | G4   | SDCLK     | M20  | CSN[0] | V2   | P[11]    |
| B11  | MIITXD[1] | G5   | RVDD      | N1   | DA[13] | V3   | P[8]     |
| B12  | CRS       | G6   | RVDD      | N2   | DA[12] | V4   | DD[15]   |
| B13  | VS1       | G15  | RVDD      | N3   | DA[11] | V5   | DD[13]   |
| B14  | MCD1      | G16  | RVDD      | N4   | AD[3]  | V6   | P[1]     |
| B15  | MCBVD2    | G17  | EGPIO[7]  | N5   | CVDD   | V7   | AD[14]   |
| B16  | MCEHN     | G18  | EGPIO[9]  | N6   | CVDD   | V8   | AD[12]   |
| B17  | EGPIO[13] | G19  | EGPIO[10] | N8   | GND    | V9   | DA[2]    |
| B18  | MCRDN     | G20  | EGPIO[11] | N9   | GND    | V10  | IDECSON  |
| B19  | WAITN     | H1   | DQMN[3]   | N10  | GND    | V11  | IDEDA[2] |
| B20  | TRSTN     | H2   | CASN      | N11  | GND    | V12  | TDI      |
| C1   | CSN[1]    | H3   | RASN      | N12  | GND    | V13  | GND      |
| C2   | CSN[3]    | H4   | SDCSN[2]  | N13  | GND    | V14  | ASYNC    |

| Ball | Signal    | Ball | Signal   | Ball | Signal  | Ball | Signal   |
|------|-----------|------|----------|------|---------|------|----------|
| C3   | AD[20]    | H5   | CVDD     | N15  | GND     | V15  | SSPTX1   |
| C4   | DA[29]    | H8   | GND      | N16  | GND     | V16  | INT[2]   |
| C5   | DD[10]    | H9   | GND      | N17  | XTALO   | V17  | RTSN     |
| C6   | DD[6]     | H10  | GND      | N18  | COL[0]  | V18  | USBP[0]  |
| C7   | DD[2]     | H11  | GND      | N19  | COL[1]  | V19  | CTSN     |
| C8   | MDC       | H12  | GND      | N20  | COL[2]  | V20  | TXD[0]   |
| C9   | MIIRXD[3] | H13  | GND      | P1   | AD[4]   | W1   | P[12]    |
| C10  | TXCLK     | H16  | RVDD     | P2   | DA[10]  | W2   | P[9]     |
| C11  | MIITXD[0] | H17  | RTCXTALO | P3   | DA[9]   | W3   | DD[0]    |
| C12  | READY     | H18  | ADC_VDD  | P4   | BRIGHT  | W4   | P[5]     |
| C13  | MCD2      | H19  | ADC_GND  | P5   | RVDD    | W5   | P[3]     |
| C14  | MCDIR     | H20  | XP       | P6   | RVDD    | W6   | DA[7]    |
| C15  | MCELN     | J1   | DA[21]   | P15  | RVDD    | W7   | DA[5]    |
| C16  | IORDN     | J2   | DQMN[0]  | P16  | RVDD    | W8   | AD[11]   |
| C17  | MCWRN     | J3   | DQMN[1]  | P17  | XTALI   | W9   | AD[9]    |
| C18  | USBP[2]   | J4   | DQMN[2]  | P18  | PLL_VDD | W10  | IDECS1N  |
| C19  | IORDY     | J5   | GND      | P19  | ROW[6]  | W11  | IDEDA[1] |
| C20  | DMACKN    | J8   | GND      | P20  | ROW[7]  | W12  | TCK      |
| D1   | AD[24]    | J9   | GND      | R1   | AD[2]   | W13  | TMS      |
| D2   | DA[25]    | J10  | GND      | R2   | AD[1]   | W14  | EECLK    |
| D3   | DD[11]    | J11  | GND      | R3   | P[17]   | W15  | SCLK1    |
| D4   | SDCLKEN   | J12  | GND      | R4   | P[14]   | W16  | GRLED    |
| D5   | AD[19]    | J13  | GND      | R5   | RVDD    | W17  | INT[3]   |
| D6   | DD[9]     | J16  | CVDD     | R6   | RVDD    | W18  | SLA[1]   |
| D7   | DD[5]     | J17  | RTCXTALI | R7   | GND     | W19  | SLA[0]   |
| D8   | AD[16]    | J18  | XM       | R8   | CVDD    | W20  | RXD[2]   |
| D9   | MIIRXD[2] | J19  | YP       | R13  | CVDD    | Y1   | HSYNC    |
| D10  | MIITXD[3] | J20  | YM       | R14  | GND     | Y2   | DD[1]    |
| D11  | TXEN      | K1   | AD[22]   | R15  | RVDD    | Y3   | DD[12]   |
| D12  | MCWAITN   | K2   | DA[20]   | R16  | RVDD    | Y4   | P[2]     |
| D13  | MCDAENN   | K3   | AD[21]   | R17  | ROW[0]  | Y5   | AD[15]   |
| D14  | MCADENN   | K4   | DA[19]   | R18  | ROW[3]  | Y6   | DA[6]    |
| D15  | EGPIO[14] | K5   | RVDD     | R19  | PLL_GND | Y7   | DA[4]    |
| D16  | WP        | K8   | GND      | R20  | ROW[5]  | Y8   | AD[10]   |
| D17  | USBM[2]   | K9   | GND      | T1   | DA[8]   | Y9   | DA[1]    |
| D18  | ARSTN     | K10  | GND      | T2   | BLANK   | Y10  | AD[8]    |
| D19  | DIORN     | K11  | GND      | T3   | P[13]   | Y11  | IDEDA[0] |
| D20  | EGPIO[1]  | K12  | GND      | T4   | SPCLK   | Y12  | DTRN     |
| E1   | AD[23]    | K13  | GND      | T5   | V_CSNC  | Y13  | TDO      |
| E2   | DA[23]    | K16  | CVDD     | T6   | DD[14]  | Y14  | BOOT[0]  |
| E3   | DA[26]    | K17  | SYM      | T7   | GND     | Y15  | EEDAT    |
| E4   | CSN[6]    | K18  | SYP      | T8   | CVDD    | Y16  | ASDO     |
| E5   | GND       | K19  | SXM      | T9   | RVDD    | Y17  | SFRM1    |
| E6   | GND       | K20  | SXP      | T10  | GND     | Y18  | RDLED    |
| E7   | CVDD      | L1   | DA[18]   | T11  | GND     | Y19  | USBP[1]  |
| E8   | CVDD      | L2   | DA[17]   | T12  | RVDD    | Y20  | ABITCLK  |

The following section focuses on the EP9315 pin signals from two viewpoints - the pin usage and pad characteristics, and the pin multiplexing usage. The first table ([Table S](#)) is a summary of all the EP9315 pin signals. The second table ([Table T](#)) illustrates the pin signal multiplexing and configuration options.

[Table S](#) is a summary of the EP9315 pin signals, which illustrates the pad type and pad pull type (if any). The symbols used in the table are defined as follows. (Note: A blank box means Not Applicable (NA) or, for Pull Type, No Pull (NP).)

Under the Pad Type column:

- A - Analog pad
- P - Power pad
- G - Ground pad
- I - Pin is an input only
- I/O - Pin is input/output
- 4mA - Pin is a 4 mA output driver
- 8mA - Pin is an 8 mA output driver
- 12mA - Pin is an 12 mA output driver

See the text description for additional information about bi-directional pins.

Under the Pull Type Column:

- PU - Resistor is a pull up to the RVDD supply
- PD - Resistor is a pull down to the RGND supply

**Table S. Pin Descriptions**

| Pin Name   | Block  | Pad Type | Pull Type | Description                 |
|------------|--------|----------|-----------|-----------------------------|
| TCK        | JTAG   | I        | PD        | JTAG clock in               |
| TDI        | JTAG   | I        | PD        | JTAG data in                |
| TDO        | JTAG   | 4ma      |           | JTAG data out               |
| TMS        | JTAG   | I        | PD        | JTAG test mode select       |
| TRSTn      | JTAG   | I        | PD        | JTAG reset                  |
| BOOT[1:0]  | System | I        | PD        | Boot mode select in         |
| XTALI      | PLL    | A        |           | Main oscillator input       |
| XTALO      | PLL    | A        |           | Main oscillator output      |
| VDD_PLL    | PLL    | P        |           | Main oscillator power, 1.8V |
| GND_PLL    | PLL    | G        |           | Main oscillator ground      |
| RTCXTALI   | RTC    | A        |           | RTC oscillator input        |
| RTCXTALO   | RTC    | A        |           | RTC oscillator output       |
| WRn        | EBUS   | 4ma      |           | SRAM Write strobe out       |
| RDn        | EBUS   | 4ma      |           | SRAM Read / OE strobe out   |
| WAITn      | EBUS   | I        | PU        | SRAM Wait in                |
| AD[25:0]   | EBUS   | 8ma      |           | Shared Address bus out      |
| DA[31:0]   | EBUS   | 8ma      | PU        | Shared Data bus in/out      |
| CSn[3:0]   | EBUS   | 4ma      | PU        | Chip select out             |
| CSn[7:6]   | EBUS   | 4ma      | PU        | Chip select out             |
| DQMn[3:0]  | EBUS   | 8ma      |           | Shared data mask out        |
| SDCLK      | SDRAM  | 8ma      |           | SDRAM clock out             |
| SDCLKEN    | SDRAM  | 8ma      |           | SDRAM clock enable out      |
| SDCSn[3:0] | SDRAM  | 4ma      |           | SDRAM chip selects out      |
| RASn       | SDRAM  | 8ma      |           | SDRAM RAS out               |
| CASn       | SDRAM  | 8ma      |           | SDRAM CAS out               |
| SDWEn      | SDRAM  | 8ma      |           | SDRAM write enable out      |
| P[17:0]    | Raster | 4ma      | PU        | Pixel data bus out          |

**Table S. Pin Descriptions (Continued)**

| Pin Name  | Block  | Pad Type | Pull Type | Description   |
|-----------|--------|----------|-----------|---|
| SPCLK     | Raster | 12ma     | PU        | Pixel clock in/out                                      |
| HSYNC     | Raster | 8ma      | PU        | Horizontal synchronization / line pulse out             |
| V_CSYNC   | Raster | 8ma      | PU        | Vertical or composite synchronization / frame pulse out |
| BLANK     | Raster | 8ma      | PU        | Composite blanking signal out                           |
| BRIGHT    | Raster | 4ma      |           | PWM brightness control out                              |
| PWMOUT    | PWM    | 8ma      |           | Pulse width modulator output                            |
| Xp, Xm    | ADC    | A        |           | Touchscreen ADC X axis                                  |
| Yp, Ym    | ADC    | A        |           | Touchscreen ADC Y axis                                  |
| sXp, sXm  | ADC    | A        |           | Touchscreen ADC X axis feedback                         |
| sYp, sYm  | ADC    | A        |           | Touchscreen ADC Y axis feedback                         |
| VDD_ADC   | ADC    | P        |           | Touchscreen ADC power, 3.3V                             |
| GND_ADC   | ADC    | G        |           | Touchscreen ADC ground                                  |
| COL[7:0]  | Key    | 8ma      | PU        | Key matrix column inputs                                |
| ROW[7:0]  | Key    | 8ma      | PU        | Key matrix row outputs                                  |
| USBp[2:0] | USB    | A        |           | USB positive signals                                    |
| USBm[2:0] | USB    | A        |           | USB negative signals                                    |
| TXD0      | UART1  | 4ma      |           | Transmit out  |
| RXD0      | UART1  | I        | PU        | Receive in  |
| CTSn      | UART1  | I        | PU        | Clear to send / transmit enable                         |
| DSRn      | UART1  | I        | PU        | Data set ready / Data Carrier Detect                    |
| DTRn      | UART1  | 4ma      |           | Data Terminal Ready output                              |
| RTSn      | UART1  | 4ma      |           | Ready to send   |
| TXD1      | UART2  | 4ma      |           | Transmit / IrDA output                                  |
| RXD1      | UART2  | I        | PU        | Receive / IrDA input                                    |
| TXD2      | UART3  | 4ma      |           | Transmit  |
| RXD2      | UART3  | I        | PU        | Receive   |
| MDC       | EMAC   | 4ma      |           | Management data clock                                   |

**Table S. Pin Descriptions (Continued)**

| Pin Name    | Block  | Pad Type | Pull Type | Description                        |
|-------------|--------|----------|-----------|------------------------------------|
| MDIO        | EMAC   | 4ma      | PU        | Management data input/output       |
| RXCLK       | EMAC   | I        | PD        | Receive clock in                   |
| MIRXD[3:0]  | EMAC   | I        | PD        | Receive data in                    |
| RXDVAL      | EMAC   | I        | PD        | Receive data valid                 |
| RXERR       | EMAC   | I        | PD        | Receive data error                 |
| TXCLK       | EMAC   | I        | PU        | Transmit clock in                  |
| MIITXD[3:0] | EMAC   | I        | PD        | Transmit data out                  |
| TXEN        | EMAC   | 4ma      | PD        | Transmit enable                    |
| TXERR       | EMAC   | 4ma      | PD        | Transmit error                     |
| CRS         | EMAC   | I        | PD        | Carrier sense                      |
| CLD         | EMAC   | I        | PU        | Collision detect                   |
| GRLED       | LED    | 12ma     |           | Green LED                          |
| RDLED       | LED    | 12ma     |           | Red LED                            |
| EECLK       | EEPROM | 4ma      | PU        | EEPROM / Two-wire Interface clock  |
| EEDAT       | EEPROM | 4ma      | PU        | EEPROM / Two-wire Interface data   |
| ABITCLK     | AC97   | 8ma      | PD        | AC97 bit clock                     |
| ASYNC       | AC97   | 8ma      | PD        | AC97 frame sync                    |
| ASDI        | AC97   | I        | PD        | AC97 Primary input                 |
| ASDO        | AC97   | 8ma      | PU        | AC97 output                        |
| ARSTn       | AC97   | 8ma      |           | AC97 reset                         |
| SCLK1       | SPI1   | 8ma      | PD        | SPI bit clock                      |
| SFRM1       | SPI1   | 8ma      | PD        | SPI Frame Clock                    |
| SSPRX1      | SPI1   | I        | PD        | SPI input                          |
| SSPTX1      | SPI1   | 8ma      |           | SPI output                         |
| INT[3:0]    | INT    | I        | PD        | External interrupts                |
| PRSTn       | Syscon | I        | PU        | Power on reset                     |
| RSTOn       | Syscon | 4ma      |           | User Reset in out - open drain     |
| SLA[1:0]    | EEPROM | 4ma      |           | Flash programming voltage control  |
| VS1         | PCMCIA | I        | PU        | Voltage sense                      |
| VS2         | PCMCIA | I        | PU        | Voltage sense                      |
| MCD1        | PCMCIA | I        | PU        | Card detect                        |
| MCD2        | PCMCIA | I        | PU        | Card detect                        |
| MCBV1       | PCMCIA | I        | PU        | Voltage detection / status change  |
| MCBV2       | PCMCIA | I        | PU        | Voltage detection                  |
| MCDIR       | PCMCIA | 4ma      |           | Data transceiver direction control |
| MCDAENn     | PCMCIA | 4ma      |           | Data bus transceiver enable        |
| MCADEn      | PCMCIA | 4ma      |           | Address bus transceiver enable     |
| MCREGn      | PCMCIA | 4ma      | PU        | Memory card register               |
| MCEHn       | PCMCIA | 4ma      | PU        | Memory card high byte select       |
| MCELn       | PCMCIA | 4ma      | PU        | Memory card low byte select        |
| IORDn       | PCMCIA | 4ma      | PU        | I/O card read                      |
| IOWRn       | PCMCIA | 4ma      | PU        | I/O card write                     |
| MCRDn       | PCMCIA | 4ma      | PU        | Memory card read                   |
| MCWRn       | PCMCIA | 4ma      | PU        | Memory card write                  |
| READY       | PCMCIA | I        | PU        | Ready / interrupt                  |
| WP          | PCMCIA | I        | PU        | Write protect                      |
| MCWAITn     | PCMCIA | I        | PU        | Wait Input                         |
| MCRESETn    | PCMCIA | 4ma      |           | Card reset                         |

**Table S. Pin Descriptions (Continued)**

| Pin Name    | Block  | Pad Type  | Pull Type | Description                |
|-------------|--------|-----------|-----------|----------------------------|
| EGPIO[15:0] | GPIO   | I/O, 4 ma | PU        | Enhanced GPIO              |
| DD[15:8]    | IDE    | 8ma       | PU        | IDE data bus               |
| DD7         | IDE    | 8ma       | PD        | IDE data bus               |
| DD[6:0]     | IDE    | 8ma       | PU        | IDE data bus               |
| IDEDA[2:0]  | IDE    | 8ma       |           | IDE Device address output  |
| IDECS0n     | IDE    | 8ma       |           | IDE Chip Select 0 output   |
| IDECS1n     | IDE    | 8ma       |           | IDE Chip Select 1 output   |
| DIORn       | IDE    | 8ma       |           | IDE Read strobe output     |
| DIOWn       | IDE    | 8ma       |           | IDE Write strobe output    |
| DMACKn      | IDE    | 8ma       |           | IDE DMA acknowledge output |
| IORDY       | IDE    | I         | PU        | IDE ready input            |
| CVDD        | Power  | P         |           | Digital power, 1.8V        |
| RVDD        | Power  | P         |           | Digital power, 3.3V        |
| CGND        | Ground | G         |           | Digital ground             |
| RGND        | Ground | G         |           | Digital ground             |

**Table T** illustrates the pin signal multiplexing and configuration options.

**Table T. Pin Multiplex Usage Information**

| Physical Pin Name | Description                          | Multiplex signal name      |
|-------------------|--------------------------------------|----------------------------|
| COL[7:0]          | GPIO                                 | GPIO Port D[7:0]           |
| ROW[7:0]          | GPIO                                 | GPIO Port C[7:0]           |
| EGPIO[0]          | Ring Indicator Input                 | RI                         |
| EGPIO[1]          | 1Hz clock monitor                    | CLK1HZ                     |
| EGPIO[2]          | IDE DMA request                      | DMARQ                      |
| EGPIO[3]          | Transmit Enable output / HDLC clocks | TENn / HDLCCLK1 / HDLCCLK3 |
| EGPIO[4]          | I2S Transmit Data 1                  | SDO1                       |
| EGPIO[5]          | I2S Receive Data 1                   | SDI1                       |
| EGPIO[6]          | I2S Transmit Data 2                  | SDO2                       |
| EGPIO[7]          | DMA Request 0                        | DREQ0                      |
| EGPIO[8]          | DMA Acknowledge 0                    | DACK0                      |
| EGPIO[9]          | DMA EOT 0                            | DEOT0                      |
| EGPIO[10]         | DMA Request 1                        | DREQ1                      |
| EGPIO[11]         | DMA Acknowledge 1                    | DACK1                      |
| EGPIO[12]         | DMA EOT 1                            | DEOT1                      |
| EGPIO[13]         | I2S Receive Data 2                   | SDI2                       |
| EGPIO[14]         | PWM 1 output                         | PWMOUT1                    |
| EGPIO[15]         | IDE Device active / present          | DASP                       |
| ABITCLK           | I2S Serial clock                     | SCLK                       |
| ASYNC             | I2S Frame Clock                      | LRCK                       |
| ASDO              | I2S Transmit Data 0                  | SDO0                       |
| ASDI              | I2S Receive Data 0                   | SDIO                       |
| ARSTn             | I2S Master clock                     | MCLK                       |
| SCLK1             | I2S Serial clock                     | SCLK                       |
| SFRM1             | I2S Frame Clock                      | LRCK                       |
| SSPTX1            | I2S Transmit Data 0                  | SDO0                       |
| SSPRX1            | I2S Receive Data 0                   | SDIO                       |
| IDEDA[2:0]        | GPIO                                 | GPIO Port E[7:5]           |
| IDECS0n           | GPIO                                 | GPIO Port E[4]             |
| IDECS1n           | GPIO                                 | GPIO Port E[3]             |
| DIORN             | GPIO                                 | GPIO Port E[2]             |
| GRLED             | LED                                  | GPIO Port E[1]             |
| RDLED             | LED                                  | GPIO Port E[0]             |
| DD[7:0]           | GPIO                                 | GPIO Port H[7:0]           |
| DD[15:12]         | GPIO                                 | GPIO Port G[7:4]           |
| SLA[1:0]          | GPIO                                 | GPIO Port G[3:2]           |
| EEDAT             | GPIO                                 | GPIO Port G[1]             |
| EECLK             | GPIO                                 | GPIO Port G[0]             |
| FGPIO[7]          | GPIO                                 | VS2                        |
| FGPIO[6]          | GPIO                                 | READY                      |
| FGPIO[5]          | GPIO                                 | VS1                        |
| FGPIO[4]          | GPIO                                 | MCBVD2                     |
| FGPIO[3]          | GPIO                                 | MCBVD1                     |
| FGPIO[2]          | GPIO                                 | MCD2                       |
| FGPIO[1]          | GPIO                                 | MCD1                       |
| FGPIO[0]          | GPIO                                 | WP                         |

## Acronyms and Abbreviations

The following tables list abbreviations and acronyms used in this data sheet.

| Term             | Definition  |
|------------------|---|
| ADC              | Analog-to-Digital Converter                           |
| ALT              | Alternative   |
| AMBA             | Advanced Micro-controller Bus Architecture            |
| ATAPI            | ATA Packet Interface                                  |
| CODEC            | COder / DECoder                                       |
| CRC              | Cyclic Redundancy Check                               |
| DAC              | Digital-to-Analog Converter                           |
| DMA              | Direct-Memory Access                                  |
| EBUS             | External Memory Bus                                   |
| EEPROM           | Electronically Erasable Programmable Read Only Memory |
| EMAC             | Ethernet Media Access Controller                      |
| FIFO             | First In / First Out                                  |
| FIQ              | Fast Interrupt Request                                |
| FLASH            | Flash memory  |
| GPIO             | General Purpose I/O                                   |
| HDLC             | High-level Data Link Control                          |
| I/F              | Interface   |
| I <sup>2</sup> S | Inter-IC Sound  |
| IC               | Integrated Circuit                                    |
| ICE              | In-Circuit Emulator                                   |
| IDE              | Integrated Drive Electronics                          |
| IEEE             | Institute of Electronics and Electrical Engineers     |
| IrDA             | Infrared Data Association                             |
| IRQ              | Standard Interrupt Request                            |
| ISO              | International Standards Organization                  |
| JTAG             | Joint Test Action Group                               |
| LFSR             | Linear Feedback Shift Register                        |
| MII              | Media Independent Interface                           |
| MMU              | Memory Management Unit                                |

| Term  | Definition   |
|-------|--|
| OHCI  | Open Host Controller Interface   |
| PHY   | Ethernet PHYSical layer interface  |
| PIO   | Programmed I/O   |
| RISC  | Reduced Instruction Set Computer   |
| SDMI  | Secure Digital Music Initiative  |
| SDRAM | Synchronous Dynamic RAM  |
| SPI   | Serial Peripheral Interface  |
| SRAM  | Static Random Access Memory  |
| STA   | Station - Any device that contains an IEEE 802.11 conforming Medium Access Control (MAC) and physical layer (PHY) interface to the wireless medium |
| TFT   | Thin Film Transistor   |
| TLB   | Translation Lookaside Buffer   |
| USB   | Universal Serial Bus   |

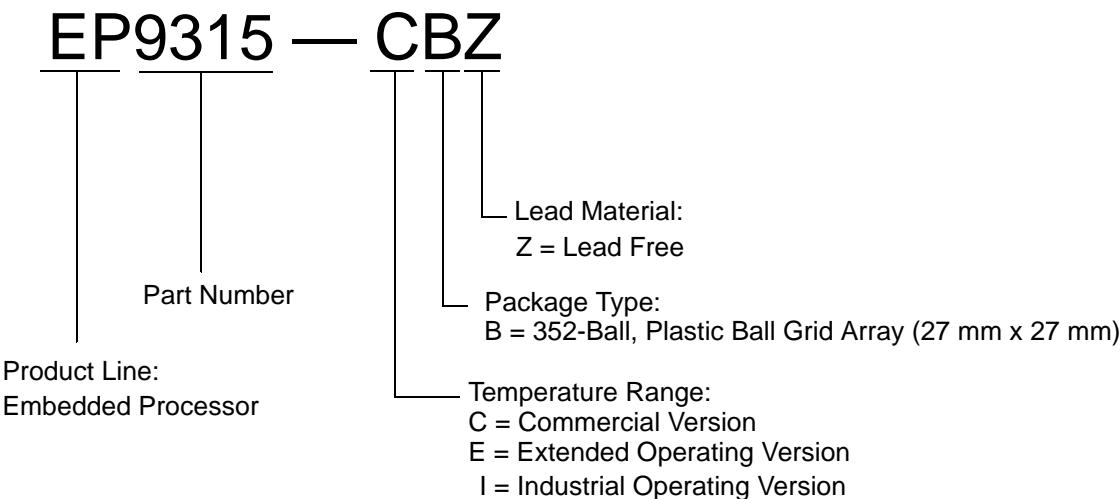
## Units of Measurement

| Symbol | Unit of Measure                                      |
|--------|--|
| °C     | degree Celsius                                       |
| Hz     | Hertz = cycle per second                             |
| Kbps   | Kilobits per second                                  |
| kbyte  | Kilobyte   |
| kHz    | KiloHertz = 1000 Hz                                  |
| Mbps   | Megabits per second                                  |
| MHz    | MegaHertz = 1,000 kHz                                |
| µA     | microAmpere = $10^{-6}$ Ampere                       |
| µs     | microsecond = 1,000 nanoseconds = $10^{-6}$ seconds  |
| mA     | milliAmpere = $10^{-3}$ Ampere                       |
| ms     | millisecond = 1,000 microseconds = $10^{-3}$ seconds |
| mW     | milliWatt = $10^{-3}$ Watts                          |
| ns     | nanosecond = $10^{-9}$ seconds                       |
| pF     | picoFarad = $10^{-12}$ Farads                        |
| V      | Volt   |
| W      | Watt   |

## Ordering Information

The order numbers for the device are:

|            |                |              |           |
|------------|----------------|--------------|-----------|
| EP9315-CB  | 0°C to +70°C   | 352-pin PBGA |           |
| EP9315-CBZ | 0°C to +70°C   | 352-pin PBGA | Lead Free |
| EP9315-IB  | -40°C to +85°C | 352-pin PBGA |           |
| EP9315-IBZ | -40°C to +85°C | 352-pin PBGA | Lead Free |



Note: Go to the Cirrus Logic Internet site at <http://www.cirrus.com> to find contact information for your local sales representative.

## Contacting Cirrus Logic Support

For all product questions and inquiries contact a Cirrus Logic Sales Representative.

To find one nearest you go to [www.cirrus.com](http://www.cirrus.com)

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